

LM12434/LM12{L}438 12-Bit + Sign Data Acquisition System with Serial I/O and Self-Calibration

General Description

The LM12434 and LM12{L}438 are highly integrated Data Acquisition Systems. Operating on 3V to 5V, they combine a fully-differential self-calibrating (correcting linearity and zero errors) 13-bit (12-bit + sign) analog-to-digital converter (ADC) and sample-and-hold (S/H) with extensive analog and digital functionality. Up to 32 consecutive conversions, using two's complement format, can be stored in an internal 32-word (16-bit wide) FIFO data buffer. An internal 8-word instruction RAM can store the conversion sequence for up to eight acquisitions through the LM12{L}438's eight-input multiplexer. The LM12434 has a four-channel multiplexer, a differential multiplexer output, and a differential S/H input. The LM12434 and LM12 L 438 can also operate with 8-bit $+\,$ sign resolution and in a supervisory "watchdog" mode that compares an input signal against two programmable limits.

Acquisition times and conversion rates are programmable through the use of internal clock-driven timers. The differential reference voltage inputs can be externally driven for absolute or ratiometric operation.

All registers, RAM, and FIFO are directly accessible through the high speed and flexible serial I/O interface bus. The serial interface bus is user selectable to interface with the following protocols with zero glue logic: MICROWIRE/ PLUSTM, Motorola's SPI/QSPI, Hitachi's SCI, 8051 Family's Serial Port (Mode 0), I²C and the TMS320 Family's Serial Port.

An evaluation kit for demonstrating the LM12434 and LM12{L}438 is available.

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Key Specifications

Rey Specifications	
$f_{CLK} = 8 MHz \{L, f_{CLK} = 6 MHz\}$	
Resolution 12-bi	t + sign or 8-bit + sign
13-bit conversion time	5.5 μs {7.3 μs} (max)
9-bit conversion time	2.6 μs {3.5 μs} (max)
13-bit Through-put rate	
140k samples/s	s {105k sample/s} (min)
 Comparison time ("watchdog" n 	node)
	1.4 μs {1.8 μs} (max)
Serial Clock	10 MHz {6 MHz} (max)
 Integral Linearity Error 	\pm 1 LSB (max)
V _{IN} range	GND to V _A +
 Power dissipation 	45 mW {20 mW} (max)
 Stand-by mode 	
power dissipation	25 μW {16.5 μW} (typ)
Supply voltage LM12L438	3.3V ±10%
LM12434/8	5V ±10%
Features	
■ Three operating modes: 12-bit	+ sign, 8-bit + sign,
and "watchdog" comparison mo	ode
 Single-ended or differential input 	ts
 Built-in Sample-and-Hold 	
 Instruction RAM and event sequ 	lencer
8-channel (LM12{L}438) or 4-ch	nannel (LM12434)

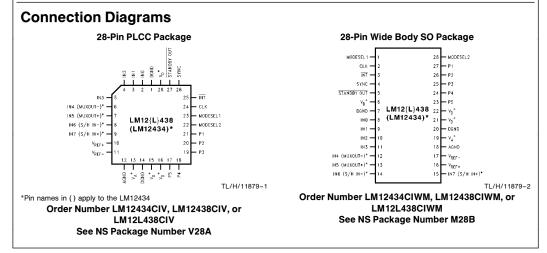
multiplexer 32-word conversion FIFO

- Programmable acquisition times and conversion rates
- Self-calibration and diagnostic mode
- Power down output for system power management
- Read while convert capability for maximum through-put

rate Applications

- Data Logging
- Portable Instrumentation
- Process Control
- Energy Management
 Debeties





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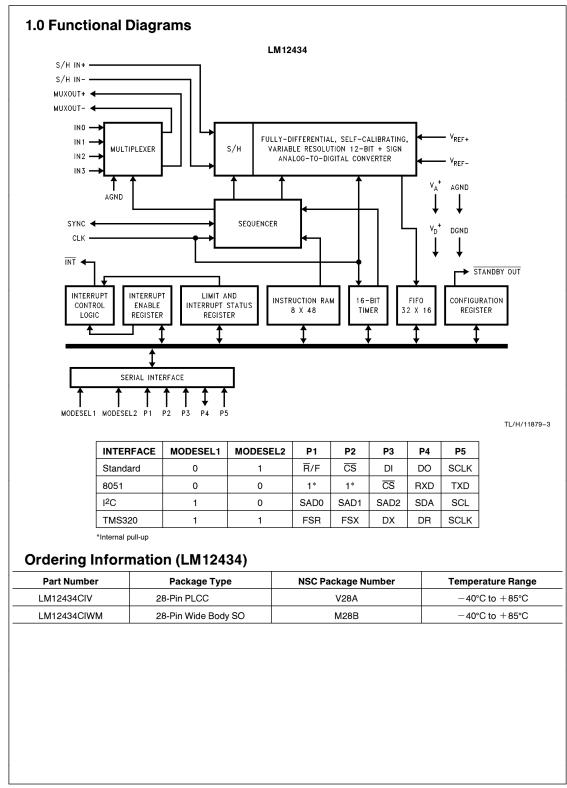
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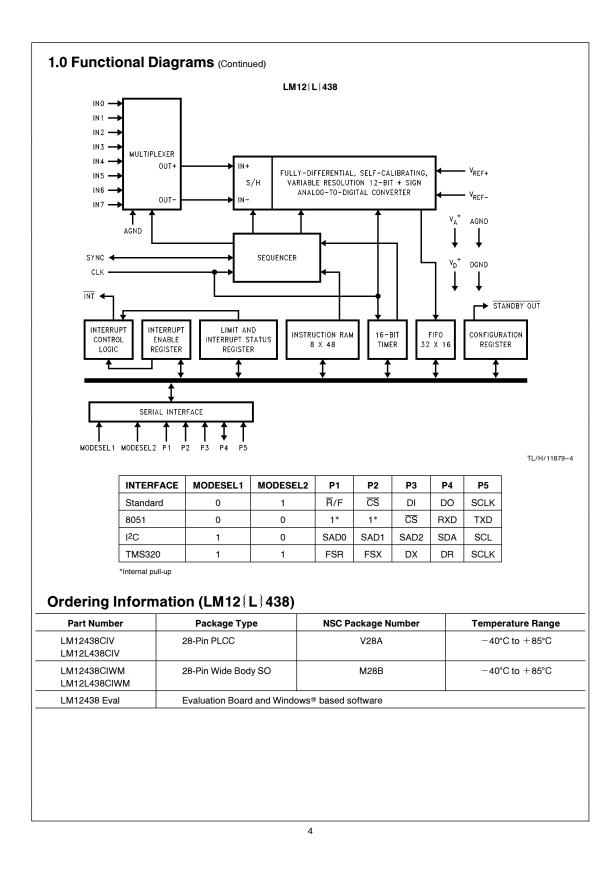
LM12434/LM12{L}438 12-Bit + Sign Data Acquisition System with Serial I/O and Self-Calibration

July 1995

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2.0 Electrical Specifications

2.1 RATINGS

ESD Susceptibility (Note 5)

2.1.1 Absolute Maximum Ratings	s (Notes 1 & 2)
If Military/Aerospace specified please contact the National Office/Distributors for availabili	Semiconductor Sales
Supply Voltage (V _A $^+$ and V _D $^+$)	6.0V V
Voltage at Input and Output Pins except IN0-IN3 (LM12434) and IN0-IN7 (LM12{L}438)	$-0.3V \text{ to } V^+ + 0.3V$ A
Voltage at Analog Inputs IN0-IN3	(LM12434) V
and IN0–IN7 (LM12{L}438)	$GND - 5V$ to $V^+ + 5V$ V_1
$ V_{A}^{+} - V_{D}^{+} $	300 mV V
AGND – DGND	300 mV V
Input Current at Any Pin (Note 3)	±5 mA
Package Input Current (Note 3)	±20 mA
Power Dissipation ($T_A = 25^{\circ}$ C) (N V Package WM Package	ote 4)
Storage Temperature	-65°C to +150°C
Soldering Information, Lead Temp V Package, Vapor Phase (60 se Infrared (15 seconds WM Package, Vapor Phase (60 Infrared (15 seconds)	conds) s) seconds)

2.1.2 Operating Ratings (N	Notes 1 & 2)
Temperature Range LM12434CIV/LM12{L}4 LM12434CIWM, LM12{L	$\begin{array}{l} (T_{min} \leq T_{A} \leq T_{max}) \\ 38 CIV -40^\circC \leq T_{A} \leq 85^\circC \\ 3438 CIWM -40^\circC \leq T_{A} \leq 85^\circC \end{array}$
Supply Voltage	
V_A^+ , V_D^+	3.0V to 5.5V
$ V_{A}^{+} - V_{D}^{+} $	\leq 100 mV
AGDND - DGND	\leq 100 mV
Analog Inputs Range	$GND \leq V_{IN+} \leq V_A^+$
V _{REF+} Input Voltage	$1V \le V_{REF+} \le V_{A}^+$
V _{REF} Input Voltage	$0V \le V_{REF^-} \le V_{REF^+} - 1V$
$V_{REF+} - V_{REF-}$	$1V \leq V_{REF} \leq V_{A}^+$
V _{REF} Common Mode Range (Note 16)	0.1 $V_{\text{A}}{}^+ \leq V_{\text{REFCM}} \leq$ 0.6 $V_{\text{A}}{}^+$

2.2 PERFORMANCE CHARACTERISTICS All specifications apply to the LM12434, LM12438, and LM12L438 unless otherwise noted. Specifications in braces { } apply only to the LM12L438.

1.5 kV

2.2.1 Converter Static Characteristics The following specifications apply to the LM12434 and LM12{L}438 for $V_A^+ = V_D^+ = 5V$ [3.3V], AGND = DGND = 0V, $V_{REF+} = 4.096V$ [2.5V], $V_{REF-} = 0V$, 12-bit + sign conversion mode, $f_{CLK} = 8.0$ MHz {6 MHz}, $R_S = 25\Omega$, source impedance for V_{REF+} and $V_{REF-} \le 25\Omega$, fully-differential input with fixed 2.048V {1.25V} common-mode voltage, and minimum acquisition time unless otherwise specified. Boldface limits apply for $T_A = T_J = T_{MIN}$ to T_{MAX} ; all other limits $T_A = T_J = 25^{\circ}C$. (Notes 6, 7, 8 and 9)

Symbol	Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Units (Limit)
ILE	Positive and Negative Integral Linearity Error	After Auto-Cal (Notes 12, 17)	±0.35	± 1	LSB (max)
TUE	Total Unadjusted Error	After Auto-Cal (Note 12)	±1		LSB
	Resolution with No Missing Codes	After Auto-Cal (Note 12)		13	Bits
DNL	Differential Non-Linearity	After Auto-Cal	±0.2	± 1	LSB (max)
	Zero Error	After Auto-Cal (Notes 13, 17)	±0.2	± 1	LSB (max)
	Positive Full-Scale Error	After Auto-Cal (Notes 12, 17)	±0.2	± 2	LSB (max)
	Negative Full-Scale Error	After Auto-Cal (Notes 12, 17)	±0.2	± 2	LSB (max)
	DC Common Mode Error	(Note 14)	±2	± 3.5 { ± 4.0}	LSB (max)
ILE	8-Bit + Sign and ''Watchdog'' Mode Positive and Negative Integral Linearity Error	(Note 12)	±0.15	± 1/2	LSB (max)
TUE	8-Bit + Sign and "Watchdog" Mode Total Unadjusted Error	After Auto-Zero	±1/2	± 1/2	LSB (max)
	8-Bit + Sign and "Watchdog" Mode Resolution with No Missing Codes			9	Bits (max)

2.2.1 Converter Static Characteristics The following specifications apply to the LM12434 and LM12{L}438 for $V_A^+ = V_D^+ = 5V$ {3.3V}, AGND = DGND = 0V, $V_{REF+} = 4.096V$ {2.5V}, $V_{REF-} = 0V$, 12-bit + sign conversion mode, $f_{CLK} = 8.0$ MHz {6 MHz}, $R_S = 25\Omega$, source impedance for V_{REF+} and $V_{REF-} \le 25\Omega$, fully-differential input with fixed 2.048V {1.25V} common-mode voltage, and minimum acquisition time unless otherwise specified. **Boldface limits apply for T_A = T_J = T_{MIN} to T_{MAX}; all other limits T_A = T_J = 25°C. (Notes 6, 7, 8 and 9) (Continued)**

Symbol		Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Units (Limit)
DNL	8-Bit + Sign ar Differential Nor	nd "Watchdog" Mode n-Linearity		±0.15	± 1/2	LSB (max)
	8-Bit + Sign ar Zero Error	nd "Watchdog" Mode	After Auto-Zero	±0.05	± 1/2	LSB (max)
	8-Bit + Sign ar and Negative F	nd "Watchdog" Positive full-Scale Error		±0.1	± 1/2	LSB (max)
	8-Bit + Sign ar DC Common M	nd ''Watchdog'' Mode lode Error		±1/8		LSB
	Multiplexer Cha Matching	annel-to-Channel		±0.05		LSB
$v_{\text{IN}+}$	Non-Inverting Input Range				GND V _A +	V (min) V (max)
$v_{\text{IN}-}$	Inverting Input Range				GND V _A +	V (min) V (max)
$V_{IN+} - V_{IN-}$	Differential Inpu	ut Voltage Range			-V _A + V _A +	V (min) V (max)
$\frac{V_{\text{IN}+}-V_{\text{IN}-}}{2}$	Common Mode	Input Voltage Range			GND V _A +	V (min) V (max)
PSS	Power Supply Sensitivity (Note 15)	Zero Error Full-Scale Error Linearity Error	$V_{A}^{+} = V_{D}^{+} = 5V \pm 10\%,$ $V_{REF+} = 4.096V, V_{REF-} = GND$	±0.05 ±0.25 ±0.2	± 1.0 ± 1.5	LSB (max) LSB (max) LSB
C _{REF}	V _{REF+} /V _{REF-}	Input Capacitance		85		pF
C _{IN}	Selected Multip Capacitance	blexer Channel Input		75		pF

2.2.2 Converter Dynamic Characteristics The following specifications apply only to the LM12434 and LM12438 for $V_A^+ = V_D^+ = 5V$, AGND = DGND = 0V, $V_{REF+} = 4.096V$, $V_{REF-} = 0V$, 12-bit + sign conversion mode, $f_{CLK} = 8.0$ MHz, throughput rate = 133.3 kHz, $R_S = 25\Omega$, source impedance for V_{REF+} and $V_{REF-} \le 25\Omega$, fully-differential input with fixed 2.048V {1.25V} common-mode voltage, and minimum acquisition time unless otherwise specified. **Boldface limits apply for T_A = T_J = T_{MIN} to T_MAX; all other limits T_A = T_J = 25^\circC. (Notes 6, 7, 8 and 9)**

Symbol	Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Units (Limit)
	CLK Duty Cycle		50		%
				40	% (min)
				60	% (max)
t _C	Conversion Time	13-Bit Resolution, Sequencer State S5 <i>(Figure 10)</i>	44 (t _{CLK})	44 (t _{CLK}) + 50 ns	(max)
		9-Bit Resolution, Sequencer State S5 <i>(Figure 10)</i>	21 (t _{CLK})	21 (t _{CLK}) + 50 ns	(max)
t _A	Acquisition Time (Programmable)	Sequencer State S7 <i>(Figure 10)</i> Minimum for 13-Bits Maximum for 13-Bits (D = 15)	9 (t _{CLK}) 39 (t _{CLK})	9 (t _{CLK}) + 50 ns 39 (t _{CLK}) + 50 ns	t _{CLK} = CLK Period (max) (max)
		Minimum for 9-Bits (<i>Figure 10</i>) Maximum for 9-Bits ($D = 15$)	2 (t _{CLK}) 2 (t _{CLK})	2 (t _{CLK}) + 50 ns 32 (t _{CLK}) + 50 ns	(max) (max)

2.2.2 Converter Dynamic Characteristics The following specifications apply only to the LM12434 and LM12438 for $V_A^+ = V_D^+ = 5V$, AGND = DGND = 0V, $V_{REF+} = 4.096V$, $V_{REF-} = 0V$, 12-bit + sign conversion mode, $f_{CLK} = 8.0$ MHz, throughput rate = 133.3 kHz, $R_S = 25\Omega$, source impedance for V_{REF+} and $V_{REF-} \le 25\Omega$, fully-differential input with fixed 2.048V common-mode voltage, and minimum acquisition time unless otherwise specified. **Boldface limits apply for T_A** = **T_J** = **T_MIN to T_MAX**; all other limits $T_A = T_J = 25^{\circ}C$. (Notes 6, 7, 8 and 9) (Continued)

Symbol	Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Units (Limit)
tz	Auto-Zero Time	Sequencer State S2 (Figure 10)	76 (t _{CLK})	76 (t _{CLK}) + 50 ns	(max)
t _{CAL}	Full Calibration Time	Sequencer State S2 (Figure 10)	4944 (t _{CLK})	4944 (t _{CLK}) + 50 ns	(max)
	Throughput Rate	(Note 18)	142	140	kHz (min)
t _{WD}	"Watchdog" Mode Comparison Time	Sequencer States S6, S4, and S5 (<i>Figure 10</i>)	11 (t _{CLK})	11 (t _{CLK}) + 50 ns	(max)
SNR	Signal-to-Noise Ratio, Differential Input	$\begin{array}{l} V_{IN} = \ \pm 4.096V \ (Note \ 20) \\ f_{IN} = \ 1 \ kHz \\ f_{IN} = \ 10 \ kHz \\ f_{IN} = \ 62 \ kHz \end{array}$	79 79 70		dB dB dB
SNR	Signal-to-Noise Ratio, Single-Ended Input	$\begin{split} V_{IN} &= 4.096 \; V_{p\text{-}p} \\ f_{IN} &= 1 \; \text{kHz} \\ f_{IN} &= 10 \; \text{kHz} \\ f_{IN} &= 62 \; \text{kHz} \end{split}$	71 71 67		dB dB dB
SINAD	Signal-to-Noise + Distortion Ratio, Differential Input	$\begin{array}{l} V_{IN}=\pm 4.096V~(Note~20)\\ f_{IN}=1~kHz\\ f_{IN}=10~kHz\\ f_{IN}=62~kHz \end{array}$	79 78 67		dB dB dB
SINAD	Signal-to-Noise + Distortion Ratio, Single-Ended Input	$\begin{split} V_{IN} &= 4.096 \; V_{p\text{-}p} \\ f_{IN} &= 1 \; \text{kHz} \\ f_{IN} &= 10 \; \text{kHz} \\ f_{IN} &= 62 \; \text{kHz} \end{split}$	71 70 64		dB dB dB
THD	Total Harmonic Distortion, Differential Input	$\begin{array}{l} V_{IN}=\pm 4.096V~(Note~20)\\ f_{IN}=1~kHz\\ f_{IN}=10~kHz\\ f_{IN}=62~kHz \end{array}$	90 85 71		dBc dBc dBc
THD	Total Harmonic Distortion, Distortion, Single-Ended Input	$ \begin{array}{l} V_{IN} = 4.096 \; V_{p\text{-}p} \\ f_{IN} = 1 \; kHz \\ f_{IN} = 10 \; kHz \\ f_{IN} = 62 \; kHz \end{array} $	88 82 67		dBc dBc dBc
ENOB	Effective Number of Bits, Differential Input	$\begin{array}{l} V_{IN} = \ \pm 4.096V \ (Note \ 20) \\ f_{IN} = \ 1 \ kHz \\ f_{IN} = \ 10 \ kHz \\ f_{IN} = \ 62 \ kHz \end{array}$	12.6 12.2 12.1		Bits Bits Bits
ENOB	Effective Number of Bits, Single-Ended Input	$ \begin{array}{l} V_{IN} = 4.096 \; V_{p\text{-}p} \\ f_{IN} = 1 \; kHz \\ f_{IN} = 10 \; kHz \\ f_{IN} = 62 \; kHz \end{array} $	11.3 11.2 10.8		Bits Bits Bits
SFDR	Spurious Free Dynamic Range, Differential Input	$\begin{split} V_{IN} &= \pm 4.096V \text{ (Note 20)} \\ f_{IN} &= 1 \text{ kHz} \\ f_{IN} &= 10 \text{ kHz} \\ f_{IN} &= 62 \text{ kHz} \end{split}$	90 86 76		dBc dBc dBc
SFDR	Spurious Free Dynamic Range, Single-Ended Input	$ \begin{array}{l} V_{IN} = 4.096V V_{p\text{-}p} \\ f_{IN} = 1 \text{kHz} \\ f_{IN} = 10 \text{kHz} \\ f_{IN} = 62 \text{kHz} \end{array} $	90 85 72		dBc dBc dBc

2.2.2 Converter Dynamic Characteristics The following specifications apply only to the LM12434 and LM12438 for $V_A^+ = V_D^+ = 5V$, AGND = DGND = 0V, $V_{REF+} = 4.096V$, $V_{REF-} = 0V$, 12-bit + sign conversion mode, $f_{CLK} = 8.0$ MHz, throughput rate = 133.3 kHz, $R_S = 25\Omega$, source impedance for V_{REF+} and $V_{REF-} \le 25\Omega$, fully-differential input with fixed 2.048V common-mode voltage, and minimum acquisition time unless otherwise specified. **Boldface limits apply for T_A = T_J = T_{MIN} to T_MAX; all other limits T_A = T_J = 25^\circC. (Notes 6, 7, 8 and 9) (Continued)**

Symbol	Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Units (Limit)
IMD	Two Tone Intermodulation Distortion Differential Input	$V_{IN} = \pm 4.096V$ (Note 20) $f_1 = 19.190 \text{ kHz}$ $f_2 = 19.482 \text{ kHz}$	-82		dBc
IMD	Two Tone Intermodulation Distortion Single Ended Input	$V_{IN} = 4.096 V_{pp}$ f ₁ = 19.190 kHz f ₂ = 19.482 kHz	-80		dBc
	Multiplexer Channel-to-Channel Crosstalk	$\begin{split} V_{IN} &= 4.096 \ V_{PP} \\ f_{IN} &= 5 \ \text{kHz} \\ f_{CROSSTALK} &= 40 \ \text{kHz} \\ LM12434 \ \text{MUXOUT} \ \text{Only} \\ \text{and} \ LM12438 \ \text{MUX} \\ \text{plus} \ \text{Converter} \ (\text{Note } 21) \end{split}$	- 90		dBc
t _{PU}	Power-Up Time		10		ms
t _{WU}	Wake-Up Time	(Note 22)	2		ms

2.2.3 DC Characteristics The following specifications apply to the LM12434 and LM12{L}438 for $V_A^+ = V_D^+ = 5V$ {3.3V], AGND = DGND = 0V, $V_{REF+} = 4.096V$ {2.5V}, $V_{REF-} = 0V$, $f_{CLK} = 8.0$ MHz {6 MHz} and minimum acquisition time unless otherwise specified. **Boldface limits apply for T_A = T_J = T_{MIN} to T_{MAX}**; all other limits T_A = T_J = 25°C. (Notes 6, 7 and 8)

Symbol	Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Units (Limit)
I_D^+	V _D ⁺ Supply Current	$\label{eq:fclk} \begin{array}{l} f_{CLK} = 8 \; \text{MHz} \; \{ 6 \; \text{MHz} \} \\ f_{SCLK} = \; \text{Stopped} \\ f_{SCLK} = \; 10 \; \text{MHz} \; \{ 8 \; \text{MHz} \} \end{array}$	2.0 {1.4} 4.0 {2.0}	5.0 {2.5}	mA (max) mA (max)
I_A^+	V _A ⁺ Supply Current	$f_{CLK} = 8 MHz \{6 MHz\}$	2.8 {2.2}	4.0 {3.5}	mA (max)
I _{ST}	Stand-By Supply Current ($I_D^+ + I_A^+$)	$\label{eq:stand-By Mode Selected} Stand-By Mode Selected \\ f_{SCLK} = Stopped \\ f_{CLK} = 8 \mbox{ MHz } {6 \mbox{ MHz}} \\ f_{SCLK} = 10 \mbox{ MHz } {8 \mbox{ MHz}} \\ f_{CLK} = Stopped \\ f_{CLK} = 8 \mbox{ MHz } {6 \mbox{ MHz}} \\ \end{tabular}$	5{5} 120 {50} 1.4 {0.8} 1.4 {0.8}		μΑ (max) μΑ (max) mA (max) mA (max)
	Multiplexer ON-Channel Leakage Current	$V_A^+ = 5.5V$ ON-Channel = 5.5V OFF-Channel = 0V ON-Channel = 0V OFF-Channel = 5.5V	0.1	1.0 {3.0} 1.0 {3.0}	μΑ (max) μΑ (max)
	Multiplexer OFF-Channel Leakage Current	$V_A^+ = 5.5V \{3.3V\}$ ON-Channel = 5.5V $\{3.3V\}$ OFF-Channel = 0V ON-Channel = 0V OFF-Channel = 5.5V $\{3.3V\}$	0.1	1.0 {3.0} 1.0 {3.0}	μΑ (max) μΑ (max)

2.2.3 DC Characteristics The following specifications apply to the LM12434 and LM12{L}438 for $V_A^+ = V_D^+ = 5V$ {3.3V], AGND = DGND = 0V, $V_{REF+} = 4.096V$ {2.5V}, $V_{REF-} = 0V$, $f_{CLK} = 8.0$ MHz {6 MHz} and minimum acquisition time unless otherwise specified. **Boldface limits apply for T_A = T_J = T_{MIN} to T_{MAX}**; all other limits T_A = T_J = 25°C. (Notes 6, 7 and 8) (Continued)

Symbol	Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Units (Limit)
R _{ON}	Multiplexer ON-Resistance	LM12434			
		$V_{IN} = 5V$	650	1000	Ω(max)
		$V_{IN} = 2.5V$	700	1000	Ω(max)
		$V_{IN} = 0V$	630	1000	Ω(max)
	Multiplexer Channel-to-Channel	LM12434			
	R _{ON} matching	$V_{IN} = 5V$	±1.0%	\pm 3.0%	(max)
		$V_{IN} = 2.5V$	±1.0%	± 3.0%	(max)
		$V_{IN} = 0V$	±1.0%	\pm 3.0%	(max)

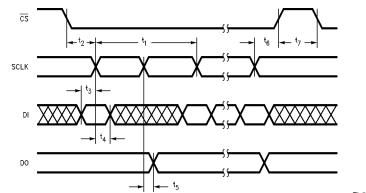
2.2.4 Digital DC Characteristics The following specifications apply to the LM12434 and LM12{L}438 for $V_A^+ = V_D^+ = 5V$ {3.3V}, AGND = DGND = 0V, unless otherwise specified. **Boldface limits apply for T_A = T_J = T_{MIN} to T_{MAX}**; all other limits $T_A = T_J = 25^{\circ}$ C. (Notes 6, 7 and 8)

Symbol	Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Units (Limit)
V _{IN(1)}	Logical "1" Input Voltage	$V_A^+ = V_D^+ = 5.5V \{3.6V\}$		2.0	V (min)
V _{IN(0)}	Logical "0" Input Voltage	$V_A^+ = V_D^+ = 4.5V \{3.0V\}$		0.8	V (max)
I _{IN(1)}	Logical "1" Input Current	$V_{IN} = 5V \{3.3V\}$	0.005	1.0	μA (max)
I _{IN(0)}	Logical "0" Input Current	$V_{IN} = 0V$	-0.005	- 1.0	μA (max)
C _{IN}	All Digital Inputs		6		pF
V _{OUT(1)}	Logical "1" Output Voltage	$V_A^+ = V_D^+ = 4.5V \{3.0V\}$ $I_{OUT} = -360 \ \mu A$ $I_{OUT} = -10 \ \mu A$		2.4 4.25 {2.9}	V (min) V (min)
V _{OUT(0)}	Logical "0" Output Voltage	$V_A^+ = V_D^+ = 4.5V \{3.0V\}$ $I_{OUT} = 1.6 \text{ mA}$		0.4	V (max)
I _{OUT}	TRI-STATE [®] Output Leakage Current	$V_{OUT} = 0V$ $V_{OUT} = 5V \{3.3V\}$	-0.05 0.05	- 3.0 3.0	μΑ (max) μΑ (max)

2.3 DIGITAL SWITCHING CHARACTERISTICS The following specifications apply to the LM12434 and LM12{L}438 for V_A+ = V_D+ = 5V {3.3V}, AGND = DGND = 0V, C_L (load capacitance) on output lines = 80 pF unless otherwise specified. **Boldface limits apply for T_A** = **T_J** = **T_{MIN} to T_{MAX}**, all other limits for T_A = T_J = 25°C. (Notes 6, 7, and 9) **2.3.1 Standard Mode Interface (MICROWIRE/PLUSTM. SCI and SPI/OSPI)**

Symbol (See <i>Figure</i> Below)	Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Units (Limit)
t ₁	SCLK (Serial Clock) Period			100 {125}	ns (min)
t ₂	CS Set-Up Time to First Clock Transition			25 {30}	ns (min)
t ₃	DI Valid Set-Up Time to Data Capture Transition of SCLK			0	ns (min)
t ₄	DI Valid Hold Time to Data Capture Transition of SCLK			40	ns (min)
t ₅	DO Hold Time from Data Shift Transition of SCLK			70 {120}	ns (max)
t ₆	CS Hold Time from Last SCLK Transition in a Read or Write Cycle (Excluding Burst Read Cycle)			25	ns (min)
t ₇	CS Inactive to CS Active Again			3	CLK Cycle (min)*
t ₈	SCLK Idle Time between the End of the Command Byte Transfer and the Start of the Data Transfer in Read Cycles			3	CLK Cycle (min)*

*CLK is the main clock input to the device, pin number 24 in PLCC package or pin number 2 in SO package.



TL/H/11879-18

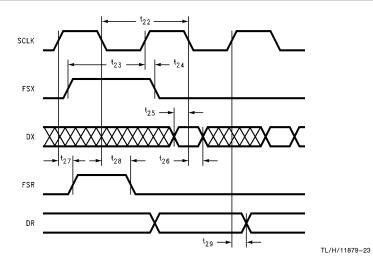
2.3 DIGITAL SWITCHING CHARACTERISTICS The following specifications apply to the LM12434 and LM12{L}438 for V_A + V_D + = 5V {3.3V}, AGND = DGND = 0V, C_L (load capacitance) on output lines = 80 pF unless otherwise specified. **Boldface limits apply for T_A** = **T_J** = **T_{MIN} to T_{MAX}**, all other limits for T_A = T_J = 25°C. (Notes 6, 7, and 9) (Continued)

Symbol See <i>Figure</i> Below)	Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Units (Limit)
9	TXD (Serial Clock Period)			125 {250}	ns (min)
10	CS Set-Up Time to First Clock Transition			25 {40}	ns (min)
11	Data in Valid Set-Up Time to TXD Clock High			40	ns (min)
12	Data in Valid Hold Time from TXD Clock High			40 {90}	ns (min)
13	Data Out Hold Time from TXD Clock High			70 {120}	ns (max)
14	CS Hold Time from Last TXD High in a Read or Write Cycle (Excluding Burst Read Cycle)			25 {50}	ns (min)
15	CS Inactive to CS Active Again			3	CLK Cycle (min)*
16	SCLK Idle Time between the End of the Command Byte Transfer and the Start of the Data Transfer in Read Cycles			3	CLK Cycle (min)*
			/ X_XXX	XXXX	
	RXD Data out	ررې ج ^t ۱3	X	TL/H/	11879–21

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2.3 DIGITAL SWITCHING CHARACTERISTICS The following specifications apply to the LM12434 and LM12{L}438 for V_A+ = V_D+ = 5V {3.3V}, AGND = DGND = 0V, C_L (load capacitance) on output lines = 80 pF unless otherwise specified. **Boldface limits apply for T_A = T_J = T_{MIN} to T_{MAX}**, all other limits for T_A = T_J = 25°C. (Notes 6, 7, and 9) (Continued)

Symbol (See <i>Figure</i> Below)	Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Units (Limit)
t ₂₂	SCLK (Serial Clock) Period			125 {167}	ns (min)
t ₂₃	FSX Set-Up Time to SCLK High			30 {50}	ns (min)
t ₂₄	FSX Hold Time from SCLK High			10	ns (min)
t ₂₅	Data in (DX) Set-Up Time to SCLK Low			0	ns (min)
t ₂₆	Data in DX Hold Time from SCLK Low			30 { 120 }	ns (min)
t ₂₇	FSR High from SCLK High			80 { 100 }	ns (max)
t ₂₈	FSR Low from SCLK Low			120	ns (max)
t ₂₉	SCLK High to Data Out (DR) Change			90	ns (max)

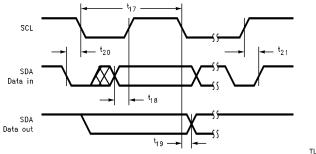


2.3 DIGITAL SWITCHING CHARACTERISTICS The following specifications apply to the LM12434 and LM12{L}438 for V_A+ = V_D+ = 5V {3.3V}, AGND = DGND = 0V, C_L (load capacitance) on output lines = 80 pF unless otherwise specified. **Boldface limits apply for T_A = T_J = T_{MIN} to T_{MAX}, all other limits for T_A = T_J = 25°C. (Notes 6, 7, and 9) (Continued)**

2.3.4 I²C Bus Interface

The switching characteristics of the LM12434/8 for I²C bus interface fully meets or exceeds the published specifications of the I²C bus. The following parameters given here are the timing relationships between SCL and SDA signals related to the LM12434/8. They are not the I²C bus specifications.

Symbol (See <i>Figure</i> Below)	Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Units (Limit)
t ₁₇	SCL (Clock) Period			2500 { 10000 }	ns (min)
t ₁₈	Data in Set-Up Time to SCL High			30	ns (min)
t ₁₉	Data Out Stable after SCL Low			900 { 1400 }	ns (max)
t ₂₀	SDA Low Set-Up Time to SCL Low (Start Condition)			40	ns (min)
t ₂₁	SDA High Hold Time after SCL High (Stop Condition)			40	ns (min)



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2.4 NOTES ON SPECIFICATIONS

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

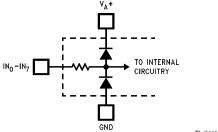
Note 2: All voltages are measured with respect to GND, unless otherwise specified. GND specifies either AGND and/or DGND and V⁺ specifies either V_A⁺ and/or V_D⁺.

Note 3: When the input voltage (V_{IN}) at any pin exceeds the power supply rails ($V_{IN} < GND$ or $V_{IN} > (V_A^+ \text{ or } V_D^+)$), the current at that pin should be limited to 5 mA. The 20 mA maximum package input current rating allows the voltage at any four pins, with an input current of 5 mA, to simultaneously exceed the power supply voltages.

Note 4: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{Jmax} (maximum junction temperature), Θ_{JA} (package junction to ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $PD_{max} = (T_{Jmax} - T_A)/\Theta_{JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower. For this device, $T_{Jmax} = 150^{\circ}$ C, and the typical thermal resistance (Θ_{JA}) of the V package, when board mounted, is 70°C/W and in the WM package, when board mounted, is 60°C/W.

Note 5: Human body model, 100 pF discharged through a 1.5 k Ω resistor.

Note 6: Two on-chip diodes are tied to each analog input through a series resistor, as shown below. Input voltage magnitude up to 5V above V_A^+ or 5V below GND will not damage the part. However, errors in the A/D conversion can occur if these diodes are forward biased by more than 100 mV. As an example, if V_A^+ is 4.5 V_{DC} , the full-scale input voltage must be \leq 4.6 V_{DC} to ensure accurate conversions.



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Note 7: V_A^+ and V_D^+ must be connected together to the same power supply voltage and bypassed with separate capacitors at each V+ pin to assure conversion/comparison accuracy. Refer to Section 8.0 for a detailed discussion on grounding the DAS.

Note 8: Accuracy is guaranteed when operating the LM12434/LM12{L}438 at $f_{CLK} = 8 \text{ MHz} \{6 \text{ MHz}\}$.

Note 9: With the test condition for V_{REF} (V_{REF+} - V_{REF-}) given as +4.096V, the 12-bit LSB is 1 mV and the 8-bit/"Watchdog" LSB is 19 mV.

Note 10: Typicals are at $T_A = 25^{\circ}C$ and represent most likely parametric norm.

Note 11: Limits are guaranteed to National's AOQL (Average Output Quality Level).

Note 12: Positive integral linearity error is defined as the deviation of the analog value, expressed in LSBs, from the straight line that passes through positive fullscale and zero. For negative integral linearity error the straight line passes through negative full-scale and zero. (See Figures 5b and 5c).

Note 13: Zero error is a measure of the deviation from the mid-scale voltage (a code of zero), expressed in LSB. It is the average value of the code transitions between -1 to 0 and 0 to +1 (see Figure 6).

Note 14: The DC common-mode error is measured with both the inverted and non-inverted inputs shorted together and driven from 0V to 5V {3.3V}. The measured value is referred to the resulting output value when the inputs are driven with a 2.5V {1.65V} signal.

Note 15: Power Supply Sensitivity is measured after Auto-Zero and/or Auto-Calibration cycle has been completed with V_A^+ and V_D^+ at the specified extremes. Note 16: V_{REFCM} (Reference Voltage Common Mode Range) is defined as $(V_{REF+} + V_{REF-})/2$. See *Figures 3* and 4.

Note 17: The device self-calibration technique ensures linearity and offset errors as specified, but noise inherent in the self-calibration process will result in a repeatability uncertainty of ±0.10 LSB.

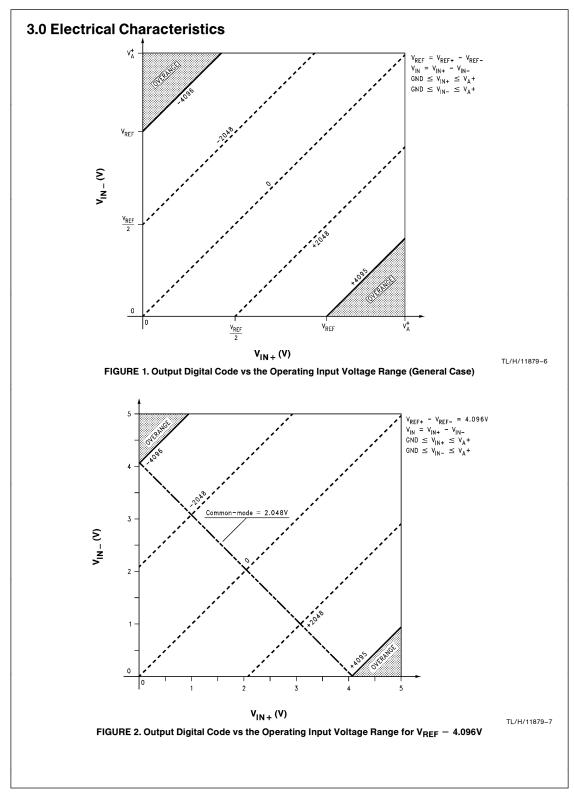
Note 18: The Throughput Rate is for a single instruction repeated continuously while reading data during conversions with a serial clock frequency f_{SCLK} = 10 MHz {8 MHz}. Sequencer states 0 (1 clock cycle), 1 (1 clock cycle), 7 (9 clock cycles) and 5 (44 clock cycles) are used (see *Figure 10*) for a total of 56 clock cycles per conversion. The Throughput Rate is f_{CLK} (MHz)/N, where N is the number of clock cycles/conversion.

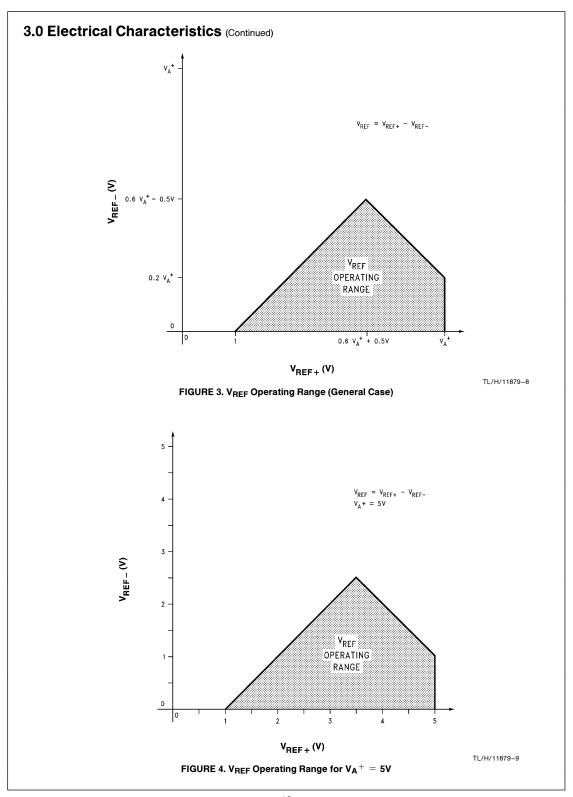
Note 19: See AN-450 "Surface Mounting Methods and their Effect on Product Reliability" for other methods of soldering surface mount devices.

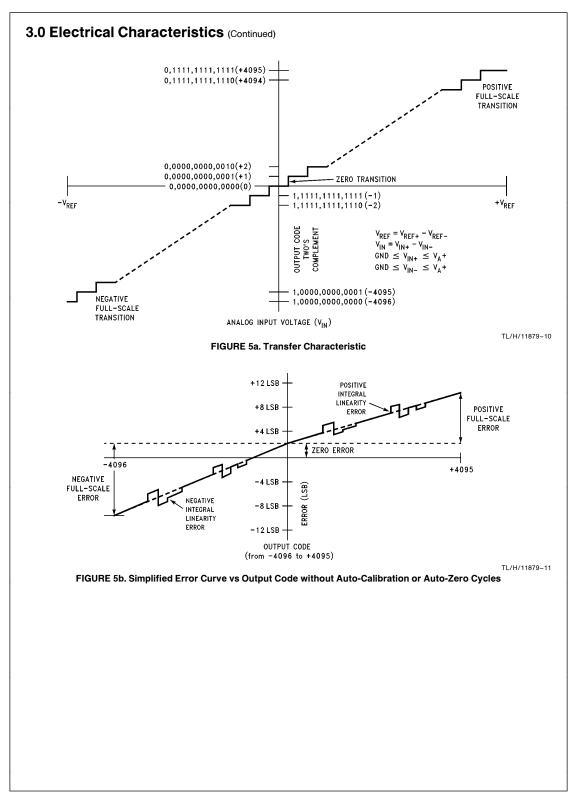
Note 20: Each input referenced to the other input sees a $\pm 4.096V$ (8.192 V_{p-p}) sine wave. However the voltage at each input stays within the supply rails. This is done by applying two sine waves with 180° phase shift and 4.096 V_{p-p} (between GND and V_A⁺) to the inputs.

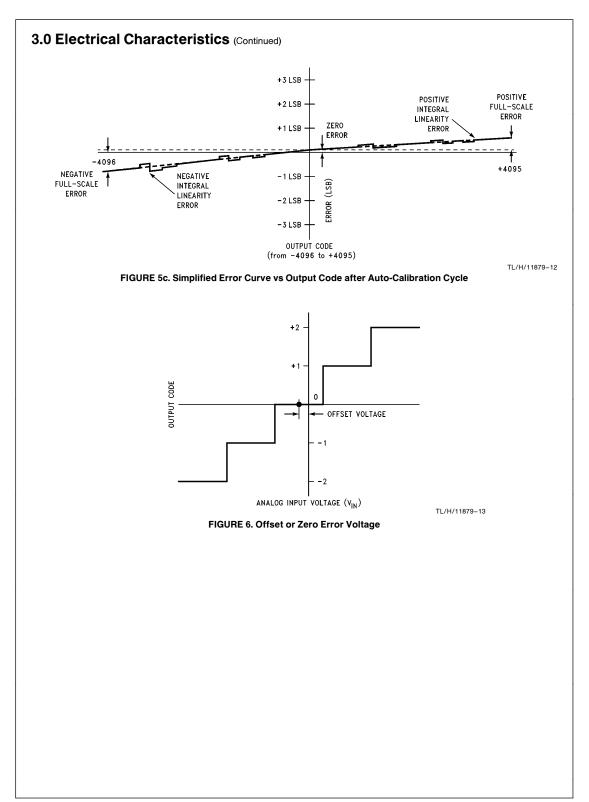
Note 21: Multiplexer channel-to-channel crosstalk is measured by placing a sinewave with a frequency of $f_{IN} = 5$ kHz on one channel and another sinewave with a frequency of $f_{CROSSTALK} = 40$ kHz on the remaining channels. 8192 conversions are performed on the channel with the 5 kHz signal. A special response is generated by doing a FFT on these samples. The crosstalk is then calculated by subtracting the amplitude of the frequency component at 40 kHz from the amplitude of the fundamental frequency at 5 kHz.

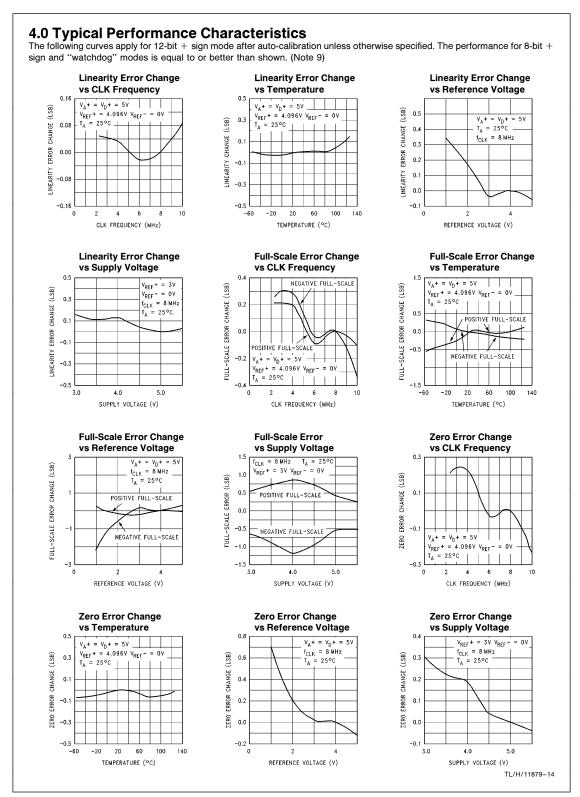
Note 22: Interrupt 7 is set to return an out-of-standby flag 10 ms (typ) after the device is requested to come out of standby mode. However, characterization has shown the devices will perform to their rated specifications in 2 ms.

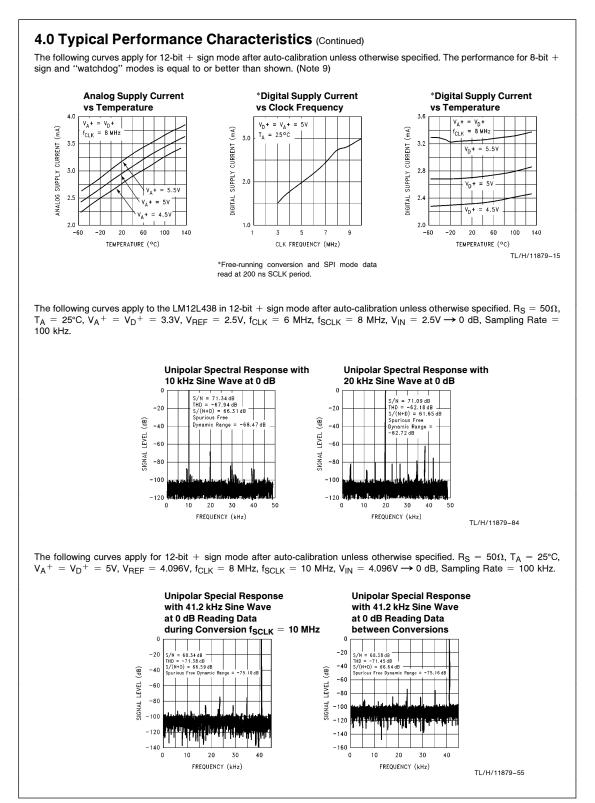


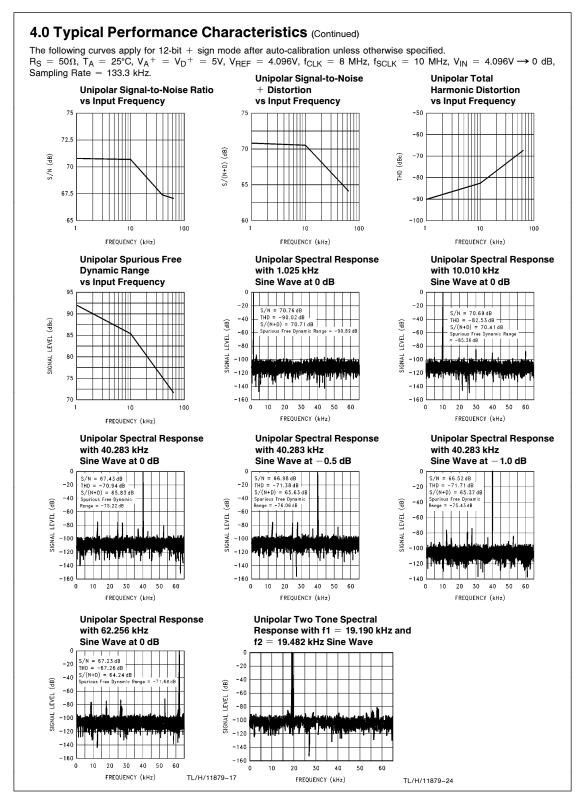


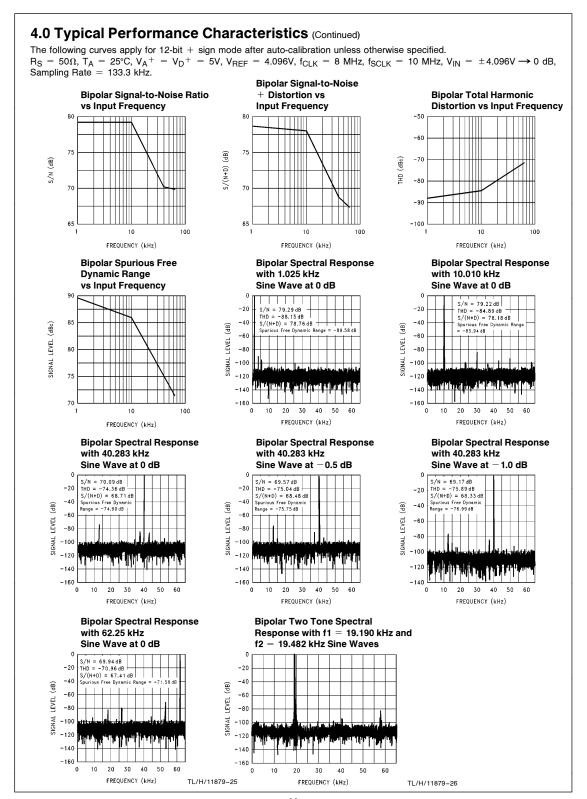














Pin Nu	mher		(-	.}438 Pin Descr	
PLCC Pkg.	SO Pkg.	Pin Name		Des	scription
1	7	DGND		• • • •	bly ground connection. It should be connected ground return to the system power supply.
2 3 4 5 6 7 8 9	8 9 10 11 12 13 14 15	IN0 IN1 IN2 IN3 IN4 IN5 IN6 IN7	active channels are selected channel can be selected for a	according to the single-ended co	plexer. For each conversion to be performed, the instruction RAM programming. Any individual poversion referenced to AGND, or any pair of can be selected as a fully differential input pairs.
10	16	V _{REF} +	Figures 3 and 4). In order to a	achieve 12-bit penation of a 10 μ F	e range for this input is $1V \le V_{REF}^+ \le V_A^+$ (See rformance this pin should be by passed to AGND and a 0.1 μ F (ceramic) capacitor. The capacitors ble.
11	17	V _{REF} -	— 1V (See Figures 3 and 4).	In order to achie lel combination o	ge range for this input is 0 V \leq V _{REF} ⁻ \leq V _{REF} ⁺ ve 12-bit performance, this pin should be bypasser of a 10 μ F and a 0.1 μ F (ceramic) capacitor. The art as possible.
12	18	AGND	00		pply ground connection. It should be connected ground return to the system power supply.
13	19	V _A +	voltage range is +3.0V to + connected to the same poten bypassed to AGND at least w	5.5V. Accuracy is itial. In order to a rith a parallel cor	or the analog circuitry. The device operating supples guaranteed only if the V_A^+ and V_D^+ are chieve 12-bit performance, this pin should be nbination of a 10 μ F and a 0.1 μ F (ceramic) a close to the part as possible.
14	20	DGND	Digital ground. See above de	finition.	
15 16	21 22	V _D +	voltage range is +3.0V to + are connected to the same po by passed to DGND at least v	5.5V. The device otential. In order with a parallel co	or the analog circuitry. The device operating supply accuracy is guaranteed only if the V_A^+ and V_D^+ to achieve 12-bit performance this pin should be mbination of a 10 μ F and a 0.1 μ F (ceramic) a close to the part as possible.
17	23	P5	P1-P5 are the multi-function depending on the selected m Serial interface input:		nput or output pins that have different assignments SCLK TXD SCL DR
18	24	P4	Serial interface input/output:	Standard: 8051: I ² C: TMS320:	DO RXD SDA DR
19	25	P3	Serial interface input:	Standard: 8051: I ² C: TMS320:	DI CS SAD2 DX

		1	TABLE I. LM12{L}438 Pin	Description (Con	tinued)
Pin Nu	mber			_	
PLCC Pkg.	SO Pkg.	Pin Name		Descr	iption
20	26	P2	Serial interface input:	Standard: 8051: I ² C: TMS320:	CS 1 SAD1 FSX
21	27	P1	Serial interface input:	Standard: 8051: I ² C: TMS320:	R/F (Clock rise/fall) 1 SAD0 FSR
22 23	28 1	MODESEL2 MODESEL1		elow. The standar	of these inputs determine the operation of d mode covers the National's MICROWIRE, Standard mode 8051 I ² C TMS320
24	2	CLK	-		nge of clock frequency is 0.05 MHz to only for the clock frequencies indicated in
25	3	ĪNT	masked interrupt condition t generate an interrupt. (Refe	akes place. There r to Section 6.2.4) This output can d	An interrupt is generated any time a non- e are seven different conditions that can . The interrupt is set high (inactive) by readin rive up to 100 pF of capacitive loads. An er capacitive loads.
26	4	SYNC	is "0" and output when the h causes the internal S/H to h cycle (depending on the pro comparison actually begins edge of sync.) When output, and returns low when the cy	bit is "1". When sy old the input signs grammed instruct on the rising edge it goes high at the cle is completed. an drive up to 100	ut if the Configuration Register's SYNC I/O b ync is an input, a rising edge on this pin al and a conversion cycle or a comparison ion) to be started. (The conversion or of the CLK immediately following the rising e start of a conversion or a comparison cycle At power up the SYNC pin is set as an input. pF of capacitive loads. An external buffer ads.
27	5	STANDBYOUT	LM12{L}438 is put into stan is used to force any other de to go into power-down mode "standby", etc. pins of the o ICs do not have the power-do	d-by mode throug evices in the syste e. This is done by ther ICs to STANI lown inputs, STAN I. Note that the log	STANDBYOUT will be activated when the the Configuration Register's stand-by bit. I m (signal conditioning circuitry, for example) connecting the "shutdown", "powerdown", DBYOUT. In those cases where the peripher IDBYOUT can be used to turn off their powe gic polarity of the STANDBYOUT is the iguration Register.
28	6	V _D +	Digital supply. See above de	finition.	
M12	13/ D	in Descriptiv			438 with the exceptions of the following pins
6	12		DN (Same As LM12{L}438 Multiplexer outputs These a		externally available analog MUX output pins
7	13	MUXOUT +			ased on the Instruction RAM programming.
8 9	14 15	S/H IN – S/H IN +	Sample-and-hold inputs. The and-hold. LM12434 allows e		ng and non-inverting inputs of the sample-

6.0 Operational Information

6.1 FUNCTIONAL DESCRIPTION

The LM12434 and LM12{L}438 are multi-functional Data Acquisition Systems that include a fully differential 12-bit-plus-sign self-calibrating analog-to-digital converter (ADC) with a two's-complement output format, an 8-channel (LM12{L}438) or a 4-channel (LM12434) analog multiplexer, a first-in-first-out (FIFO) register that can store 32 conversion results, and an Instruction RAM that can store as many as eight instructions to be sequentially executed. The LM12434 also has a differential multiplexer output and a differential S/H input. All of this circuitry operates on only a single \pm 5V power supply. For simplicity, the DAS (Data Acquisition System) abbreviation is used as a generic name for the members of the LM12434 and LM12{L}438 family thoughout this discussion.

Figure 7 illustrates the functional block diagram or user programming model of the DAS. Note that this diagram is not meant to reflect the actual implementation of the internal building blocks. The model consists of the following blocks:

- A flexible analog multiplexer with differential output at the front end of the device.
- A fully-differential, self-calibrating 12-bit + sign ADC converter with sample and hold.
- A 32-word FIFO register as the output data buffer.
- An 8-word instruction RAM that can be programmed to repeatedly perform a series of conversions and comparisons on selected input channels.
- A series of registers for overall control and configuration of DAS operation and indication of internal operational status.
- Interrupt generation logic to request service from the processor under specified conditions.
- Serial interface logic for input/output operations between the DAS and the processor. All the registers shown in the diagram can be read and most of them can also be written to by the user through the input/output block.
- A controller unit that manages the interactions of the different blocks inside the DAS and controls the conversion, comparison and calibration sequences.
- The DAS has 3 different modes of operation:
- 12-bit + sign conversion
- 8-bit + sign conversion
- 8-bit + sign comparison (also called "watchdog" mode)

The fully differential 12-bit-plus-sign ADC uses a charge redistribution topology that includes calibration capabilities. Charge re-distribution ADCs use a capacitor ladder in place of a resistor ladder to form an internal DAC. The DAC is used by a successive approximation register to generate intermediate voltages between the voltages applied to V_{REF}^- and V_{REF}^+ . These intermediate voltages are compared against the sampled analog input voltage as each bit is charged.

Conversion accuracy is ensured by an internal auto-calibration system. Two different calibration modes are available; one compensates for offset voltage, or zero error, while the other corrects the ADC's linearity and offset errors.

When correcting offset only, the offset error is measured once and a correction coefficient is created. During the full calibration, the offset error is measured eight times, averaged, and a correction coefficient is created. After completion of either calibration mode, the offset correction coefficient is stored in an internal offset correction register.

The LM12434 and LM12{L}438's overall linearity correction is achieved by correcting the internal DAC's capacitor mismatch. Each capacitor is compared eight times against all remaining smaller value capacitors and any errors are averaged. A correction coefficient is then created and stored in one of the thirteen linearity correction registers. A state machine, using patterns stored in 16-bit x 8-bit ROM, executes each calibration algorithm.

Once the converter has been calibrated, an arithmetic logic unit (ALU) uses the offset correction coefficient and the 13 linearity correction coefficients to reduce the conversion's offset error and linearity error, in the background, during the 12-bit + sign conversion. 8-bit + sign conversions and "watchdog" comparisons use only the offset coefficient. An 8-bit + sign conversion requires less than half the time needed for a 12-bit + sign conversion.

Diagnostic Mode

A diagnostic mode is available that allows verification of the LM12{L}438's operation. The diagnostic mode is disabled in the LM12434. This mode internally connects the voltages present at the V_{REF}⁺ and V_{REF}⁻ pins to the internal V_{IN}⁺ and V_{IN}⁻ S/H inputs. This mode is activated by setting the Diagnostic bit (Bit 11) in the Configuration register to a "1". More information concerning this mode of operation can be found in Section 6.2.2.

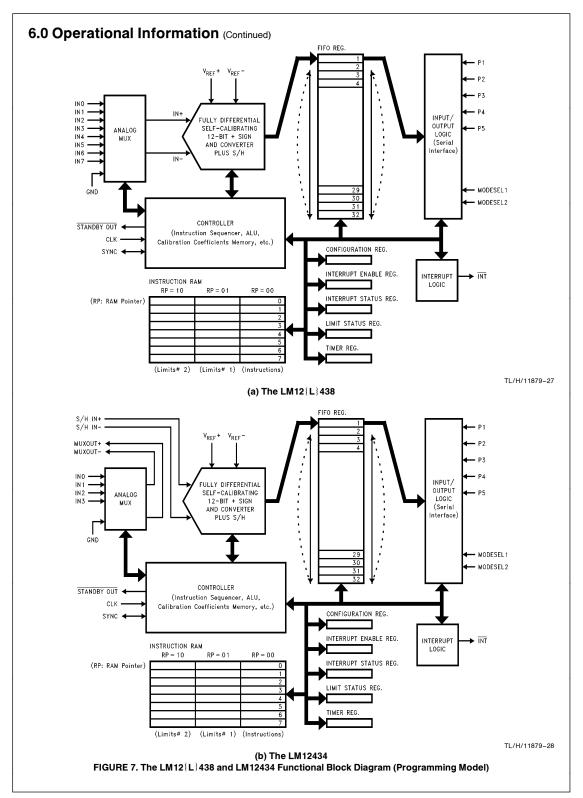
Watchdog Mode

In the watchdog mode no conversion is performed, but the DAS samples an input and compares it with the values of the two limits stored in the Instruction RAM. If the input voltage is above or below the limits (as defined by the user) an interrupt can be generated to indicate a fault condition. The LM12434 and LM{L}438's "watchdog" mode is used to monitor a single-ended or differential signal's amplitude and generate an output if the signal's amplitude falls outside of a programmable "window". Each watchdog instruction includes two limits. An interrupt can be generated if the input signal is above or below either of the two limits. This allows interrupt to be generated when analog voltage inputs are "outside the window". After a "watchdog" mode interrupt, the processor can then request a conversion on the input signal and read the signal's magnitude.

Analog Input Multiplexer

The analog input multiplexer can be configured for any combination of single-ended or fully differential operation. Each input is referenced to AGND when a multiplexer channel operates in the single-ended mode. Fully differential analog input channels are formed by pairing any two channels together.

The LM12434's multiplexer outputs and S/H inputs (MUXOUT+, MUXOUT- and S/H IN+, S/H IN-) provide the option for additional analog signal processing after the multiplexer. Fixed-gain amplifiers, programmable-gain amplifiers, filters, and other processing circuits can operate on the multiplexer output signals before they are applied to the ADC's S/H inputs. If external processing is not used, connect MUXOUT+ to S/H IN+ and MUXOUT- to S/H IN-.



6.0 Operational Information (Continued) Acquisition Time

The LM12434 and LM12{L}438's internal S/H is designed to operate at its minimum acquisition time (1.125 [1.5] μs for a 12-bit + sign conversion) when the source impedance, R_S, is less than or equal to 60 {80} Ω (f_{CLK} \leq 8 {6} MHz). When 60 {80} $\Omega < R_S \leq 4.17$ {5.56} kÅ, the internal S/H's acquisition time can be increased to a maximum of 4.88 {6.5] μs (12 + sign bits, f_{CLK} = 8 {6} MHz) to provide sufficient time for the sampling capacitor to charge. See Section 6.2.1 (Instruction RAM "00") Bits 12–15 for more information.

Instruction Register

The INSTRUCTION RAM is divided into 8 separate words, each with 48 (3 x 16) bit length. Each word is separated into three 16-bit sections. Each word has a unique address and different sections of the instruction word are selected by the 2-bit RAM pointer (RP) in the configuration register. As shown in Figure 7, the Instruction RAM sections are labeled Instructions, Limits #1 and Limits #2. The Instruction section holds operational (12-bit + sign, 8-bit + sign or watchdog) information such as the input channels to be selected, the mode of operation to be performed for each instruction. and the duration of the acquisition period. The other two sections are used in the watchdog mode and the userdefined limits are stored in them. Each watchdog instruction has 2 limits associated with it (usually a low limit and a high limit, but two low limits or two high limits may be programmed instead). The DAS starts executing from instruction 0 and moves through the next instructions up to any user-specified instruction and then "loop back" to instruction 0. It is not necessary to execute all 8 instructions in the instruction loop. The cycle may be repeatedly executed until stopped by the user. The processor should access the Instruction RAM only when the instruction sequencer is stopped.

FIFO Register

The FIFO Register stores the conversion results. This register is "Read only" and all the locations are accessed through a single address. Each time a conversion is performed the result is stored in the FIFO and the FIFO's internal write pointer points to the next location. The pointer rolls back to location 1 after a Write to location 32. The same flow occurs when reading from the FIFO. The internal FIFO Writes and the external FIFO Reads do not affect each other's pointer locations. Microprocessor overhead is reduced through the use of the internal conversion FIFO. Thirty-two consecutive conversions can be completed and stored in the FIFO without any microprocessor intervention. The microprocessor can, at any time, interrogate the FIFO and retrieve its contents. It can also wait for the LM12434 and LM12{L}438 to issue an interrupt when the FIFO is full or after any number (\leq 32) of conversions have been stored.

Configuration Register

The CONFIGURATION Register is the main "control panel" of the DAS. Writing 1s and 0s to the different bits of the Configuration Register commands the DAS start or stop the sequencer, reset the pointers and flags, go into "standby" mode for low power consumption, calibrate offset and linearity, and select sections of the RAM.

Other Registers

The INTERRUPT ENABLE Register lets the user activate up to 7 sources for interrupt generation (refer to Section 6.2.3). It also holds two user-programmable values. One is the number of conversions to be stored in the FIFO register before the generation of the Data Ready interrupt. The other value is the instruction number that generates an interrupt when the sequencer reaches that instruction.

The INTERRUPT STATUS and LIMIT STATUS Registers are "Read only" registers. They are used as vectors to indicate which conditions have generated the interrupt and what watchdog limit boundaries have been passed. Note that the bits are set in the status registers upon occurrence of their corresponding interrupt conditions, regardless of whether the condition is enabled for external interrupt generation.

The TIMER Register can be programmed to insert a delay before execution of each instruction. A bit in the instruction register enables or disables the insertion of the delay before the execution of an instruction.

Serial I/O

A very flexible serial synchronous interface is provided to facilitate reading from and writing to the LM12434 and LM12{L}438's registers. The communication between the LM12434 and LM12{L}438 and microcontrollers, microprocessors and other circuitry is accomplished through this serial interface. The serial interface is designed to directly communicate with the synchronous serial interfaces of the most popular microprocessors with no extra hardware requirement. The interface has been also designed to simplify software development.

ADD = 0000 ADD = 0001 ADD = 0010 ADD = 0011 ADD = 0100 ADD = 0101 ADD = 0110 ADD = 0110
ADD = 0010 ADD = 0011 ADD = 0100 ADD = 0101 ADD = 0110
ADD = 0011 ADD = 0100 ADD = 0101 ADD = 0110
ADD = 0100 ADD = 0101 ADD = 0110
ADD = 0101 ADD = 0110
ADD = 0110
ADD = 0111
(Read/Write
ADD = 1000
(Read/Write
ADD = 1001
(Pood Only
(Read Only ADD = 1010
(Read/Write
ADD = 1011
(Read Only
ADD = 1100
(Read Only
ADD = 1101

6.0 Operational Information (Continued)

6.2 INTERNAL USER-ACCESSIBLE REGISTERS

Figure 8 shows the LM12434 and LM12{L}438 internal user accessible registers. *Figure 9* shows the bit assignment for each register. All the registers are accessible through the serial interface bus. Following are the descriptions of the registers and their bit assignments.

6.2.1 Instruction RAM

The instruction RAM holds up to eight sequentially executable instructions. Each 48-bit long instruction is divided into three 16-bit sections. READ and WRITE operations can be issued to each 16-bit section using the instruction's address and the 2-bit "RAM pointer" in the Configuration register. The eight instructions are located at addresses 0000 through 0111. They can be accessed and programmed in random order.

Read/Write Operations

Any Instruction RAM READ or WRITE can affect the sequencer's operation.

Therefore, the Sequencer should be stopped by setting the RESET bit to a "1" or by resetting the START bit in the Configuration Register and waiting for the current instruction to finish execution before any Instruction RAM READ or WRITE is initiated.

A soft RESET should be issued by writing a "1" to the Configuration Register's RESET bit after any READ or WRITE to the Instruction RAM.

The three sections in the Instruction RAM are selected by the Configuration Register's 2-bit "RAM Pointer", bits D8 and D9. The first 16-bit Instruction RAM section is selected with the RAM Pointer equal to "00". This section can be programmed for multiplexer channel selection, conversion resolution, watchdog mode operation, timer or external SYNC use, pause in instruction and loop bit as described later. The second 16-bit section holds "watchdog" limit #1, its sign, and a bit that determines whether an interrupt can be generated when the input is greater than or less than limit #1. The third 16-bit section holds "watchdog" limit #2, its sign, and the "greater than/less than" selection bit.

Instruction RAM, Bank 1, RP = 00

Bit 0 is the LOOP bit. After an instruction with Bit 0 set to a "1" is executed, the sequencer will loop back to instruction 0. The next instruction to be executed will be instruction 0.

Bit 1 is the PAUSE bit. When the PAUSE bit is set ("1"), the Sequencer will stop after reading the current instruction. The instruction will not execute at this point, and the START bit in the Configuration register will reset to "0". Setting the PAUSE also causes an interrupt to be issued. The Sequencer is restarted by placing a "1" in the Configuration register's Bit 0 (Start bit).

After the Instruction RAM has been programmed and the RESET bit is set to "1", the Sequencer retrieves Instruction 0, decodes it, and waits for a "1" to be placed in the Configuration register's START bit. The START bit value of "1" "overrides" the action of Instruction 0's PAUSE bit when the Sequencer is started. Once started, the Sequencer executes Instruction 0 and retrieves, decodes, and executes

each of the remaining instructions. With the PAUSE bit set to "1" in instruction 0, no PAUSE Interrupt (INT 5) is generated the first time the Sequencer executes Instruction 0. When the Sequencer encounters a LOOP bit or completes all eight instructions, Instruction 0 is retrieved and decoded. A set PAUSE bit in Instruction 0 now halts the Sequencer before the instruction is executed. If Pause = 0, the instruction loop continues to execute.

Bits 2–4 select which of the eight input channels (IN0–IN7) will be the non-inverting inputs to the LM12{L}438's ADC. (See Table III.) They select which of the four input channels (for IN0–IN3) will be the non-inverting inputs to the LM12434's ADC. (See Table IV.)

Bits 5–7 select which of the seven input channels (IN1 to IN7) will be the inverting inputs to the LM12{L}438 ADC. (See Table III.) They select which of the three input channels (IN1–IN4) will be the inverting inputs to the LM12434's ADC. (See Table IV.) Fully differential operation is created by selecting two multiplexer channels, one non-inverting and the other inverting. A code of "000" selects ground as the inverting input for single ended operation.

Bit 8 is the SYNC bit. Setting Bit 8 to "1" causes the Sequencer to hold operation at the internal S/H's acquisition cycle and to wait until a rising edge appears at the SYNC pin. When a rising edge appears, the S/H goes into the "Hold" mode and the ADC begins to perform a conversion on the next rising edge of CLK. To make the SYNC pin serve as an input, the Configuration register's "SYNC I/O" bit (Bit 7) must be set to a "0". With SYNC configured as an input, it is possible to synchronize the start of a conversion to external events. When SYNC pin is defined as an output (SYNC I/O bit = 1) the SYNC bit in the instruction registers must not be set to 1.

When the LM12434 and LM12{L}438 are used in the "watchdog" mode with external synchronization, two rising edges on the SYNC input are required to initiate the two comparisons that are performed during a watchdog instruction. The first rising edge initiates the comparison of the selected analog input signal with Limit #1 (found in Instruction RAM "01") and the second rising edge initiates the comparison of the same analog input signal with Limit #2 (found in Instruction RAM "10").

Bit 9 is the TIMER bit. When Bit 9 is set to "1", the Sequencer will halt until the internal 16-bit Timer counts down to zero. During this time interval, no "watchdog" comparisons or analog-to-digital conversions will be performed.

Bit 10 selects the ADC conversion resolution. Setting Bit 10 to "1" selects 8-bit + sign and resetting to "0" selects 12-bit + sign.

Bit 11 is the "watchdog" comparison mode enable bit. When operating in the "watchdog" comparison mode, the selected analog input signal is compared with the programmable values stored in Limit #1 and Limit #2 (see Instruction RAM "01" and Instruction RAM "10"). Setting Bit 11 to "1" causes two comparisons of the selected analog input signal, one with each of the two stored limits. When Bit 11 is reset to "0", an 8-bit + sign or 12-bit + sign (depending on the state of Bit 10 of Instruction RAM "00") conversion of the input signal can take place.

4	A3	A2	A1	Purpose	Туре	D15 D14 D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
0	0 1	0 to 1	0 1	Instruction RAM (RAM Pointer = 00)	R/W	Acquisition Time		Watch- dog	8/12	Timer	Sync		S/H IN- (MUXIN-)	*		S/H IN+ /IUXIN+		Pause	Loop
0	0	0 to 1	0	Instruction RAM (RAM Pointer = 01)	R/W	Don	n't Care	Э		>/<	Sign				Limit	#1			
0	0	0 to 1	0	Instruction RAM (RAM Pointer = 10)	R/W	Don	n't Care	9		>/<	Sign				Limit	#2			
1	0	0	0	Configuration Register	R/W	Don't Care		DIAG†	Test = 0		AM nter	SYNC I/O	A/Z Each Cycle	I/S	Stand- by	Full CAL	Auto- Zero	Reset	Start
1	0	0	1	Interrupt Enable Register	R/W	Number of Co Results in F Generate Inter	FIFO to	0	N (nstructio lumber Generat errupt (If	to :e	INT7	x	INT5	INT4	INT3	INT2	INT1	INTO
1	0	1	0	Interrupt Status Register	R	Number of Conversion in FIF	Result			nstructio Numbe being Execute	r	INST7	x	INST5	INST4	INST3	INST2	INST1	INSTO
1	0	1	1	Timer Register	R/W	Tin	ner Pre	eset Higl	n Byte					Time	er Preset	Low By	te		
1	1	0	0	Conversion FIFO	R	Instruction Number or Extended Sign	Sign		Conve Data: I					Conv	version D	Data: LSF	3s		
1	1	0	1	Limit Status Register	R	· · · · ·	Limit	#2: Stat	us					1	imit #1:	Status			
Ť	LM1	2{L	}438	efer to Table IV). only. Must be set to ' is associated with thi: FIGU	s bit. W					-					isters				
Ť	LM1	2{L	}438	only. Must be set to ' is associated with this	s bit. W	hen programming				-					isters				
Ť	LM1	2{L	}438	only. Must be set to ' is associated with this	s bit. W	hen programming				-					isters				
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Ť	LM1	2{L	}438	only. Must be set to ' is associated with this	s bit. W	hen programming				-					isters				

	·	Auto Zero instruct	Full Cal sets the	Stand- by	I/S	/Z Each				D10	D11 [D12		5 D14
	·	instruct	sets the			Cycle	Sync /		RAM Pointer	Fest	Diag. 1		n't Care	Do
	·	instruct	sets the		n	n evecuti	structio	rts the i	n 1 sta	evecutio	instruction	ons the	Start: 0 st	0:
active	hip to a			s and re	register	n status	the bits	sets all	; also re	Start bit	o 1, resets automatical	nen set t	Reset: W	1: I
active	hip to a			med.	s perfor	n cycle i	alibrati	to-zero	ycle) aut	ong (8-c	set to 1 a lo	: When s	Auto-Zero	2: /
active	chip to ε		med.	is perfo	o-zero)	/ and aut	(linearit	on cycle	calibratio	1 a full o	hen set to	ration: W	ull Calib	3: I
		irn the o	will retu	g the bit	esettin	mode. F	standb	/-power	es to low	chip goe	et to 1 the o t delay.		Standby: node afte	
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-								1	1			1		struction:
DO	D1	D2	D3	D4	D5	D6	D7	D8	D9	D10	D11	D12	D13	5 D14
Loo	Pause		MUXIN+			MUXIN-		Sync	Timer	8/12	Watchdog		sition Time	Acqui
it. For	ing input d conve	's invert S/H an	the ADC	+. ected to NC is a	XOUT - s conne JT = SYI NC pin.	ed to MU channel i o MUXOU output. 1 ed to SYI	connec ch input nected is an nal appl	annel is lect whi el is con g, SYNC ernal sig	nput cha e bits se t channe al timing an exte	t which i 38, these ich input n, interna colled by	LM12{L}43 they select LM12{L}43 y select whi al operation is not used	M12434, For the 434, they Norma on) timin	For the L MUXIN he LM12 Sync: 0 comparis	17–D5: 1 18: 5
wn to	unts dov	timer co	gin until	es not de	ion doe								ero.	:
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				cles.	ock cyc	MHz].	× f _{CLK}	8-bit + $R_{S}[k\Omega]$	es. For 0.45 x 1 0.36 x	ock cycl –D12. for D \geq for D \geq	(9+2D) cleants of D15 Choose D Choose D Choose D t source res	+ sign: = Conte + sign: + sign:	For 12-bit Where D For 12-bit For 8-bit	
						3438 Inte	LM12{	34 and	r LM124	nents fo	Bit Assignm	URE 9. E	FIG	
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		ued)	(Continu	egisters	ernal R									
		ued)	(Continu	egisters	ernal R									
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D15 D14 D13 D12 D11 D10 D9 D8 D7 D6 D5 D4 D3 D2 Don't Care >/< Sign Limit D7-D0: Limit: 8-bit limit value. D8: Sign of limit value, 0 = Positive; 1 = Negative. D9: >/<: High Limit/Low limit. 0 = Inputs lower than limit generate interrupt, 1 = Inputs higher than linterrupt. D15-D10: Don't Care. INTERRUPT ENABLE REGISTER (Read/Write): INTERRUPT ENABLE REGISTER (Read/Write): D8 D7 D6 D5 D4 D3 D2 Number of Conversion	D1	erat
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D8: Sign: Sign of limit value, 0 = Positive; 1 = Negative. D9: >/<: High Limit/Low limit. 0 = Inputs lower than limit generate interrupt, 1 = Inputs higher than interrupt.	limit gen	erat
D9: >/<: High Limit/Low limit. 0 = Inputs lower than limit generate interrupt, 1 = Inputs higher than interrupt.	limit gen	erat
D15-D10: Don't Care. INTERRUPT ENABLE REGISTER (Read/Write): D15 D14 D13 D12 D11 D10 D9 D8 D7 D6 D5 D4 D3 D2	Ū	
INTERRUPT ENABLE REGISTER (Read/Write): D15 D14 D13 D12 D11 D10 D9 D8 D7 D6 D5 D4 D3 D2		
D15 D14 D13 D12 D11 D10 D9 D8 D7 D6 D5 D4 D3 D2		
D15 D14 D13 D12 D11 D10 D9 D8 D7 D6 D5 D4 D3 D2		
		_
	D1 INT1	
Results in FIFO to to Generate		IIN
Generate Interrupt (INT2) Interrupt (INT1)		
Bits # 0 to 7 enable interrupt generation for the following conditions when the bit is set to 1.		
D0: INT0: Generates an interrupt when a limit is passed in watchdog mode.		
D1: INT1: Generates an interrupt when the sequencer has loaded the instruction number contained in bits	D10, D9	, an
D8 of the Interrupt Enable register. D2: INT2: Generates an interrupt when the number of conversion results in the FIFO is equal to the progr	ammody	vəlu
(D15–D11).	annieu	vaiu
D3: INT3: Generates an interrupt when an auto-zero cycle is completed.		
D4: INT4: Generates an interrupt when a full calibration cycle is completed.		
D5: INT5: Generates an interrupt when a pause condition is encountered.		
D6: This bit is a don't care condition. No interrupt is associated with this bit.		
D7: INT7: Generates an interrupt when the chip is returned from standby and is ready for operation.	1	
D10–D8: Programmable instruction number used to generate an interrupt when that instruction has been reach D15–D11: Programmable number of conversion results in the FIFO to generate an interrupt.	eu.	
TIMER REGISTER (Read/Write):		
D15 D14 D13 D12 D11 D10 D9 D8 D7 D6 D5 D4 D3 D2	D1	D
N = Timer Preset Value		
The Timer delays the execution of an instruction if the Timer bit is set in that instruction.		
•		
The time delay is:		
The time delay is: Delay = $(32 \times N) + 2$ [Clock Cycles]		
$Delay = (32 \times N) + 2 [Clock Cycles]$		
Delay = $(32 \times N) + 2$ [Clock Cycles]		
Delay = $(32 \times N) + 2$ [Clock Cycles]		
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Delay = $(32 \times N) + 2$ [Clock Cycles]		

	nE013	TER (Rea	au orny).												
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D
	uction Nu Extended		Sign						Conversi	ion Result					
D11-	D0: C	onversior	n Result:												
	F	or 12-bit	+ sign:	12-bit re	sult valu	e									
	F	or 8-bit	+ sign:	D11-D4	= resu	ılt value,	D3-D0	= 1110							
D12:	Si	ign: Conv	ersion re	əsult sigr	n bit, 0 =	= Positiv	/e, 1 =	Negative)						
D15–		struction								tended s	sign bit f	or 2's co	ompleme	ent arithr	netic
	Se	elected by	y bit D5	(Channe	el Mask)	of the C	onfigura	tion regis	ster.						
INTE	RRUPT	STATUS	REGIS	TER (Re	ad only):	:									
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D
	Numbe	er of Unread	Results		Inst	ruction Nu	mber	INST7	х	INST5	INST4	INST3	INST2	INST1	INS
		in FIFO			Be	eing Execu	ted								
Bits #	#0 to 7	are interr	upt flags	s (vector	s) that w	/ill be se	t to 1 wh	nen the f	ollowing	conditio	ns occur	. The bit	ts are se	t to 1 wh	ethe
	•	is enable				•	able reg	jister. Th	e bits a	re reset	to 0 whe	en the re	egister is	read, or	by by
		through		-	-										
D0:		IST0: Is s						•							
D1:		IST1: Is s iterrupt E			e sequer	ncer has	loaded	the instru	uction nu	imber co	ontained	in bits D	010, D9,	and D8 (of th
D2:		IST2: Is s		0	mbor of	convers	ion resu	lte in ElE		ial to the	a progra	mmed v	alua (D1	5_011)	in th
DL.		iterrupt E				00110013	10111030	113 111 1	0 13 040		s progra			0-011)	in un
D3:	IN	IST3: Is s													
				wnen an	auto-ze	ro cycle	is comp	leted.							
D4:	IN	IST4: Is s					•								
D4: D5:			set to 1 v	when a f	ull calibr	aton cyc	cle is co	mpleted.							
	IN	IST4: Is s	set to 1 v set to 1 v	when a f	ull calibr	aton cyc	cle is co	mpleted.							
D5:	IN D	IST4: ls s IST5: ls s	set to 1 v set to 1 v	when a f when a p	ull calibr bause co	raton cyc ondition i	cle is col is encou	mpleted. ntered.	nd is rea	ıdy.					
D5: D6: D7:	IN D IN	IST4: Is s IST5: Is s on't care	set to 1 v set to 1 v set to 1 v	when a f when a p when the	full calibr bause co e chip is	raton cycondition i returned	cle is co is encou d from st	mpleted. ntered. andby a			bllowing	a Pause	or Time	r delay.	
D5: D6: D7: D10-	IN D IN 08: H	IST4: Is s IST5: Is s on't care IST7: Is s	set to 1 v set to 1 v set to 1 v set to 1 v	when a f when a p when the	full calibr pause co e chip is er prese	raton cycondition i returned ntly bein	cle is col is encou d from st ng execu	mpleted. ntered. andby a ted or w	ill be exe	ecuted for	-				usei
D5: D6: D7: D10- D15-	IN D IN D8: H D11: H	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i	set to 1 v set to 1 v set to 1 v nstructionumber of	when a f when a p when the on numbo of conve	ull calibr pause cc e chip is er prese rsion res	raton cycondition i returned ntly bein	cle is col is encou d from st ng execu	mpleted. ntered. andby a ted or w	ill be exe	ecuted for	-				usei
D5: D6: D7: D10– D15–	IN D D8: H D11: H	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i	set to 1 v set to 1 v set to 1 v instructionumber of STER (R	when a f when a p when the of conve lead only	full calibr pause co e chip is er prese rsion res /):	raton cycondition i returned ntly bein sults that	cle is col is encou d from st ng execu t have be	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF	=Cuted for =O but th	nat have	not yet l	been rea	d by the	1
D5: D6: D7: D10- D15-	IN D IN D8: H D11: H	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i	set to 1 v set to 1 v set to 1 v instruction number of STER (R	when a f when a p when the on numbor of conve tead only D11	full calibr pause cc e chip is er prese rsion res	raton cycondition i returned ntly bein	cle is col is encou d from st ng execu	mpleted. ntered. andby a ted or w	ill be exe	ecuted for	D4	not yet l D3			1
D5: D6: D7: D10- D15- LIMIT	IN D D8: H D11: H T STAT D14	IST4: Is s IST5: Is s on't care. IST7: Is s olds the i olds the i US REGI D13	set to 1 v set to 1 v set to 1 v set to 1 v instruction number of STER (R D12 Limit #2	when a f when a p when the on numbro of conve lead only D11 2: Status	ull calibr pause cc e chip is er prese rsion res /): D10	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D
D5: D6: D7: D10- D15- LIMIT D15 The b	IN D D8: H D11: H 5 STAT D14	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i US REGI D13	set to 1 v set to 1 v set to 1 v set to 1 v instruction number of STER (R D12 Limit #2 er are lim	when a f when a p when the on numbro of conve lead only D11 2: Status iit flags (ull calibr pause cc e chip is er prese rsion res /): D10	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D
D5: D6: D7: D10– D15– LIMIT D15 The b instru	IN D IN D8: H D11: H T STAT D14 Dits in th action lin	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i US REGI D13	set to 1 v set to 1 v set to 1 v instructionumber of STER (R D12 Limit #2 er are lim dicated l	when a f when a p when the on numbo f conve lead only D11 2: Status iit flags (below.	ull calibr pause cc e chip is er prese rsion res /): D10 vectors)	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D
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D5: D6: D7: D10- D15- LIMIT D15 The b instru D0: D1:	IN D D D8: H D11: H T STAT D14 Dits in th ction lir Limit # Limit #	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i US REGI US REGI nits registe nits as in 1 of Instr 1 of Instr	set to 1 v set to 1 v set to 1 v set to 1 v instruction number of STER (R D12 Limit #2 er are lim dicated l uction #	when a f when a p when the on numbo of conve tead only tead only 2: Status it flags (below. 0 is pas 1 is pas	ull calibr pause cc e chip is er prese rsion res /): D10 vectors) ssed. ssed.	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D
D5: D6: D7: D10- D15- LIMIT D15 The b instru D0: D1: D2:	IN DB: H DB: H D11: H T STAT D14 Dits in th iction lir Limit # Limit # Limit #	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i US REGI D13 nis registe nits as in 1 of Instr 1 of Instr 1 of Instr	set to 1 v set to 1 v set to 1 v instruction number of STER (R D12 Limit #2 er are lim dicated l uction # uction #	when a f when a p when the on numbo of conve tead only tead only 2: Status til flags (below. 0 is pas 1 is pas 2 is pas	ull calibr pause cc e chip is er prese rsion res /): D10 vectors) ssed. ssed. ssed. ssed.	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D
D5: D6: D7: D10– D15– LIMIT D15 The k instru D0: D1: D2: D3:	IN D8: H D11: H T STAT D14 Dits in the ction lin Limit # Limit # Limit #	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i US REGI D13 nis registe nits as in 1 of Instr 1 of Instr 1 of Instr 1 of Instr	set to 1 m set to 1 m set to 1 m instruction number of STER (R D12 Limit #2 er are lim dicated l uction # uction # uction #	when a f when a p when the on numbo of conve tead only tead only 2: Status til flags (below. 0 is pas 1 is pas 2 is pas 3 is pas	ull calibr pause cc e chip is er prese rsion res /): D10 vectors) ssed. ssed. ssed. ssed. ssed.	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D
D5: D6: D7: D10- D15- LIMI1 D15 The b instru D0: D1: D2: D3: D3: D4:	IN DB: H D11: H T STAT D14 D14 Dits in the ction lin Limit # Limit # Limit # Limit #	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i US REGI D13 nis registe nits as in 1 of Instr 1 of Instr 1 of Instr 1 of Instr 1 of Instr 1 of Instr	set to 1 m set to 1 m set to 1 m instruction number of STER (R D12 Limit #2 er are lim dicated l uction # uction # uction # uction #	when a f when a f when the on numbo of conve tead only tead only 2: Status til flags (below. 0 is pas 1 is pas 2 is pas 3 is pas 4 is pas	ull calibr pause cc e chip is er prese rsion res /): D10 vectors) ssed. ssed. ssed. ssed. ssed. ssed.	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D
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D5: D6: D7: D10- D15- D15- D15 D15 D1: D2: D3: D4: D5: D6: D7:	IN DB: H D11: H T STAT D14 D14 D14 D14 D14 D14 D14 D14 D14 D14	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i US REGI D13 nis registe nits as in 1 of Instr 1 of Instr	set to 1 m set to 1 m set to 1 m instruction number of STER (R D12 Limit #2 er are lim dicated l uction # uction # uction # uction # uction # uction # uction #	when a f when a f when the on numbo of conve tead only tead only 2: Status til flags (below. 2 is pas 2 is pas 3 is pas 5 is pas 5 is pas 5 is pas 5 is pas 5 is pas 5 is pas	ull calibr pause cc e chip is er prese rsion res /): D10 vectors) ssed. ssed	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D
D5: D6: D7: D10- D15- LIMIT D15 The k instru D0: D1: D2: D3: D4: D5: D6: D7: D8:	IN DB: H D11: H T STATI D14 D14 D14 Dits in the ction lin Limit # Limit # Limit # Limit # Limit # Limit # Limit #	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i US REGI I D13 	set to 1 m set to 1 m set to 1 m instruction number of STER (R D12 Limit #2 er are lim dicated l uction # uction #	when a f when a f when the on numbo of conve tead only tead only 2: Status til flags (below. 2 is pas 2 is pas 3 is pas 5 is pas	ull calibr pause cc chip is er prese rsion res /): D10 (vectors) seed.seed.	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D
D5: D6: D7: D10- D15- LIMIT D15 The k instru D0: D1: D2: D3: D4: D5: D6: D7: D8: D9:	IN DB: H D11: H T STATI D14 D14 D14 D14 D14 D14 D14 D14 D14 D14	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i US REGI I US REGI I D13 I I of Instr 1 of Instr	set to 1 m set to 1 m set to 1 m instruction number of STER (R D12 Limit #2 er are lim dicated l uction # uction # uctio	when a f when a f when the on numbo of conve tead only tead only 2: Status til flags (below. 2: Is pas 2: Is pas 3: Is pas 5:	ull calibr pause cc chip is er prese rsion res r): D10 vectors) seed.seed.	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D
D5: D6: D7: D10- D15- LIMIT D15 D15 D15 D1: D2: D3: D4: D5: D6: D7: D8: D7: D8: D9: D1:	IN DBS: H D11: H TSTATI D14 TSTATI D14 D14 D14 D14 D14 D14 D14 D14 D14 D14	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i US REGI I I D13 I I of Instr 1 of Instr 2 of Instr 2 of Instr 2 of Instr 2 of Instr	set to 1 m set to 1 m set to 1 m instruction number of STER (R D12 Limit # 2 er are lim dicated l uction # uction # ucti	when a f when a f when the on numbro of conver- tead only tead only 2: Status 1: I is pas 1: I is pas	ull calibr pause cc c chip is er prese rsion res r): D10 (vectors) seed.seed.	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D
D5: D6: D7: D10- D15- LIMIT D15 The k instru D0: D1: D2: D3: D4: D5: D6: D7: D8: D7: D8: D9: D10: D1: D1: D1: D1: D1: D15- LIMIT	IN DBS: H D11: H TSTATI D14 TSTATI D14 D14 D14 D14 D14 D14 D14 D14 D14 D14	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i US REGI I D13 	set to 1 m set to 1 m set to 1 m instruction number of STER (R D12 Limit # 2 er are lim dicated l uction # uction # ucti	when a f when a f when the on number of conver- tead only tead only 2: Status til flags (below. 2: Is pas 2: Is pas 3: Is pas 4: Is pas 5: Is pas 5: Is pas 5: Is pas 6: Is pas 7: Is pas	ull calibr pause cc chip is er prese rsion res r): D10 vectors) seed.s	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D
D5: D6: D7: D10- D15- LIMIT D15 D15 D15 D15 D2: D3: D4: D5: D6: D7: D8: D9: D10: D10: D11: D11: D12:	IN DBS: H D11: H TSTATI D14 TSTATI D14 D14 D14 D14 D14 D14 D14 D14 D14 D14	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i US REGI I I D13 I I OF Instr 1 of Instr 2 of Instr	set to 1 m set to 1 m set to 1 m instruction number of STER (R D12 Limit # 2 er are lim dicated l uction # uction # ucti	when a f when a f when the on numbro of conver- tead only <u>D11</u> 2: Status it flags (below. 1 is pas 1 is pas 2 is pas 3 is pas 1 is pas 5 is pas 6 is pas 6 is pas 7 is pas 1 is pas 2 is pas 3 is pas 1 is pas 3 is pas 3 is pas 3 is pas 4 is pas 4 is pas 5 is pas 5 is pas 6 is pas 5 is pas 6 is pas 6 is pas 7 is pas 6 is pas 7 is pas	ull calibr pause cc c chip is er prese rsion res r): D10 vectors) seed. seed	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D
D5: D6: D7: D10- D15- LIMIT D15 D15 D15 D15 D2: D3: D4: D2: D3: D4: D5: D6: D7: D8: D9: D10: D10: D11: D1: D1: D1: D1: D1: D1: D1: D1: D	IN DBS: H D11: H TSTATI D14 TSTATI D14 D14 D14 D14 D14 D14 D14 D14 D14 D14	IST4: Is s IST5: Is s on't care IST7: Is s olds the i olds the i US REGI I D13 	set to 1 m set to 1 m set to 1 m instruction set to 1 m instruction sTER (R D12 Limit # 2 er are lim dicated l uction # uction #	when a f when a f when the on numbro of conver- tead only <u>D11</u> 2: Status it flags (below. 1 is pas 1 is pas 2 is pas 3 is pas 1 is pas 5 is pas 6 is pas 6 is pas 1 is pas 5 is pas 6 is pas 1 is pas 5 is pas 6 is pas 1 is pas 5 is pas 6 is pas 5 is pas 5 is pas 6 is pas 5 is pas 5 is pas 6 is pas 6 is pas 5 is pas 5 is pas 6 is pas 6 is pas 7 is pas 6 is pas 7 is pas 7 is pas 6 is pas 7 is pas 7 is pas 6 is pas 7 is pas	ull calibr pause cc c chip is er prese rsion res (): D10 (vectors) seed. ses	returned ntly bein sults that	cle is co is encou d from st ng execu t have be D8	mpleted. ntered. andby a ted or w een put i	ill be exe n the FIF D6	D5	D4	D3 1: Status	been rea	d by the	D

6.0 Operational Information (Continued)

Bits 12-15 store the user-programmable acquisition time. The Sequencer keeps the internal S/H in the acquisition mode for a fixed number of clock cycles (nine clock cycles, for 12-bit + sign conversions and two clock cycles for 8-bit + sign conversions or "watchdog" comparisons) plus a variable number of clock cycles equal to twice the value stored in Bits 12-15. Thus, the S/H's acquisition time is (9 + 2D) clock cycles for 12-bit + sign conversions and (2 + 2D) clock cycles for 8-bit + sign conversions or "watchdog" comparisons, where D is the value stored in Bits 12-15. The minimum acquisition time compensates for the typical internal multiplexer series resistance of 2 k Ω , and any additional delay created by Bits 12-15 compensates for source resistances greater than 60Ω { 80Ω }. The necessary acquisition time is determined by the source impedance at the multiplexer input. If the source resistance $R_S < 60\Omega$ and the clock frequency is 8 MHz, the value stored in bits 12–15 (D) can be 0000. If $R_S > \, 60 \Omega,$ the following equations determine the value that should be stored in bits 12-15.

 $\mathsf{D}=0.45\,\mathsf{x}\,\mathsf{R}_{\mathsf{S}}\,\mathsf{x}\,\mathsf{f}_{\mathsf{CLK}}$

for 12-bits $\,+\,$ sign $D = 0.36\,x\,R_S\,x\,f_{CLK}$

for 8-bits + sign and "watchdog"

 R_S is in $k\Omega$ and f_{CLK} is in MHz. Round the result to the next higher integer value. If the value of 0 obtained from the expressions above is greater than 15, it is advisable to lower the source impedance by using an analog buffer between the signal source and the LM12{L}438's multiplexer inputs. The value of D can also be used to compensate for the settling or response time of external processing circuits connected between the LM12434's MUXOUT and S/H IN pins.

Instruction RAM, Bank 2 RP = 01

The second Instruction RAM section is selected by placing "01" in Bits 8 and 9 of the Configuration register.

Bits 0–7 hold "watchdog" **limit** #1. When Bit 11 of Instruction RAM "00" is set to a "1", the LM12434 and LM12{L}438 performs a "watchdog" comparison of the sampled analog input signal with the limit #1 value first, followed by a comparison of the same sampled analog input signal with the value found in limit #2 (Instruction RAM "10").

Bit 8 holds limit #1's sign.

Bit 9's state determines the limit condition that generates a "watchdog" interrupt. A "1" causes a voltage greater than limit # 1 to generate an interrupt, while a "0" causes a voltage less than limit # 1 to generate an interrupt.

Bits 10-15 are not used.

Instruction RAM, Bank 3, RP = 10

The third Instruction RAM section is selected by placing "10" in Bits 8 and 9 of the Configuration register.

Bits 0–7 hold "watchdog" **limit** #2. When Bit 11 of Instruction RAM "00" is set to a "1", the LM12434 and LM12{L}438 performs a "watchdog" comparison of the sampled analog input signal with the limit #1 value first (Instruction RAM "01"), followed by a comparison of the same sampled analog input signal with the value found in limit #2. **Bit 8** holds limit #2's sign.

Bit 9's state determines the limit condition that generates a "watchdog" interrupt. A "1" causes a voltage greater than limit #2 to generate an interrupt, while a "0" causes a voltage less than limit #2 to generate an interrupt. **Bits 10–15** are not used.

TABLE III. LM12{L}438 Operating Mode Input Channel Selection through Input Multiplexer

Normal Operating Mode						
Non-Inverting Input Channel Selection Bits in Instruction Register D4, D3, D2	Input Channel to Be Connected to A/D Non-Inverting Input (IN+)	Inverting Input Channel Selection Bits in Instruction Register D7, D6, D5	Input Channel to Be Connected to A/D Inverting Input (IN-)			
000	IN0	000	GND			
001	IN1	001	IN1			
010	IN2	010	IN2			
011	IN3	011	IN3			
100	IN4	100	IN4			
101	IN5	101	IN5			
110	IN6	110	IN6			
111	IN7	111	IN7			

TABLE IV. LM12434 Input Channel Selection through Input Multiplexer						
Normal Operating Mode						
Non-Inverting Input Channel Selection Bits in Instruction Register D4, D3, D2	Input Channel to Be Connected to MUX Non-Inverting Output (MUXOUT+)	Inverting Input Channel Selection Bits in Instruction Register D7, D6, D5	Input Channel to Be Connected to MUX Inverting Output (MUXOUT-)			
000	INO	000	GND			
001	IN1	001	IN1			
010	IN2	010	IN2			
011	IN3	011	IN3			
1XX	None	1XX	None			

TABLE V. LM12{L}438 Diagnostic Mode Input Channel Selection through Input Multiplexer						
	Diagnostic Mode					
Non-Inverting Input Channel Selection Bits in Instruction Register D4, D3, D2	Input Channel to Be Connected to A/D Non-Inverting Input (IN+)	Inverting Input Channel Selection Bits in Instruction Register D7, D6, D5	Input Channel to Be Connected to A/D Inverting Input (IN-)			
000	None	000	None			
001	V _{REF} +	001	V _{REF} -			
010	IN2	010	IN2			
011	IN3	011	IN3			

100

101

110

111

IN4

IN5 IN6

IN7

IN4

IN5

IN6

IN7

100

101

110

111

6.0 Operational Information (Continued)

6.2.2 Configuration Register

The Configuration register is a 16-bit control register with read/write capability. It acts as the LM12434's and LM12{L}438's "control panel" holding global information as well as start/stop, reset, self-calibration, and stand-by commands.

Bit 0 is the START/STOP bit. Reading Bit 0 returns an indication of the Sequencer's status. A "0" indicates that the Sequencer is stopped and waiting to execute the next instruction. A "1" shows that the Sequencer is running. Writing a "0" halts the Sequencer when the current instruction has finished execution. The next instruction to be executed is pointed to by the instruction pointer found in the status register. Writing a "1" to Bit 0 restarts the Sequencer with the instruction currently pointed to by the instruction pointer. (See Bits 8–10 in the Interrupt Status register.)

Bit 1 is the DAS' system RESET bit. Writing a "1" to Bit 1 stops the Sequencer (resetting the Configuration register's START/STOP bit), resets the Instruction pointer to "000" (found in the Interrupt Status register), clears the Conversion FIFO, and resets all interrupt flags. The RESET bit will return to "0" after two clock cycles unless it is forced high by writing a "1" into the Configuration register's Standby bit. A reset signal is internally generated when power is first applied to the part. No operation should be started until the RESET bit is "0".

Bit 2 is the auto-zero bit. Writing a "1" to this bit initiates an auto-zero offset voltage calibration. Unlike the eight-sample auto-zero calibration performed during the full calibration procedure, Bit 2 initiates a "short" auto-zero by sampling the offset once and creating a correction coefficient (full calibration averages eight samples of the converter offset voltage when creating a correction coefficient). If the Sequencer is running when Bit 2 is set to "1", an auto-zero starts immediately after the conclusion of the currently running instruction. Bit 2 is reset automatically to a "0" and an interrupt flag (Bit 3, in the Interrupt Status register) is set at the end of the auto-zero (76 clock cycles). After completion of an auto-zero calibration, the Sequencer fetches the next instruction as pointed to by the Instruction RAM's pointer and resumes execution. If the Sequencer is stopped, an auto-zero is performed immediately at the time requested.

Bit 3 is the calibration bit. Writing a "1" to this bit initiates a complete calibration process that includes a "long" autozero offset voltage correction (this calibration averages eight samples of the comparator offset voltage when creating a correction coefficient) followed by an ADC linearity calibration. This complete calibration is started after the currently running instruction is completed if the Sequencer is running when Bit 3 is set to "1". Bit 3 is reset automatically to a "0" and an interrupt flag (Bit 4, in the Interrupt Status register) will be generated at the end of the calibration procedure (4944 clock cycles). After completion of a full autozero and linearity calibration, the Sequencer fetches the next instruction as pointed to by the Instruction RAM's pointer and resumes execution. If the Sequencer is stopped, a full calibration is performed immediately at the time reauested.

Bit 4 is the Standby bit. Writing a "1" to Bit 4 immediately places the DAS in Standby mode. Normal operation returns when Bit 4 is reset to a "0". The Standby command ("1") disconnects the external clock from the internal circuitry, decreases the LM12434 and LM12{L}438's internal

analog circuitry power supply current, and preserves all internal RAM contents. After writing a "0" to the Standby bit, the DAS returns to an operating state identical to that caused by exercising the RESET bit. A Standby completion interrupt is issued after a power-up delay to allow the analog circuitry to settle. The Sequencer should be restarted only after the Standby completion interrupt is issued (see Note 22). The Instruction RAM can still be accessed through read and write operations while the LM12434 and LM12{L}438 are in Standby Mode.

Bit 5 is the Channel Address Mask. If Bit 5 is set to a "1", Bits 13–15 in the conversion FIFO will be equal to the sign bit (Bit 12) of the conversion data. Resetting Bit 5 to a "0" causes conversion data Bits 13 through 15 to hold the instruction pointer value of the instruction to which the conversion data belongs.

Bit 6 selects a "short" auto-zero correction for every conversion. The Sequencer automatically inserts an auto-zero before every conversion or "watchdog" comparison if Bit 6 is set to "1". No automatic correction will be performed if Bit 6 is reset to "0".

The DAS' offset voltage, after calibration, has a typical drift of 0.1 LSB over a temperature range of -40° C to $+85^{\circ}$ C. This small drift is less than the variability of the change in offset that can occur when using the auto-zero correction with each conversion. This variability is the result of using only one sample of the offset voltage to create a correction value. This variability decreases when using the full calibration mode because eight samples of the offset voltage are taken, averaged, and used to create a correction value. Therefore, it is recommended that this mode not be used.

Bit 7 programs the SYNC pin (29) to operate as either an input or an output. The SYNC pin becomes an output when Bit 7 is a "1" and an input when Bit 7 is a "0". With SYNC programmed as an input, the rising edge of any logic signal applied to pin 29 will start a conversion or "watchdog" comparison. Programmed as an output, the logic level at pin 29 will go high at the start of a conversion or "watchdog" comparison and remain high until either have finished. See Instruction RAM "00", Bit 8.

Bits 8 and 9 form the RAM Pointer that is used to select each of a 48-bit instruction's three 16-bit sections during read or write actions. A "00" selects Instruction RAM section one, "01" selects section two, and "10" selects section three.

Bit 10 activates the Test mode that is used only during production testing. Always write "0" in this bit when programming the Instruction Register.

Bit 11 is the Diagnostic bit and is available only in the LM12{L}438. It can be activated by setting it to a "1". The Diagnostic mode, along with a properly chosen instruction, allows verification that the LM12{L}438's ADC is performing correctly. When activated, the inverting and non-inverting inputs are connected as shown in Table V. As an example, an instruction with "001" for both IN+ and IN- while using the Diagnostic mode typically results in a full-scale output.

6.2.3 Interrupts

The LM12434 and LM12{L}438 have seven possible interrupts, all with the same priority. Any of these interrupts will cause a hardware interrupt to appear on the $\overline{\text{INT}}$ pin (31) if

6.0 Operational Information (Continued)

they are not masked (by the Interrupt Enable register). The Interrupt Status register is then read to determine which of the seven interrupts has been issued.

The Interrupt Status register must be cleared by reading it after writing to the Interrupt Enable register. This removes any spurious interrupts on the $\overline{\text{INT}}$ pin generated during an Interrupt Enable register access.

Interrupt 0 is generated whenever the analog input voltage on a selected multiplexer channel crosses a limit while the LM12434 and LM12{L}438 are operating in the "watchdog" comparison mode. Two sequential comparisons are made when the LM12434 and LM12{L}438 are executing a "watchdog" instruction. Depending on the logic state of Bit 9 in the Instruction RAM's second and third sections, an interrupt will be generated either when the input signal's magnitude is greater than or less than the programmable limits. (See the Instruction RAM, Bit 9 description.) The Limit Status register will indicate which preprogrammed limit (#1 or #2) was crossed, and which instruction was executing when the limit was crossed.

Interrupt 1 is generated when the Sequencer reaches the instruction counter value specified in the Interrupt Enable register's bits 8–10. This flag appears before the instruction's execution. Instructions continue to execute as programmed.

Interrupt 2 is activated when the Conversion FIFO holds a number of conversions equal to the programmable value stored in the Interrupt Enable register's Bits 11–15. This value ranges from 00000 to 11111, with 00001 to 11111 representing 1 to 31 conversions stored in the FIFO, and 00000 generating an interrupt after 32 conversions. See Section 6.2.8 for more FIFO information.

The completion of the short, single-sampled auto-zero calibration generates Interrupt 3.

The completion of a full auto-zero and linearity self-calibration generates **Interrupt 4**.

Interrupt 5 is generated when the Sequencer encounters an instruction that has its Pause bit (Bit 1 in Instruction RAM "00") set to "1".

Interrupt 7 is issued after a short delay (10 ms typ) while the DAS returns from Standby mode to active operation using the Configuration register's Bit 4. This short delay allows the internal analog circuitry to settle sufficiently, ensuring accurate conversion results (see Note 22).

6.2.4 Interrupt Enable Register

The Interrupt Enable register at address location 1001 has READ/WRITE capability. An individual interrupt's ability to produce an external interrupt at pin 31 (\overline{INT}) is accomplished by placing a "1" in the appropriate bit location. Any of the internal interrupt-producing operations will set their corresponding bits to "1" in the Interrupt Status register regardless of the state of the associated bit in the Interrupt Enable register. See Section 2.3 for more information about each of the eight internal interrupts.

Bit 0 enables an external interrupt when an internal "watchdog" comparison limit interrupt has taken place.

Bit 1 enables an external interrupt when the Sequencer has reached the address stored in Bits 8–10 of the Interrupt Enable register.

Bit 2 enables an external interrupt when the Conversion FIFO's limit, stored in Bits 11–15 of the Interrupt Enable register, has been reached.

Bit 3 enables an external interrupt when the single-sampled auto-zero calibration has been completed.

Bit 4 enables an external interrupt when a full auto-zero and linearity self-calibration has been completed.

Bit 5 enables an external interrupt when an internal Pause interrupt has been generated.

Bit 6 don't care condition.

Bit 7 enables an external interrupt when the LM12434 and LM12{L}438 returns from standby to active mode (see Note 22).

Bits 8–10 form the storage location of the user-programmable value against which the Sequencer's address is compared. When the Sequencer reaches an address that is equal to the value stored in Bits 8–10, an internal interrupt is generated and appears in Bit 1 of the Interrupt Status register. If Bit 1 of the Interrupt Enable register is set to "1", an external interrupt will appear at pin 31 (INT).

The value stored in bits 8-10 ranges from 000 to 111, representing 1 to 8 instructions stored in the Instruction RAM. After the Instruction RAM has been programmed and the RESET bit is set to "1", the Sequencer is started by placing a "1" in the Configuration register's START bit. Setting the INT 1 trigger value to 000 does not generate an INT 1 the first time the Sequencer retrieves and decodes Instruction 000. The Sequencer generates INT 1 (by placing a "1" in the Interrupt Status register's Bit 1) the second time and every subsequent time that the Sequencer encounters Instruction 000. It is important to remember that the Sequencer continues to operate even if an Instruction interrupt (INT 1) is internally or externally generated. The only mechanisms that stop the Sequencer are an instruction with the PAUSE bit set to "1" (halts before instruction execution), placing a "0" in the Configuration register's START bit, or placing a "1" in the Configuration register's RESET bit.

Bits 11–15 hold the number of conversions that must be stored in the Conversion FIFO in order to generate an internal interrupt. This internal interrupt appears in Bit 2 of the Interrupt Status register. If Bit 2 of the Interrupt Enable register is set to "1", an external interrupt will appear at pin 31 (INT).

6.2.5 Interrupt Status Register

This read-only register is located at address 1010. The corresponding flag in the Interrupt Status register goes high ('1')' any time that an interrupt condition takes place, whether an interrupt is enabled or disabled in the Interrupt Enable register. Any of the active ('1')' Interrupt Status register flags are reset to ''0'' whenever this register is read or a device reset is issued (see Bit 1 in the Configuration Register).

Bit 0 is set to "1" when a "watchdog" comparison limit interrupt has taken place.

Bit 1 is set to "1" when the Sequencer has reached the address stored in Bits 8–10 of the Interrupt Enable register. **Bit 2** is set to "1" when the Conversion FIFO's limit, stored in Bits 11–15 of the Interrupt Enable register, has been reached.

Bit 3 is set to "1" when the single-sampled auto-zero has been completed.

Bit 4 is set to "1" when an auto-zero and full linearity selfcalibration has been completed.

Bit 5 is set to "1" when a Pause interrupt has been generated.

6.0 Operational Information (Continued)

 $\ensuremath{\text{Bit}}\xspace 6$ no interrupt is associated with this bit. Don't care condition.

Bit 7 is set to "1" when the DAS returns from standby to active mode (see Note 22).

Bits 8–10 hold the Sequencer's current instruction number while it is running.

Bits 11–15 hold the current number of conversion results stored in FIFO but have not been read by the user. After each conversion, the result will be stored in the FIFO and the contents of these bits incremented by one. Each single read from FIFO decrements the contents of these bits by one. If more than 32 conversion results being stored in FIFO the numbers on these bits roll over from "11111" to "00000" and continue incrementing. If reads are performed from FIFO more than the number of conversions stored in it, the contents of these bits roll back from "00000" to "11111" and continue decrementing.

6.2.6 Limit Status Register

This read-only register is located at address 1101. This register is used in tandem with the Limit #1 and Limit #2 registers in the Instruction RAM. Whenever a given instruction's input voltage exceeds the limit set in its corresponding Limit register (#1 or #2) a bit corresponding to the instruction number is set in the Limit Status register. Any of the active ("1") Limit Status flags are reset to "0" whenever this register is read or a device reset is issued (see Bit 1 in the Configuration register). This register holds the status of limits #1 and #2 for each of the eight instructions.

Bits 0–7 show the Limit #1 status. Each bit will be set high (''1') when the corresponding instruction's input voltage exceeds the threshold stored in the instruction's Limit #1 register. When, for example, instruction 3 is a "watchdog" operation (Bit 11 is set high) and the input for instruction 3 meets the magnitude and/or polarity data stored in instruction 3's Limit #1 register, Bit 3 in the Limit Status register will be set to a "1".

Bits 8–15 show the Limit #2 status. Each bit will be set high ('1') when the corresponding instruction's input voltage exceeds the threshold stored in the instruction's Limit #2 register. When, for example, the input to instruction 6 meets the value stored in instruction 6's Limit #2 register, Bit 14 in the Limit Status register will be set to a "1".

6.2.7 Timer

The LM12434 and LM12{L}438 have an on-board 16-bit timer that includes a 5-bit pre-scaler. It uses the clock signal applied to pin 23 as its input. It can generate time intervals of 0 through 2^{21} clock cycles in steps of 2^{5} . This time interval can be used to delay the execution of instructions. It can also be used to slow the conversion rate when converting slowly changing signals. This can reduce the amount of redundant data stored in the FIFO and retrieved by the controller.

The user-defined timing value used by the Timer is stored in the 16-bit READ/WRITE Timer register at location 1011 and is pre-loaded automatically. Bits 0–7 hold the preset value's low byte and Bits 8–15 hold the high byte. The Timer is activated by the Sequencer only if the current instruction's Bit 9 is set ("1"). If the equivalent decimal value "N" ($0 \le N \le 2^{16} - 1$) is written inside the 16-bit Timer register and the Timer is enabled by setting an instruction's bit 9 to a "1", the Sequencer will delay that instruction's execution by halting at state 3 (S3), as shown in *Figure 11*, for $32 \times N + 2$ clock cycles.

6.2.8 FIFO

The result of each conversion is stored in an internal readonly FIFO (First-In, First-Out) register. It is located at address 1100. This register has 32 16-bit wide locations. Each location holds 13 bits of conversion data. Bits 0–3 hold the four LSBs in the 12 bits + sign mode or "1110" in the 8 bits + sign mode. Bits 4–11 hold the eight MSBs and Bit 12 holds the sign bit. Bits 13–15 can hold either the sign bit, extending the register's two's complement data format to a full sixteen bits or the instruction address that generated the conversion and the resulting data. These modes are selected according to the logic state of the Configuration register's Bit 5.

The FIFO status should be read in the Interrupt Status register (Bits 11–15) to determine the number of conversion results that are held in the FIFO before retrieving them. This will help prevent conversion data corruption that may take place if the number of reads are greater than the number of conversion results contained in the FIFO. Trying to read the FIFO when it is empty may corrupt new data being written into the FIFO. Writing more than 32 conversion results into the FIFO. Writing more than 32 conversion results into the FIFO by the ADC results in loss of the first conversion results. Therefore, to prevent data loss, it is recommended that the LM12434 and LM12{L}438's interrupt capability be used to inform the system controller that the FIFO is full.

Bits 0–12 hold 12-bit + sign conversion data. **Bits 0–3** will be 1110 when using 8-bit plus sign resolution.

Bits 13–15 hold either the instruction responsible for the associated conversion data or the sign bit. Either mode is selected with Bit 5 in the Configuration register.

Using the FIFO's full depth is achieved as follows. Set the value of the Interrupt Enable registers's Bits 11-15 to 00000 and the Interrupt Enable register's Bit 2 to a "1". This generates an external interrupt when the 31st conversion is stored in the FIFO. This gives the host processor a chance to send a "0" to the LM12434 and LM12{L}438's Start bit (Configuration register) and halt the ADC before it completes the 32nd conversion. The Sequencer halts after the current (32) conversion is completed. The conversion data is then transferred to the FIFO and occupies the 32nd location. FIFO overflow is avoided if the Sequencer is halted before the start of the 32nd conversion by placing a "0" in the Start bit (Configuration register). It is important to remember that the Sequencer continues to operate even if a FIFO interrupt (INT 2) is internally or externally generated. The only mechanisms that stop the Sequencer are an instruction with the PAUSE bit set to "1" (halts before instruction execution), placing a "0" in the Configuration register's START bit, or placing a "1" in the Configuration register's RESET bit.

6.0 Operational Information (Continued)

6.3 INSTRUCTION SEQUENCER

The Sequencer uses a 3-bit counter (Instruction Pointer, or IP) to retrieve the programmable conversion instructions stored in the Instruction RAM. The counter is reset to 000 during chip reset or if the current executed instruction has its Loop bit (Bit 1 in any Instruction RAM "00") set high ("1"). It increments at the end of the currently executed instruction and points to the next instruction. It will continue to increment up to 111 unless an instruction's Loop bit is set. If this bit is set, the counter resets to "000" and execution begins again with the first instruction. If all instructions have their Loop bit reset to "0", the Sequencer will execute all eight instructions continuously. Therefore, it is important to realize that if less than eight instructions are programmed, the Loop bit on the last instruction must be set. Leaving this bit reset to "0" allows the Sequencer to execute "unprogrammed" instructions, the results of which may be unpredictable.

The Sequencer's Instruction Pointer value is readable at any time and is found in the Status register at Bits 8–10. *Figure 10* illustrates the instruction execution flow as performed by the sequencer. The Sequencer can go through eight states during instruction execution:

State 0: The current instruction's first 16 bits are read from the Instruction RAM "00". This state is one clock cycle long.

State 1: Checks the state of the Calibration and Start bits. This is the "rest" state whenever the Sequencer is stopped using the reset, a Pause command, or the Start bit is reset low ("0"). When the Start bit is set to a "1", this state is one clock cycle long. **State 2:** Perform calibration. If bit 2 or bit 6 of the Configuration register is set to a "1", state 2 is 76 clock cycles long. If the Configuration register's bit 3 is set to a "1", state 2 is 4944 clock cycles long.

State 3: Run the internal 16-bit Timer. The number of clock cycles for this state varies according to the value stored in the Timer register. The number of clock cycles is found by using the expression below

$$32T+2 \label{eq:32T}$$
 where 0 \leq T \leq 2^{16} $-1.$

State 7: Sample the input signal and read Limit #1's value if needed. The number of clock cycles for acquiring the input signal in the 12-bit + sign mode varies according to

where D is the user-programmable 4-bit value stored in bits 12–15 of Instruction RAM "00" and is limited to 0 \leq D \leq 15.

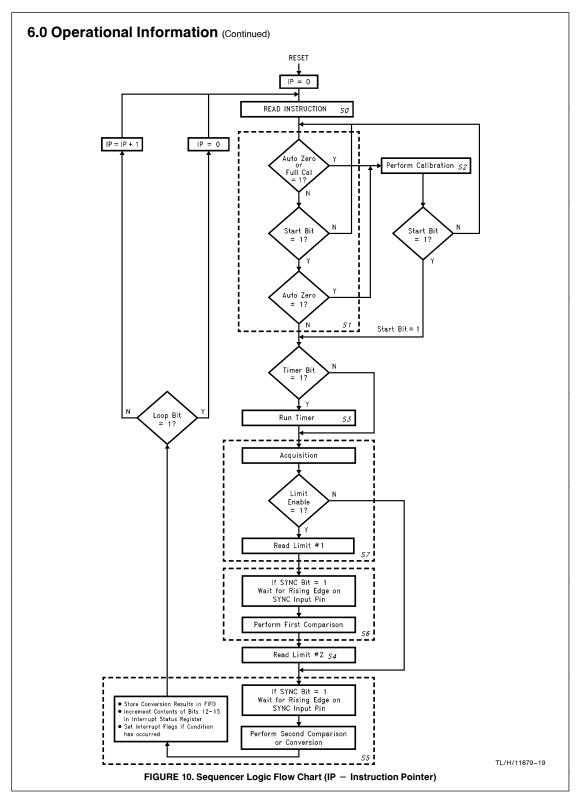
The number of clock cycles for acquiring the input signal in the 8-bit $\,+\,$ sign or "watchdog" mode varies according to

2 + 2D

State 6: Perform first watchdog comparison. This state is 5 clock cycles long.

State 4: Read Limit #2. This state is 1 clock cycle long.

State 5: Perform a conversion or second watchdog comparison. This state takes 44 clock cycles for a 12-bit + sign conversions or 21 clock cycles for a 8-bit + sign conversions. The "watchdog" comparison mode takes 5 clock cycles.



7.0 Digital Interface

In order to read from or write to the registers of the LM12434 and LM12{L}438 a very flexible serial synchronous interface is provided. Communication between the LM12434 and LM12{L}438 and microcontrollers, microprocessors and other circuitry is accomplished through this serial interface. The serial interface is designed to directly communicate with synchronous serial interface of the most popular microprocessors and 1²C serial protocol with no additional hardware required. The interface has been also designed to accommodate easy and straightforward software programming.

The LM12434 and LM12{L}438 supports four selectable protocols as shown in Table VI. The MODESEL1 and MODESEL2 inputs select the desired protocol. These pins are normally hardwired for a selected protocol, but they can also be controlled by the system in case a protocol change within the system is required. P1–P5 are multi-function serial interface input or output pins that have different assignments depending on the selected interface mode.

The "Standard" interface mode uses a simple shift register type of serial data transfer. It supports several microcontrollers' serial synchronous protocols, including: National Semiconductor's MICROWIRE/PLUS, Motorola's SPI, QSPI, and Hitachi's synchronous SCI. Section 7.1.1 shows general block diagrams of how the serial DAS, configured in the Standard Interface Mode, can be connected to the HPC and 68HC11. Also, detailed assembly routines are included for single writes, single reads and burst read operations.

The "8051" mode supports the synchronous serial interface of the 8051 family of microcontrollers (8051 serial interface Mode 0). It is also compatible with the serial interface in the MCS-96 family of 16-bit microcontrollers. Section 7.2.1 shows a general block diagram of how the serial DAS, configured in the 8051 Interface Modes can be connected to the 8051 family of μ Cs. Also, detailed assembly routines for a single write, single read and burst read operations are included.

The "TMS320" mode is designed to directly interact with the serial interface of the TMS320C3x and TMS320C5x families of digital signal processors. This interface is also compatible with the similar serial interfaces on the DSP56000 and the ADSP2100 families of DSP processors. Section 7.3.1 shows a general block diagram of how the serial DAS, configured in the TMS320 interface mode, can be connected to the TMS320C3x family of DSP processors. Also, detailed assembly routines for a single write, single read and burst read operations are included. The "I²C" mode supports the Philips' I²C bus specification for both the standard (100 kHz maximum data rate) and the fast (400 kHz maximum data rate) modes of operation. The DAS behaves as a slave device on the I²C bus and receives and transmits the information under the control of a bus master. Section 7.4.1 shows a general block diagram of how the serial DAS, configured in the I²C Interface mode, can be connected to an I²C bus using an I²C controller (PCD8584).

All the serial interface modes allow for three basic types of data transfer; these are single write, single read and burst read. In a single write or read, 16 bits (2 bytes) of data is written to or read from one of the registers inside the DAS. In a burst read, multiple reads are performed from one register address information for each read. The burst read can be performed on any LM12434 and LM12{L}343's register, however it is primarily provided for multiple reads from the FIFO register (on conversion results is stored.

7.1 STANDARD INTERFACE MODE

The standard interface mode is a simple shift register type of serial data transfer. The serial clock synchronizes the transfer of data to and from the LM12434 and LM12{L}438. The interface uses 4 lines: 2 data lines (DI and DO), a serial clock line (SCLK) and a chip-select (CS) line. More than one device can share the data and serial clock lines provided that each device has its own chip-select line.

The LM12434 and LM12{L}438 standard mode is selected when the MODESEL1 and MODESEL2 pins have the logic state of "01". *Figure 12* shows a typical connection diagram for the LM12434 and LM12{L}438 standard mode serial interface. The CS, DI, DO, and SCLK lines are respectively assigned to interface pins P2 through P5. The P1 pin is assigned to a signal called R/F (Rise/Fall). The logic level on this pin specifies the polarity of the serial clock:

- If R/F = 1, data is shifted after falling edge and is stable and captured at the rising edge of the SCLK.
- If R/F = 0, data is shifted after rising edge and is stable and captured at the falling edge of the SCLK.

Interface Mode	M0DESEL1	MODESEL2	P1	P2	P3	P4	P5
Standard	0	1	R/F	CS	DI	DO	SCLK
8051	0	0	1*	1*	CS	RXD	TXD
TMS320	1	1	FSR	FSX	DX	DR	CLK
I ² C	1	0	Slave AD0	Slave AD1	Slave AD2	SDA	SCL

TABLE VI. LM12434 and LM12{L}438 Interface Modes and Pin Assignments

*Internally pulled-up

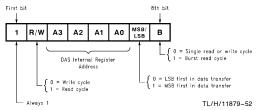
In both cases the data transfer is insensitive to idle state of the SCLK. SCLK can stay at either logic level high or low when not clocking (see *Figure 11*)

Data transfer in this mode is basically byte-oriented. This is compatible with the serial interface of the target microcontrollers and microprocessors. As mentioned, the LM12434 and LM12{L}438 have three different communication cycles: write cycle, read cycle and burst read cycle. At the start of each data transfer cycle, "command byte" is written to the serial DAS, followed by write or read data. The command byte informs the LM12434 and LM12{L}438 about the communication cycle. The command byte carries the following information:

what type of data transfer (communication cycle) is started

- which device register to be accessed

The command byte has the following format:



Note that the first bit may be either the MSB or the LSB of the byte depending on the processor type, but it must be the first bit transmitted to the LM12434 and LM12{L}438.

Figure 11 shows the timing diagrams for different communication cycles. *Figures 11a, b, c, d* show write cycles for various combinations of R/F pin logic level and SCLK idle state. *Figures 11e, f, g, h* show read cycles for similar sets of conditions. *Figure 11i* shows a burst read cycle for the case of R/F = 0 and low SCLK idle state. Note that these timing diagrams depict general relationships between the SCLK edges, the data bits and \overline{CS} . These diagrams are not meant to show guaranteed timing. (See specification tables for parametric switching characteristics.)

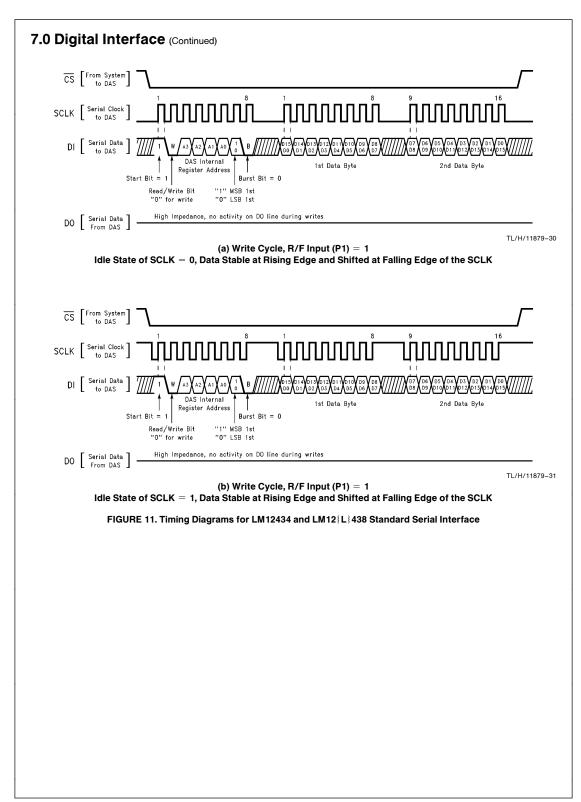
Write cycle: A write cycle begins with the falling edge of \overline{CS} . Then a command byte is written to the DAS on the DI line synchronized by SCLK. The command byte has the R/W and B bits equal to zero. Following the command byte, 16 bits of data (2 bytes) is shifted in on the same DI line.

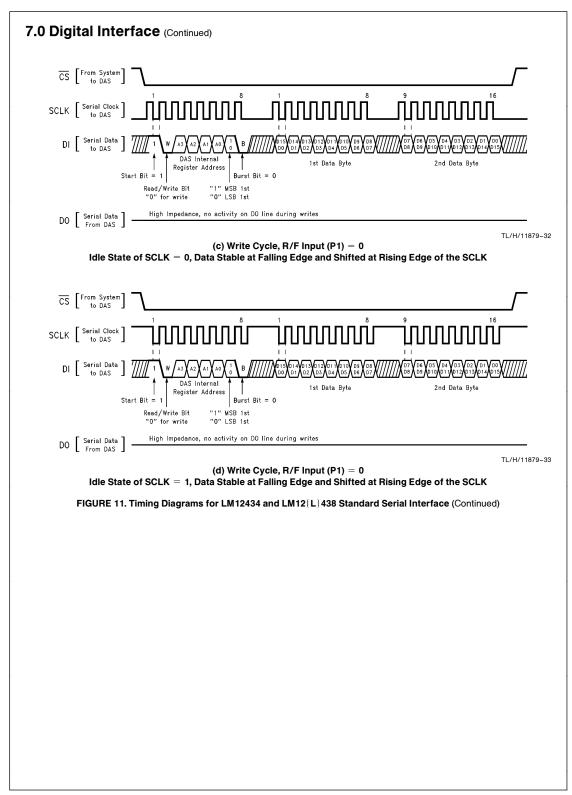
This data is written to the register addressed in the command byte (A3, A2, A1, A0). The data is interpreted as MSB or LSB first based on the logic level of the 7th bit (MSB/ LSB) in the command byte. There is no activity on the DO line during write cycles and the DAS leaves the DO line in the high impedance state. \overline{CS} will go high after the transfer of the last bit, thus completing the write cycle.

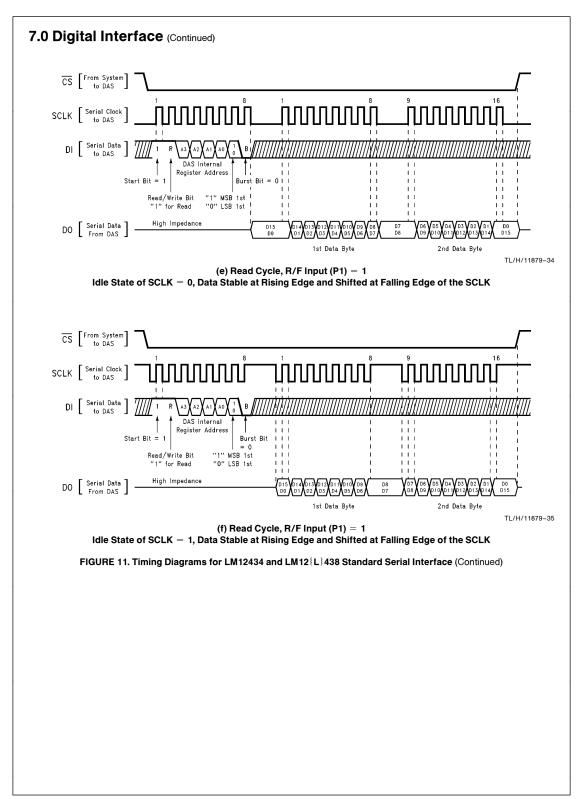
Read cycle: A read cycle starts the same way as a write cycle, except that the command byte's R/W bits equal to one. Following the command byte, the DAS outputs the data on the DO line synchronized with the microcontroller's SCLK. The data is read from the register addressed in the command byte. Data is shifted out MSB or LSB first, depending on the logic level of the MSB/LSB bit. The logic state of the DI line is "don't care" after the command byte. \overline{CS} will go high after the transfer of the last data bit, then completing the read cycle.

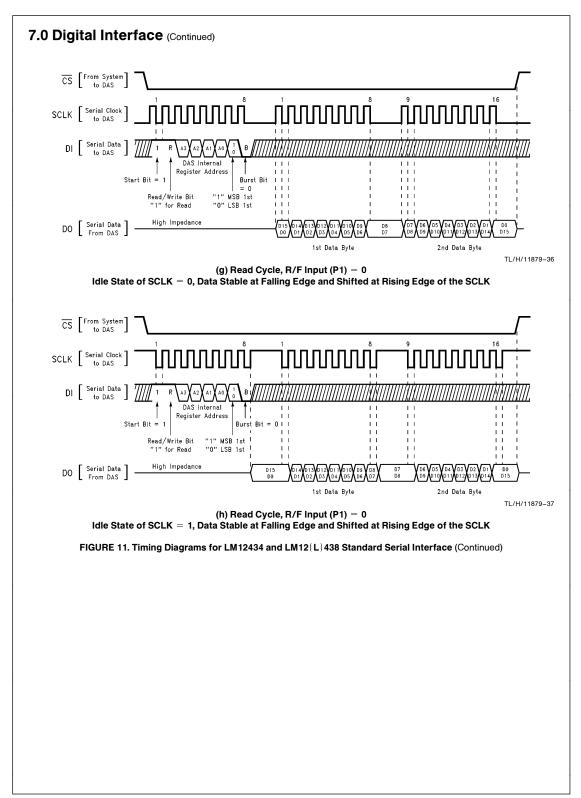
Burst read cycle: A burst read cycle starts the same way as a single read cycle, but the B bit in the command byte is set to one, indicating a burst read cycle. Following the command byte the data is output on the DO line as long as the DAS receives SCLK from the system. To tell the DAS when a burst read cycle is completed pull \overline{CS} high after the 8th and before the 15th SCLK cycle during the last data byte transfer (see *Figure 11i*). After \overline{CS} high is detected and the last data bit is transferred, the DAS is ready for a new communication cycle to begin.

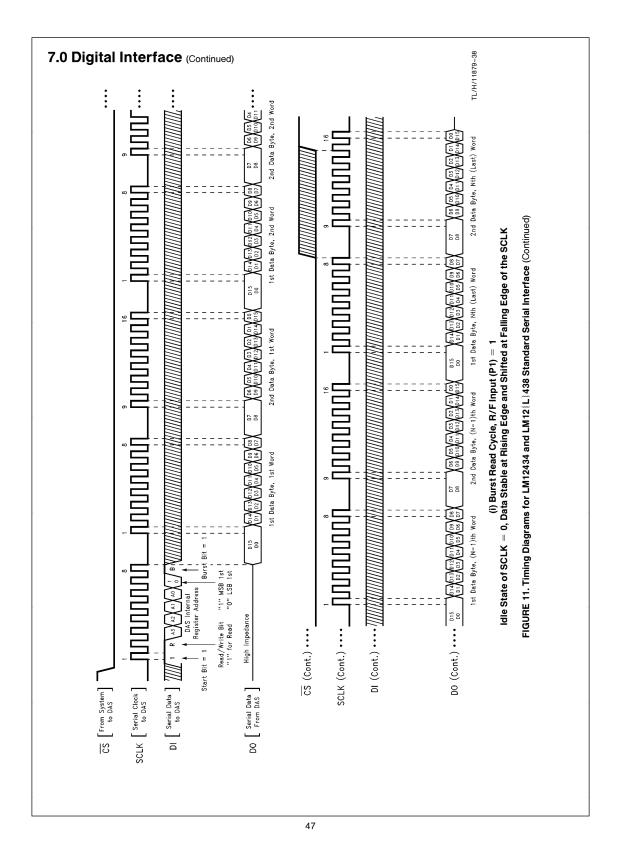
The timing diagrams in Figure 11 show the transfer of data in packets of 8 bits (bytes). This represents the way the serial ports of most microcontrollers and microprocessors produce serial clock and data. The DAS does not require a gap between the first and second byte of the data; 16 continuous clock cycles will transfer the data word. However, there should be a gap equal to 3 CLK (the DAS main clock input, not the SCLK) cycles between the end of the command byte and the start of the data during a read cycle. This is not a concern in most systems for two reasons. First, the processor generally has some inherent gap between byte transfers. Second, the SCLK frequency is usually significantly slower than the CLK frequency. For example, a 68HC11 processor with an 8 MHz crystal generates a maximum SCLK frequency of 1 MHz. If the DAS is running with a 6 MHz CLK, there are 6 cycles of CLK within each cycle of SCLK and the requirement is satisfied even if SCLK operates continuously during and after the command byte.

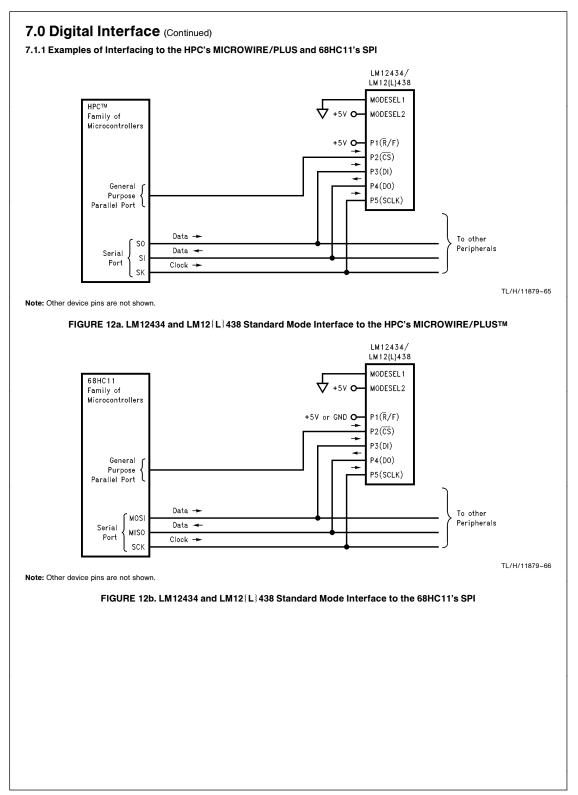












			HPC Assembly Code Example	
; THE			*********	
			SEMBLY SUBROUTINES FOR INTERFACE TO THE LM12434 AND LM12{L}438	
			STEM (SDAS) CHIP. ************************************	
;*****	********	*********	****	
;****	******	******	***********	
; HPC'	s CONTROL	REGISTER ADD	RESSES SYMBOLIC DEFINITIONS, USED IN	
	RFACE ROUT			
;****	*******	********	************	
	7	- 0*0009	; ACCUMULATOR	
;		= 0x00C8 = 0x00CC	B REGISTER	
; ;		= 0x00CA	,K REGISTER	
;		= 0x00CE	X REGISTER	
		= 0x00E2	; PORT B DATA REGISTER	
		= 0x00D2	; INTERRUPT PENDING REGISTER	
		= 0x00D6	;MICROWIRE INPUT/OUTPUT SHIFT REGISTER	
	AL	= 0x00C8	;ACCUMULATOR LOW ORDER BYTE	
		= 0x00C9	; ACCUMULATOR HIGH ORDER BYTE	
	uWDONE	$= 0 \times 0 0$	SYMBOL FOR BIT-0 IN IRPD REGISTER TO TEST	
. * * * * *	********	*******	;THE END OF MICROWIRE TRANSFER	
			RS, CONSTANTS AND MEMORY BLOCK BASE ADDRESSES	
	OLIC DEFIN			

	RINSTRO	= 0xC2		
		= 0x82	;READ AND WRITE CONTROL BYTES. THESE BYTES	
	RINSTR1		; CONTAIN THE ADDRESS OF THE SDAS REGISTER, THE	
		= 0x86	READ/WRITE BIT AND THE MSB/LSB BIT	
	WINSTR2	= 0xCA	; PREDEFINED. ; "	
	RINSTR3		, u	
	WINSTR3		; "	
	RINSTR4		; "	
	WINSTR4	= 0x92	; "	
	RINSTR5	= 0xD6	; "	
	WINSTR5	= 0x96	i "	
	RINSTR6		; "	
	WINSTR6		; "	
	RINSTR7		;	
	WINSTR7	= 0X9E	; "	
	RCONFIG	= 0xE2	;SDAS CONFIGURATION REG. READ CONTROL BYTE.	
	WCONFIG		SDAS CONFIGURATION REG. WRITE CONTROL BYTE.	
		= 0xE6	SDAS INTERRUPT ENABLE REG. READ CONTROL BYTE.	
		= 0xA6	;SDAS INTERRUPT ENABLE REG. WRITE CONTROL BYTE.	
	RINTSTAT		;SDAS INTERRUPT STATUS REG. READ CONTROL BYTE.	
		= 0xEE	;SDAS TIMER REG. READ CONTROL BYTE.	
		= 0xAE	SDAS TIMER REG. WRITE CONTROL BYTE.	
		= 0xF2	SDAS FIFO , SINGLE READ CONTROL BYTE.	
	RLMTSTAT	= 0xF3 = 0xF6	;SDAS FIFO , BURST READ CONTROL BYTE. ;SDAS LIMIT STATUS REG. READ CONTROL BYTE.	
	ICLEDICIAI	OALO	, SELE SINI OTHER REG. ASIS CONTROL SITE.	
	DAS CS	= 0x0X	BIT-X OF HPC PORT B USED FOR SDAS CHIP	
			; SELECT.	
	DATA_BL	= 0xXXXX	SYMBOLIC STARING ADDRESS OF THE DATA BLOCK	
			; IN SYSTEM MEMORY, USED TO STORE THE	
			; CONVERSION RESULTS READ FROM FIFO IN BURST	
	D3/03 000	0	READ ROUTINE.	
		'= 0×XXXX F=0×XXXX	;SYMBOLIC ADDRESS FOR A 16 BIT DATA BUFFER ;SYMBOLIC ADDRESS FOR AN 8 BIT BUFFER USED	
	CNIKL_B	- UAAAAA	; IN ROUTINES FOR CONTROL BYTE.	
	RSLT NUM	= 0xXXXX	SYMBOLIC DEFINITION FOR THE NUMBER OF	
			RESULTS TO BE READ FROM FIFO IN BURST READ	
,			**********	
			S ARE PERFORMED BY SUBROUTINES SER_WR & SER_RD,	
			RL_BUF REGISTER AS CONTROL INPUT AND THE DATA_BUF	
			OR WRITES DATA IS LOADED IN THE DATA_BUF REG. AND	
			THE DATA_BUF REGISTER.	
, • • •				TL/H/11879

			HPC Assembly Code Example (Continued)	
; AN	EXAMPL	E OF A WRITE TO CONFIGUE	ATION REGISTER:	
	LD	CNTRL_BUF.B,#WCONFIG	;CONFIGURATION REG. WRITE COMMAND ;LOADED IN THE CNTRL_BUF.	
	LD	DATA_BUF.W,#0x0002	;DATA LOADED ON THE DATA_BUF REG. RESET SDAS, ;PAUSE=1, RAM POINTER=00.	
	JSR	SER_WR	;CALLING SER_WR FOR DATA TRANSFER.	
; AN	EXAMPL	E OF A READ FROM CONFIGU	WRATION REGISTER:	
	LD	B.B,#RCONFIG	;CONFIGURATION REG. READ COMMAND ;LOADED IN THE CNTRL_BUF.	
	JSR	SER_RD	;CALLING SER_RD FOR DATA TRANSFER.	
; DATA ; HPC A ; THE D ; DATA	WRITE S ND THE ATA TRA TO BE W	JBROUTINE "SER_WR", FOR SERIAL DAS WITH UW SERIA NSFER CONTROL BYTE SHOUL RITTEN TO THE SDAS SHOUL	SERIAL I/O TRANSFER OF DATA BETWEEN THE L INTERFACE. BEFORE CALLING THE ROUTINE, D BE LOADED IN THE CNTRL BUE AND THE D BE LOADED IN THE DATA_BUF.	
SER_WR:				
	RBIT	DAS_CS, PORTB.B	;RESET THE PORT B BIT-X TO SELECT ;THE SDAS1.	
	LD	SIO.B, CNTRL_BUF.B	,LOAD THE CONTROL BYTE TO HPC'S SIO ,REGISTER, BYTE TRANSFER IS STARTED.	
WAIT1:			;WAIT AND CHECK THE uWDONE BIT FOR	
	JP JP	WBYTE1 WAIT1	;COMPLETION OF DATA TRANSFER. WHEN DONE, ;GO AHEAD FOR FIRST DATA BYTE TRANSFER.	
WBYTE1:	LD	SIO.B, (DATA_BUF+1).B	;LOAD HIGH ORDER BYTE OF DATA TO SIO	
NATT2 -	TEDIT	uWDONE, IRPD.B	;REGISTER, TRANSFER IS STARTED. ;WAIT AND CHECK THE UWDONE BIT FOR	
NAL12:	JP	WBYTE2	COMPLETION OF DATA TRANSFER. WHEN DONE,	
	JP	WAIT2	;GO AHEAD FOR SECOND DATA BYTE TRANSFER.	
WBYTE2:			;LOAD LOW ORDER BYTE OF DATA TO SIO ;REGISTER, TRANSFER IS STARTED.	
WAIT3:	IFBIT JP	uWDONE, IRPD.B WDONE	;WAIT AND CHECK THE uWDONE BIT FOR ;COMPLETION OF DATA TRANSFER. WHEN DONE,	
	JP	WAIT3	;DESELECT THE SDAS AND RETURN.	
WDONE :	SBIT RET	DAS_CS, PORTB.B	;SET THE BIT TO DESELECT THE SDAS. ;RETURN FROM SUBROUTINE.	
; DATA ; HPC A ; THE D ; DATA	READ SUI ND THE : ATA TRAI IS LOADI	BROUTINE "SER_RD", FOR S SERIAL DAS WITH UW SERIA ISFER CONTROL BYTE SHOUL ED IN THE DATA_BUF UPON	ERIAL I/O TRANSFER OF DATA BETWEEN THE L INTERFACE. BEFORE CALLING THE ROUTINE, D BE LOADED IN THE CNTRL BUF AND THE RETURN FROM SUBROUTINE.	
	RBIT	DAS_CS, PORTB.B	;RESET THE PORT B BIT-X TO SELECT ;THE SDAS1.	
	LD	SIO.B, CNTRL_BUF.B	, LOAD THE CONTROL BYTE TO HPC'S SIO ; REGISTER, BYTE TRANSFER IS STARTED.	
	TEDTO	uWDONE, IRPD.B	;WAIT AND CHECK THE uWDONE BIT FOR	
VAIT4 ·			COMPLETION OF DATA TRANSFER. WHEN DONE,	
WAIT4 -	JP JP	RBYTE1 WAIT4	;GO AHEAD FOR FIRST DATA BYTE TRANSFER.	
VAIT4 -	JP JP	WAIT4		
	JP JP		;LOAD THE SIO REGISTER WITH ZERO, ;THIS IS JUST A DUMMY LOAD TO START	
RBYTE1:	JP JD	WAIT4	;LOAD THE SIO REGISTER WITH ZERO,	
RBYTE1:	JP JP LD IFBIT JP	WAIT4 SIO.B,#0x00 uWDONE,IRPD.B RBYTE2	;LOAD THE SIO REGISTER WITH ZERO, ;THIS IS JUST A DUMMY LOAD TO START ;THE DATA TRANSFER ;WAIT AND CHECK THE UWDONE BIT FOR ;COMPLETION OF DATA TRANSFER. WHEN DONE,	
WAIT4 : RBYTE1 : WAIT5 : RBYTE2 :	JP JP LD IFBIT JP JP	WAIT4 SIO.B,#0x00 uWDONE,IRPD.B	;LOAD THE SIO REGISTER WITH ZERO, ;THIS IS JUST A DUMMY LOAD TO START ;THE DATA TRANSFER ;WAIT AND CHECK THE UWDONE BIT FOR	
RBYTE1: WAIT5:	JP JP LD IFBIT JP JP	WAIT4 SIO.B,#0x00 uWDONE,IRPD.B RBYTE2 WAIT5	;LOAD THE SIO REGISTER WITH ZERO, ;THIS IS JUST A DUMMY LOAD TO START ;THE DATA TRANSFER ;WAIT AND CHECK THE UWDONE BIT FOR ;COMPLETION OF DATA TRANSFER. WHEN DONE, ;GO AHEAD FOR SECOND DATA BYTE TRANSFER.	

			HPC Assembly Code Example (Continued)	
WAIT6:	IFBIT JP JP	uWDONE,IRPD.B RDONE WAIT6	;THE DATA TRANSFER ;WAIT AND CHECK THE UWDONE BIT FOR ;COMPLETION OF DATA TRANSFER. WHEN DONE, ;LOAD THE READ DATA TO AL, DESELECT THE ;SDAS AND RETURN.	
RDONE :	LD	DATA_BUF.B,SIO.B	;LOAD LOW ORDER BYTE OF THE DATA_BUF REGISTER	
	SBIT RET	DAS_CS, PORTB.B	;WITH THE DATA JUST READ FROM SDAS. ;SET THE BX TO DESELECT THE SDAS. ;RETURN FROM SUBROUTINE.	
; FIFO ; FROM ; SYSTE ; RESUL ; THAT	BURST R FIFO IN M MEMOR TS BEIN THE HPC	EAD SUBROUTINE "RD_FI BURST READ MODE. DATA Y STARTING FROM THE DA G READ IS RSLT_NUM WH IS USING 16 BIT DATA	NO", USED FOR READING THE CONVERSION RESULTS A IS READ FROM FIFO AND STORED IN THE TATA BLK ADDRESS. NUMBER OF CONVERSION CCH IS LOADED IN THE X REGISTER. IT IS ASSUMED BUS.	
RD_FIFO	:			
T DOT DO	LD	BK.W, #DATA_BLK, #(DA	<pre>YA_BLK+2*RSLT_NUM-1) ;SET B FOR STARTING ADDRESS OF MEMORY ;AND K FOR ENDING ADDRESS MINUS ONE</pre>	
LPFIFO:	LD	X.W, #RSLY_NUM	;A COUNTER TO KEEP TRACK OF # OF FIFO ;READS FOR TERMINATION OF BURST MODE ;BY PULLING THE CHIP SELECT HIGH DURING ;THE LAST READ CYCLE AND BEFORE THE ;14TH CLOCK EDGE.	
	RBIT	DAS_CS, PORTB.B	;RESET THE PORT B BIT-X TO SELECT ;THE SDAS.	
	LD	SIO.B, #RBFIFO	;LOAD THE BURST FIFO READ CONTROL BYTE ;TO SIO REG. BYTE TRANSFER IS STARTED.	
WAIT7:	IFBIT JP	uWDONE,IRPD.B MSBYTE	;WAIT AND CHECK THE UWDONE BIT FOR ;COMPLETION OF DATA TRANSFER. WHEN DONE,	
	JP	WAIT7	GO AHEAD FOR FIRST DATA BYTE READ.	
MSBYTE:	LD	SIO.B,#0x00	;LOAD THE SIO WITH 0, THIS IS JUST A ;DUMMY LOAD TO START THE DATA TRANSFER	
WAIT8:	IFBIT	uWDONE, IRPD.B	;WAIT AND CHECK THE UWDONE BIT FOR	
	JP JP	LSBYTE WAIT8	;COMPLETION OF DATA TRANSFER. WHEN DONE, ;GO AHEAD FOR SECOND DATA BYTE READ.	
LSBYTE :	LD	AH.B,SIO.B	;LOAD HIGH ORDER BYTE OF THE A REGISTER ;WITH DATA JUST READ FROM THE SDAS.	
	LD	SIO.B,#0x00	,LOAD THE SIO WITH 0, THIS IS JUST A ,DUMMY LOAD TO START THE DATA TRANSFER.	
	DECSZ	х	;DECREMENT X AND SET THE SDAS CHIP-	
	JP SBIT	WAIT9 DAS_CS,PORTB.B	;SELECT BIT IF LAST READ CYCLE (X=0), ;OTHERWISE CONTINUE.	
WAIT9:	IFBIT JP	uWDONE, IRPD.B CMPLT	;WAIT AND CHECK THE UWDONE BIT FOR ;COMPLETION OF DATA TRANSFER. WHEN DONE,	
	JP	WAIT9	; LOAD THE READ DATA TO AL.	
CMPLT:	LD	AL.B,SIO.B	;LOAD LOW ORDER BYTE OF THE A REGISTER ;WITH THE DATA JUST READ FROM THE SDAS.	
	XS	A,[B+].W	STORE A TO THE DATA_BLK WITH B AUTO- ;INCREMENT AND SKIP IF GREATER THAN K.	
	JP	MSBYTE	GO FOR THE NEXT FIFO DATA	
	RET			
; THIS ; COMMUI	ROUTINE NICATION	INITIALIZES THE SDAS V CYCLE IS INTERRUPTED	SERIAL INTERFACE IN CASE A D IN THE MIDDLE OF A CYCLE FOR ANY REASON.	
	R PORT I	RST :		
SDAS_SE				

			HPC Assembly Code Example (Continued)	
	I D	670 B #		
RWAIT1:	LD	SIO.B,# uWDONE,		
WALLT:	JP	R_NXT2	;APPLYING 24 SERIAL CLOCK PULSE WHILE	
	JP	RWAIT1	;CHIP SELECT IS HIGH, THIS IS EQUAL TO	
R_NXT2:		SIO.B,#		
RWAIT2:		uWDONE,		
	JP	R NXT3	;NOTE THAT THIS ROUTINE DOES NOT RESET	
	JP	RWAIT2	;THE SERIAL DAS BUT ONLY THE SERIAL INTERFACE	
R_NXT3:	LD	SIO.B,#	0x00 ;THIS ROUTINE IS USEFUL DURING	
RWAIT3:	IFBIT	uWDONE,	IRPD.B ;SOFTWARE DEVELOPMENT OR IN CASE THAT	
	RET		; A COMMUNICATION CYCLE NEEDS TO BE	
	JP	RWAIT3	; INTERRUPTED BY SYSTEM REQUIREMENTS.	
				TL/H/11879-
			68HC11 Assembly Code Example	
*****	******	******	*************	
* THE (68HC11 I	MICROCONTR	ROLLERS FAMILY ASSEMBLY SUBROUTINES FOR INTERFACE TO	
			L}438 SERIAL DATA ACQUISITION SYSTEM (SDAS) CHIP.	
*****	******	********	*************	

	II CONTI RFACE R		SISTER'S ADDRESSES SYMBOLIC DEFINITIONS, USED IN	

PORTD	EQU		; Port D data register	
*	220	91000	; " - , - ,SS* ,SCK ;MOSI,MISO,TxD ,RxD "	
*			; PORT D "SS" BIT IS USED FOR SDAS CHIP SELECT	
DDRD	EQU	\$1009	; Port D data direction	
SPCR	EQU	\$1028	; SPI control register	
*			; "SPIE, SPE , DWOM, MSTR; CPOL, CPHA, SPR1, SPR0"	
SPSR	EQU	\$1029	; SPI status register	
*			; "SPIF,WCOL, - ,MODF; - , - , - , - "	
SPDR	EQU	\$102A	; SPI data register; Read-Buffer; Write-Shifter	
			GISTERS, CONSTANTS AND MEMORY BLOCKS BASE ADDRESSES	
* SERIA * SYMBO	AL DAS 1 OLIC DEN	RELATED RE		
* SERIA * SYMB(*******	AL DAS 1 OLIC DE1	RELATED RE	GISTERS, CONSTANTS AND MEMORY BLOCKS BASE ADDRESSES	
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* SERIA * SYMBO ******* * RINSTRO WINSTRO	AL DAS 1 DLIC DEN ******** D EQU D EQU 1 EQU 1 EQU	RELATED RE FINITIONS \$C2 \$82 \$C6 \$86	GISTERS, CONSTANTS AND MEMORY BLOCKS BASE ADDRESSES ;SERIAL DAS INSTRUCTION RAM AND LIMITS 1 & 2 ;READ AND WRITE CONTROL BYTES. THESE BYTES ;CONTAIN ADDRESSES OF THE SDAS REGISTER, THE ;READ/WRITE BIT AND THE MSB/LSB BIT	
* SERIA * SYMBO ******* * RINSTRO RINSTRO WINSTRO	AL DAS 1 DLIC DE1 ******** D EQU D EQU 1 EQU 1 EQU 2 EQU	RELATED RE FINITIONS \$22 \$82 \$C6 \$86 \$CA	RGISTERS, CONSTANTS AND MEMORY BLOCKS BASE ADDRESSES ;SERIAL DAS INSTRUCTION RAM AND LIMITS 1 & 2 ;READ AND WRITE CONTROL BYTES. THESE BYTES ;CONTAIN ADDRESSES OF THE SDAS REGISTER, THE	
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* SERIJ * SYMB * SYMB * RINSTR RINSTR RINSTR RINSTR RINSTR RINSTR WINSTR RINSTR WINSTR RINSTR WINSTR RINSTR WINSTR RINSTR WINSTR RINSTR TIMER RINTEN	AL DAS 1 DLIC DE AL CAS	RELATED RE FINITIONS ********* \$C2 \$82 \$C6 \$86 \$CA \$88 \$26 \$88 \$20 \$92 \$92 \$92 \$92 \$92 \$92 \$94 \$96 \$96 \$0A \$96 \$0A \$96 \$0A \$96 \$0A \$96 \$20 \$95 \$20 \$20 \$20 \$20 \$20 \$20 \$20 \$20 \$20 \$20	<pre>SGISTERS, CONSTANTS AND MEMORY BLOCKS BASE ADDRESSES ;SERIAL DAS INSTRUCTION RAM AND LIMITS 1 & 2 ;READ AND WRITE CONTROL BYTES. THESE BYTES ;CONTAIN ADDRESSES OF THE SDAS REGISTER, THE ;READ/WRITE BIT AND THE MSB/LSB BIT ;PREDEFINED. ;" ;" ;" ;" ;" ;SDAS CONFIGURATION REG. READ CONTROL BYTE. ;SDAS CONFIGURATION REG. READ CONTROL BYTE. ;SDAS INTERRUPT ENABLE REG. READ CONTROL BYTE. ;SDAS INTERRUPT ENABLE REG. WRITE CONTROL BYTE. ;SDAS INTERRUPT ENABLE REG. WRITE CONTROL BYTE. ;SDAS INTERRUPT ENABLE REG. WRITE CONTROL BYTE. ;SDAS TIMER REG. READ CONTROL BYTE. ;SDAS TIMER REG. READ CONTROL BYTE. ;SDAS FIFO, SINGLE READ CONTROL BYTE. ;SDAS FIFO, SURST READ CONTROL BYTE. ;SDAS FIFO, BURST READ CONTROL BYTE. ;SDAS FIFO, SURGE READ CONTROL BYTE. ;SDAS FIFO, BURST READ CONTROL BYTE. ;SDAS FIFO, SURGE READ CONTROL B</pre>	
* SERIJ * SYMB * SYMB * RINSTR RINSTR RINSTR RINSTR RINSTR RINSTR WINSTR RINSTR WINSTR RINSTR WINSTR RINSTR WINSTR RINSTR WINSTR RINSTR TIMER RINTEN	AL DAS 1 DLIC DE1 ********* 0 EQU 0 EQU 1 EQU 1 EQU 2 EQU 2 EQU 2 EQU 2 EQU 2 EQU 3 EQU 4 EQU 4 EQU 4 EQU 5 EQU 5 EQU 5 EQU 5 EQU 5 EQU 5 EQU 5 EQU 6 EQU 6 EQU 8 EQU 8 EQU 8 EQU 8 EQU 8 EQU 8 EQU	RELATED RE FINITIONS ********** \$C2 \$82 \$C6 \$86 \$C6 \$86 \$CA \$88 \$CE \$92 \$92 \$92 \$96 \$92 \$96 \$94 \$95 \$95 \$95 \$95 \$25 \$26 \$20 \$95 \$95 \$25 \$26 \$26 \$26 \$26 \$26 \$26 \$26 \$26 \$26 \$26	<pre>SGISTERS, CONSTANTS AND MEMORY BLOCKS BASE ADDRESSES SERIAL DAS INSTRUCTION RAM AND LIMITS 1 & 2 ;READ AND WRITE CONTROL BYTES. THESE BYTES ;CONTAIN ADDRESSES OF THE SDAS REGISTER, THE ;READ/WRITE BIT AND THE MSB/LSB BIT ;PREDEFINED. ; " ; " ; subas configuration reg. read control byte. ;SDAS CONFIGURATION REG. READ CONTROL BYTE. ;SDAS INTERRUPT ENABLE REG. READ CONTROL BYTE. ;SDAS INTERRUPT ENABLE REG. WRITE CONTROL BYTE. ;SDAS INTERRUPT STATUS REG. READ CONTROL BYTE. ;SDAS INTERRUPT STATUS REG. READ CONTROL BYTE. ;SDAS INTERRUPT STATUS REG. READ CONTROL BYTE. ;SDAS TIMER REG. READ CONTROL BYTE. ;SDAS FIFO , SINGLE READ CONTROL BYTE. ;S</pre>	

7.0 Digital Interface (Continued) 68HC11 Assembly Code Example (Continued) DATA_BLK EQU \$10 ;SYMBOLIC STARTING ADDRESS OF THE DATA BLOCK ; IN SYSTEM MEMORY, USED TO STORE THE ; CONVERSION RESULTS READ FROM FIFO IN BURST * READ ROUTINE. ;SYMBOLIC ADDRESS FOR A 16 BIT DATA BUFFER DATA BUF EOU \$42 SYMBOLIC ADDRESS FOR AN 8 BIT BUFFER USED CNTRL_BUF EQU \$40 ; IN ROUTINES FOR CONTROL BYTE. RSLT NUM EQU \$10 ;SYMBOLIC DEFINITION FOR THE NUMBER OF ; RESULTS TO BE READ FROM FIFO IN BURST READ ***** * SERIAL DAS READS AND WRITES ARE PERFORMED BY SUBROUTINE SER IO. * THIS ROUTINE USES THE CNTRL BUF REGISTER AS CONTROL INPUT AND THE DATA BUF * REGISTER AS DATA BUFFER, FOR WRITES DATA IS LOADED ON THE DATA BUF REG. AND * FOR READS DATA RETURNS IN THE DATA BUF REGISTER. *--- AN EXAMPLE OF A WRITE TO CONFIGURATION REGISTER: LDAA #WCONFIG ;CONFIGURATION REG. WRITE COMMAND STAA CNTRL_BUF ;LOADED IN THE CNTRL_BUF. LDD #\$0010 ;DATA LOADED ON THE DATA BUF REG. STD DATA_BUF ;RESET= 1, RAM POINTER=00. JSR ;CALLING SER_WR FOR DATA TRANSFER. SER IO *--- AN EXAMPLE OF A READ FROM CONFIGURATION REGISTER: LDAA #RCONFIG ; CONFIGURATION REG. READ COMMAND STAA CNTRL BUF ;LOADED IN THE CNTRL BUF. SER_IO ;CALLING SER_RD FOR DATA TRANSFER. JSR * DATA WRITE/READ SUBROUTINE "SER_IO", FOR SERIAL I/O TRANSFER OF DATA BETWEEN * THE 68HC11 AND THE SERIAL DAS WITH SPI SERIAL INTERFACE. BEFORE CALLING THE * ROUTINE, THE DATA TRANSFER CONTROL BYTE SHOULD BE LOADED IN THE CNTRL BUF. * FOR WRITES THE DATA TO BE WRITTEN TO THE SDAS SHOULD BE LOADED IN DATA BUF. * FOR READS, DATA IS LOADED INTO THE DATA BUF UPON RETURN FROM THIS SUBROUTINE. ************** SER IO: ; DROP CHIP SELECT BCLR PORTD,Y \$20 CNTRL_BUF ; LOAD A WITH CONTROL BYTE LDAA STAA SPDR ; START SPI SEND SEND1 SPSR ; GET SPI STATUS TO WAIT FOR SPIF LDAA ANDA #\$80 ; MASKING THE EIGHTH BIT WITH THE SPIF BIT ; IF SPIF=0 THEN BRANCH, ELSE SKIP BEO SEND1 DATA_BUF LDAA ; GET MSB DATA BYTE AND SEND ; START SPI SEND. THIS WILL ALSO CLEAR THE SPIF BIT STAA SPDR SEND2 LDAA SPSR ; GET SPI STATUS TO WAIT FOR SPIF ANDA #\$80 ; MASKING THE EIGHTH BIT WITH THE SPIF BIT BEO SEND2 ; IF SPIF=0 THEN BRANCH, ELSE SKIP LDAA SPDR ; LOADS 1 DATA BYTE (MSB/LSB) SENT FROM DAS INTO ACC A DATA BUF ; STORE MSB DATA BYTE IN RAM BUFFER STAA LDAA DATA BUF+1 ; GET LSB DATA BYTE TO SEND STAA SPDR ; START SPI SEND SEND3 ; GET SPI STATUS TO WAIT FOR SPIF LDAA SPSR ANDA #\$80 ; MASKING THE EIGHTH BIT WITH THE SPIF BIT ; IF SPIF=0 THEN BRANCH, ELSE SKIP BEO SEND3 ; LOADS 1 DATA BYTE (MSB/LSB) SENT FROM DAS INTO ACC A LDAA SPDR DATA BUF ; STORE MSB DATA BYTE IN RAM BUFFER STAA PORTD,Y \$20 BSET ; DONE -- RAISE CS RTS TL/H/11879-86

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		68	HC11 Assembly Code Example (Continued)	

		_	IFO", FOR READING THE CONVERSION RESULTS	
			TA IS READ FROM FIFO AND STORED IN THE	
			DATA_BLK ADDRESS. NUMBER OF CONVERSION	
			HICH IS LOADED IN THE X REGISTER. IT IS ASSUMED	
		IS USING 16 BIT DAT		
		*****	******	
RD_FIFO		"D3/03 D1/F	TOND Y WITHIN DAMA DIOCY DAGE ADDDDCC	
	LDX	#DATA_BLK #RSLT NUM	; LOAD X WITH DATA BLOCK BASE ADDRESS ; LOAD B WITH NUMBER OF RESULTS	
	LDAB LSLB	#RSDI_NOM	; LOAD B WITH NOMBER OF RESOLTS ; MAKE INTO BYTE COUNT	
	DECB		; ONE LESS FOR LAST BYTE	
	BCLR	PORTD,Y \$20	; DROP CHIP SELECT	
		#RBFIFO	; LOAD A WITH BURST READ COMMAND	
	STAA	SPDR	; SEND COMMAND	
BURST1			; GET SPI STATUS TO WAIT FOR SPIF	
JOROII		#\$80	; MASKING THE EIGHTH BIT WITH THE SPIF BIT	
	BEQ	BURST1	; IF SPIF=0 THEN BRANCH, ELSE SKIP	
BLOOP				
	CLRA		; CLEAR DATA BYTE TO SEND	
	STAA	SPDR	; START SPI, RECEIVE A DATA BYTE	
BURST2	LDAA	SPSR	; GET SPI STATUS TO WAIT FOR SPIF	
	ANDA	#\$80	; MASKING THE EIGHTH BIT WITH THE SPIF BIT	
	BEQ	BURST2	; IF SPIF=0 THEN BRANCH, ELSE SKIP	
	LDAA	SPDR	; GET THE RECEIVED DATA BYTE	
	STAA	0,X	; STORE DATA BYTE	
	INX		; POINT TO NEXT DATA BYTE	
	DECB		; COUNTING DOWN # OF BYTES	
	BNE	BLOOP	; STILL MORE DATA BYTES TO GET	
	BSET	PORTD,Y \$20	; RAISE CS TO END BURST READ	
	STAA	SPDR	; START SPI, RECEIVE LAST BYTE	
BURST3		SPSR	; GET SPI STATUS TO WAIT FOR SPIF	
	ANDA	#\$80 BUDG#2	; MASKING THE EIGHTH BIT WITH THE SPIF BIT	
	BEQ	BURST3	; IF SPIF=0 THEN BRANCH, ELSE SKIP ; GET RECEIVED DATA BYTE	
	LDAA	SPDR	; GET RECEIVED DATA BYTE ; STORE DATA BYTE IN RAM BUFFER	
	STAA RTS	0,X	; SIGNE DATA DITE IN RAM DUFFER	
	N10			
				TL/H/11879-8

7.2 8051 INTERFACE MODE

The 8051 interface mode is designed to work directly with the 8051 family of microcontrollers' mode 0 serial interface. This interface mode is a simple shift register type of serial data transfer. The serial clock synchronizes the transfer of data to and from the LM12434 and LM12{L}438. The interface uses 3 lines: a bidirectional data line (RXD), a serial clock line (TXD) and a chip-select (\overline{CS}) line. More than one device can share the data and serial clock lines provided that each device has its own chip-select line.

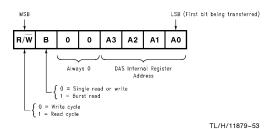
The 8051 mode is selected when the MODESEL1 and MODESEL2 pins have the logic state of "00". *Figure 14* shows a typical connection diagram for the 8051 mode serial interface. The \overline{CS} , RXD and TXD lines are respectively assigned to interface pins P3 through P5. The P1 and P2 pins are not used in this mode and should be left open or connected to logic "1". In this interface the idle state of the serial clock TXD is logic "1". The data is stable at both edges of the TXD clock and is shifted after its rising edge. The interface has a bidirectional RXD data line. The LM12434 and LM12{L}438 leaves the RXD line in a high impedance state whenever it is not outputting any data.

Data transfer in this mode is byte oriented. As mentioned, the LM12434 and LM12{L}438 has three different communication cycles: write cycle, read cycle and burst read cycle. At the start of each data transfer cycle, "command byte" is written to the LM12434 and LM12{L}438, followed by write or read data. The command byte informs the LM12434 and LM12{L}438 about the communication cycle and carries the following information:

 what type of data transfer (communication cycle) is started

- which device register is to be accessed

The command byte has the following format:



The first bit is the LSB of the byte based on the 8051 mode 0 serial interface protocol.

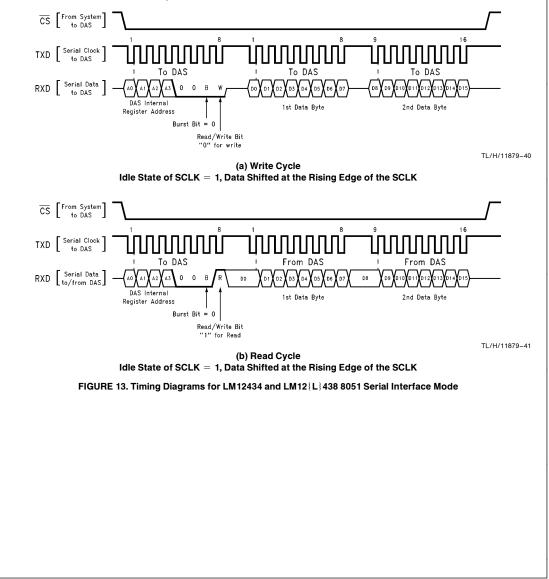
Figure 13 shows the timing diagrams for different communication cycles. *Figure 13a* shows a write cycle. *Figure 13b* shows a read cycle. *Figure 13c* shows a burst read cycle. Note that these timing diagrams depict general relationships between the SCLK edges, the data bits and \overline{CS} . These diagrams are not meant to show guaranteed timing performance. (See specification tables for parametric switching characteristics.)

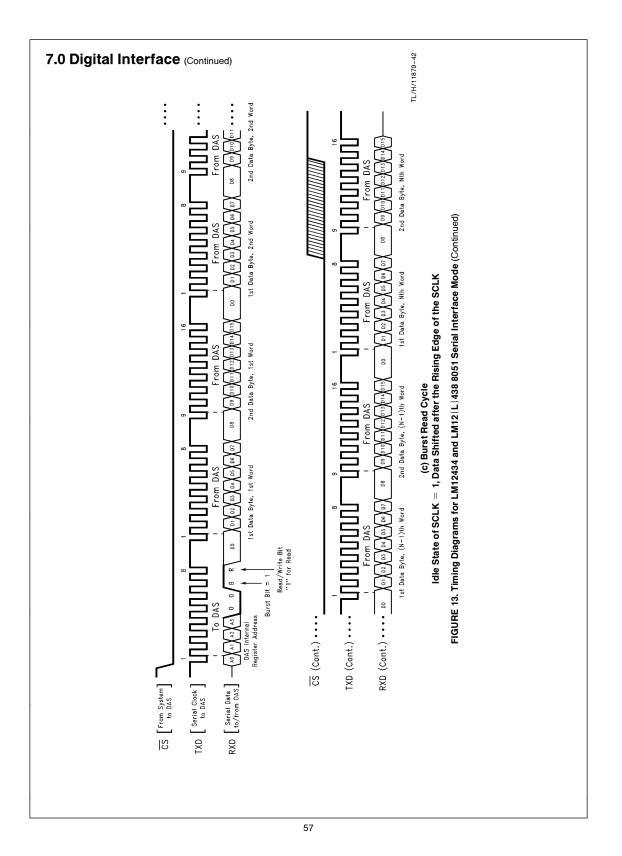
Write cycle: A write cycle begins with the falling edge of the \overline{CS} . Then a command byte is written to the DAS on the RXD line synchronized by TXD clock. The command byte has the R/W and B bits equal to zero. Following the command byte, 16 bits of data (2 bytes) is shifted in on the RXD line. The data is written to the register addressed in the command byte (A3, A2, A1, A0). The data is always LSB first in this interface. \overline{CS} will go high after the transfer of the last bit, thus completing the write cycle.

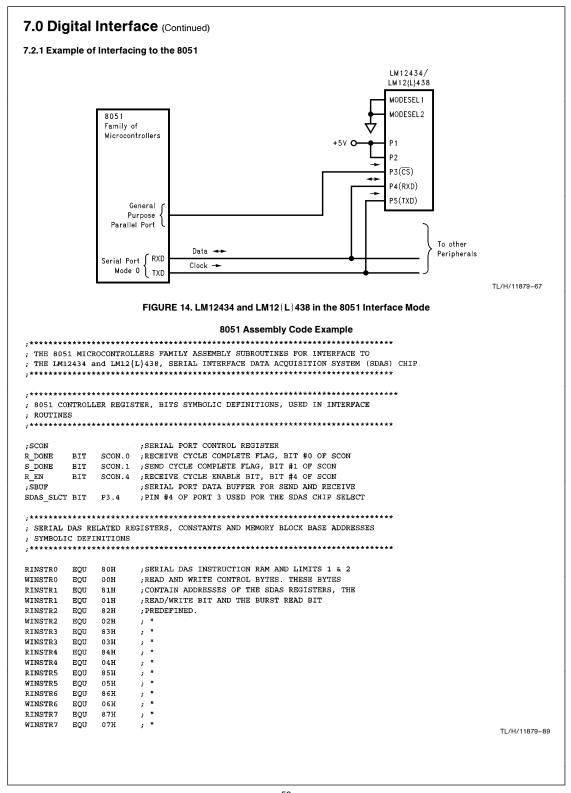
Read cycle: A read cycle starts the same way as a write cycle, except that the command bytes R/\overline{W} bit is equal to one. Following the command byte, the DAS outputs the data on the RXD line synchronized with the microcontroller's TXD clock. The data is read from the register addressed in the command byte. Data is shifted in LSB first. Again, \overline{CS} will go high after the transfer of the last data bit, thus completing the read cycle.

Burst read cycle: A burst read cycle starts the same way as a single read cycle, but the B bit in the command byte is set to one, indicating a burst read cycle. Following the command byte the data is output on the RXD line as long as the DAS receives TXD clock from the system. To tell the DAS when a burst read cycle is completed, \overline{CS} should be set high after the 8th and before the 15th SCLK cycle during the last data byte transfer (see *Figure 13c*). After \overline{CS} high is detected and the last data bit is transferred, the DAS is ready for a new communication cycle to begin.

The timing diagrams in *Figure 13* show the transfer of data in packets of 8 bits (bytes). This represents the way the serial ports of the 8051 family of microcontrollers produce the serial clock and data. The DAS does not require a gap between the first and second bytes of the data; 16 continuous clock cycles will transfer the data word. However, there should be a gap equal to 3 CLK (the DAS main clock input, not the TXD clock) cycles between the end of the command byte and the start of the data during a read cycle. This is not concerned in most systems for two reasons. First, the processor generally has some inherent gap between byte transfers. Second, the TXD frequency is usually significantly slower than the CLK frequency. For example, an 8051 processor with 12 MHz crystal generates a TXD of 1 MHz. If the DAS is running with 6 MHz CLK, there are 6 cycles of CLK within each cycle of TXD and the requirement is satisfied even if TXD comes continuously after command byte. The user should pay attention to this requirement if running the TXD with a speed near or higher than CLK.







	CONFIG CONFIG		88H			ontinued)	
CONTEG EQU 08H ;SDAS CONFIGURATION REG. WRITE CONTROL BYTE. HINTEN EQU 09H ;SDAS INTERRUPT ENABLE REG. WRITE CONTROL BYTE. HINTEN EQU 08H ;SDAS INTERRUPT ENABLE REG. WRITE CONTROL BYTE. HINTEN EQU 08H ;SDAS TIMER REG. WRITE CONTROL BYTE. SFITO EQU 06H ;SDAS TIMER REG. WRITE CONTROL BYTE. BETFO EQU 06H ;SDAS TIMER REG. WRITE CONTROL BYTE. HINTEN EQU 08H ;SDAS TIMER REG. WRITE CONTROL BYTE. HINTEN EQU 06H ;SDAS FITO, SINCLE READ CONTROL BYTE. HINTEN EQU 06H ;SDAS FITO, SINCLE READ CONTROL BYTE. HINTEN EQU 06H ;SDAS FITO, BURST READ CONTROL BYTE. HINTEN EQU 07CK ;SDAS FITO, BURST READ CONTROL BYTE. HINTEN EQU 0XH ;STMBOLIC STARTING ADDRESS OF THE DATA BLOCK ;IN SYSTEM MEMORY, USED TO STORE THE ;CONVERSION RESULTS READ FROM FITO IN BURST ;READ ROUTINE. ATA_BUF EQU 0XH ;STMBOLIC DDRESS FOR A 16 BIT DATA BUPFER HINTEL_BUF EQU 0XH ;SYMBOLIC DDRESS FOR A 16 BIT DATA BUPFER ;IN ROUTINES FOR CONTROL BYTE ;IN ROUTINES FOR CONTROL BYTE ;SIT_NUM EQU 0XH ;SYMBOLIC DDRESS FOR A 16 BIT DATA BUPFER ;IN ROUTINES FOR CONTROL BYTE ;IN ROUTINES FOR CONTROL BYTE ;IN ROUTINES FOR CONTROL BYTE ;SIT_NUM EQU 0XH ;SYMBOLIC DDRESS FOR AN 8 BIT EUFFER USED ;IN ROUTINES FOR CONTROL BYTE ;SIT_NUM EQU 0XH ;SYMBOLIC DDEFEN FOR WRITES DATA 16 LOADED ON THE 'SATA_JUF' REGISTER A SEA FERFORMED BY SUBROUTINES SER_WR & SER_RD, THESE ROUTINES USE THE "CATHL_BUF" REGISTER. **********************************	CONFIG		88H	SDAS CONFIGUR	TION DEC DEND CONTROL DATE		
<pre>INTEN EQU 99H ;SDAS INTERRUTT ENABLE REG. READ CONTROL EVTE. INTEN EQU 99H ;SDAS INTERRUTT ENABLE REG. WEITE CONTROL EVTE. INTEN EQU 98H ;SDAS INTERRUTT ENABLE REG. WEITE CONTROL EVTE. ITMER EQU 98H ;SDAS TIMER REG. READ CONTROL EVTE. SFITO EQU 9CH ;SDAS TIMER REG. WEITE CONTROL EVTE. SFITO EQU 9CH ;SDAS TIMER REG. WEITE CONTROL EVTE. INTENT EQU 9CH ;SDAS TIMER REG. WEITE CONTROL EVTE. INTENT EQU 9CH ;SDAS TIMER REG. WEITE CONTROL EVTE. INTENT EQU 9CH ;SDAS INTERRUTT STATUS REG. READ CONTROL EVTE. INTENT EQU 9CH ;SDAS INTERRUTT STATUS REG. READ CONTROL EVTE. INTENT EQU 9CH ;SDAS INTERRUTT STATUS REG. READ CONTROL EVTE. INTEN EQU 9CH ;SDAS INTERRUTT STATUS REG. READ CONTROL EVTE. INTEN EQU 9CH ;SDAS INTERRUTT STATUS REG. READ CONTROL EVTE. INTEN_EQU 9CH ;SDAS INTERRUTT READ FROM FIFO IN BURST ;READ ROUTINES INTEN_EQU 9CH ;STMBOLIC ADDRESS FOR A 16 BIT DATA BUFPER INTEN_EQU 9CH ;STMBOLIC ADDRESS FOR A 16 BIT DATA BUFPER STATUS FOUL 9CH ;STMBOLIC ADDRESS FOR AN 8 BIT EUFFER USED ;IN ROUTINES FOR CONTROL ENTE. INTENT STATUS REGISTER AS DATA SEPERFORMED BY SUBROTTIMES SEE WE & SER_ED, THESE ROUTINES USE THE "CONTEL_BUF" REGISTER AS CONTROL INPUT AND THE "DATA_BUF" REGISTER AS DATA BUFFER, FOR WRITES DATA 15 LOADED ON THE "DATA_BUF" REGISTER AS DATA BUFFER, FOR WRITES DATA 15 LOADED ON THE "DATA_BUF" REGISTER, AND FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. **** AN EXAMPLE OF A WRITE TO CONFIGURATION REGISTER: MOV CNTEL_BUF,#WCONFIG ;LOAD CONTEL BUF WITH WRITE CONTROL ;DYTE NOV DATA_BUF,#02H ;LOAD CONTELBUF WITH WRITE CONTROL ;DYTE NOV DATA_BUF,#02H ;LOAD CONTELBUF WITH READ CONTROL ;DYTE NOV DATA_BUF,#02H ;LOAD CONTELBUF WITH READ CONTROL ;DYTE NOV CNTEL_BUF,#RTIMER ;LOAD CONTEL_BUF WITH READ CONTROL ;DYTE LCALL SEE_RD ;SER_WE ROUTINE READS THE DATA</pre>		ROIT			ATION REG. READ CONTROL BITE.		
<pre>INTERN EQU 09H ,SDAS INTERRUPT ENABLE REG. WEITE CONTROL BYTE. INTERN EQU 08H ,SDAS INTERRUPT STATUS REG. READ CONTROL BYTE. TIMER EQU 08H ,SDAS TIMER REG. READ CONTROL BYTE. ENTERN EQU 08H ,SDAS FINER REG. READ CONTROL BYTE. ENTERN EQU 0CH ,SDAS FINER REG. READ CONTROL BYTE. LIMISTAT EQU 0CH ,SDAS FINE, STATUS REG. READ CONTROL BYTE. LIMISTAT EQU 0CH ,SDAS FINE, STATUS REG. READ CONTROL BYTE. ENTERN EQU 0XXH ,STMEDULIC STARTING ADDRESS OF THE DATA BLOCK ,IN SYSTEM MEMORY, USED TO STORE THE CONVERSION RESULTS READ FROM FINE IN BURST ;READ ROUTINE. ANTA_BUF EQU 0XXH ,SYMEDULIC ADDRESS FOR A 16 BIT DATA BUFFER NIRE_BUF EQU 0XXH ,SYMEDULIC ADDRESS FOR A 16 BIT DATA BUFFER NIRE_BUF EQU 0XXH ,SYMEDULIC DEFINITION FOR THE NUMBER OF ,RESULTS TO BE READ FROM FINE IN BURST READ SERIAL DAS READS AND WRITES ARE PERFORMED BY SUBROUTINES SER_WR & SER_RD, THESE ROUTINES SOLE THE "CONTRL DOF" REGISTER AS CONTROL INFUS AND THE "DATA_BUF" REGISTER AS DATA BUFFER, FOW RITES DATA IS LOADED ON THE "DATA_BUF" REGISTER, AND FOR READ FROM FIFO IN BURST READ SERIAL DAS READS AND WRITES ARE PERFORMED BY SUBROUTINES SER_WR & SER_RD, THESE ROUTINES USE THE "CONTRL_DOF" REGISTER AS CONTROL INFUS AND THE "DATA_BUF" REGISTER AS DATA BUFFER, FOW RITES DATA IS LOADED ON THE "DATA_BUF" REGISTER, AND FOR READ FROM FIFO IN BURST READ SERIAL DAS READS AND WRITES ARE PERFORMED BY SUBROUTINES SER_WR & SER_RD, THESE ROUTINES USE THE "CONTRL_DUF" REGISTER. SERIAL DAS READS AND FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. SERIAL DAS READS AND FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. SERIAL DAS READS DATA BUFF, FOW RITES DATA IS LOADED ON THE "DATA_BUF" REGISTER, AND FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. SERIAL DAS READS DATA BUFF, SOURCE BYTE OF DATA TO DATA_BUF, HOUST DATA_BUFF, SOURCE BYTE OF DATA TO DATA_BUF, BUFF, SOURCE BYTE OF DATA TO DATA_BUF, BUFF, SOURCE CONFIGURATION REGISTER: NOV DATA_BUFF, SER_WR ROUTINE TRANSFERS THE DATA SER_RE READ FROM CONFIGURATION REGISTER: NOV CNTRL_BUF, HETIMER 'LOAD CONFIG</pre>	INTEN	PÕO	08H	;SDAS CONFIGUR	TION REG. WRITE CONTROL BYTE.		
<pre>INTEN EQU 09H ,SDAS INTERGUTE ENABLE REG. WRITE CONTROL BYTE. INTERTA EQU 8AH ,SDAS INTERGUTE STATUS REG. READ CONTROL BYTE. TIMER EQU 8CH ,SDAS TIMER REG. READ CONTROL BYTE. SPIFO EQU 8CH ,SDAS FIFO, SINGLE READ CONTROL BYTE. EFIFO EQU 8CH ,SDAS FIFO, SINGLE READ CONTROL BYTE. INTERTAT EQU 8CH ,SDAS FIFO, SINGLE READ CONTROL BYTE. ATA_BLK EQU 8CH ,STMEOLIC STARTING ADDRESS OF THE DATA BLOCK ,IN SYSTEM MEMORY, USED TO STORE THE ,CONVERSION RESULTS READ FOR FIFO IN BURST ;READ ROUTINE. ATA_BUF EQU 0XXH ,STMEOLIC STARTING ADDRESS OF THE DATA BLOCK ,IN SYSTEM MEMORY, USED TO STORE THE ,CONVERSION RESULTS READ FOR FIFO IN BURST ;READ ROUTINE. ATA_BUF EQU 0XXH ,STMEOLIC ADDRESS FOR A 16 BIT DATA BUFFER NTRE_BUF EQU 0XXH ,STMEOLIC DEFINITION FOR THE NUMBER OF ,RESULTS TO BE READ FROM FIFO IN BURST READ SERIAL DAS READS AND WRITES ARE PERFORMED BY SUBROUTINES SER_WR & SER_RD, THESE ROUTINES USE THE "CONTEL_BUF" REGISTER AS CONTROL INFUT AND THE "DATA_BUF" REGISTER AS DATA BUFFER, FOR WRITES DATA IS LOADED ON THE "DATA_BUF" REGISTER, AND FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. AN EXAMPLE OF A WRITE TO CONFIGURATION REGISTER: MOV CNTRL_BUF,#02H ;LOAD CONTRL_BUF WITH WRITE CONTROL ;BUTE NOV DATA_BUF,#02H ;LOAD CONTRL_BUF WITH WRITE CONTROL ;DATA_BUF NOV DATA_BUF,#02H ;LOAD CONTRL_BUF WITH READ CONTROL ;DATA_BUF NOV DATA_BUF,#02H ;LOAD CONTRL_BUF WITH WRITE CONTROL ;DATA_BUF NOV DATA_BUF,#02H ;LOAD CONTRL_BUF WITH WRITE CONTROL ;DATA_BUF NOV DATA_BUF,#02H ;LOAD CONTRL_BUF WITH WRITE CONTROL ;DATA_BUF NOV DATA_BUF,#02H ;LOAD CONTRL_BUF WITH READ CONTROL ;DATA_BUF NOV DATA_BUF,#02H ;LOAD CONTRL_BUF WITH READ CONTROL ;DATA_BUF NOV DATA_BUF,#1,#00H (CONFIGURATION REGISTER: NOV CNTRL_BUF,#1FIMER ;LOAD CONTRL_BUF WITH READ CONTROL ;DATA_BUF LCALL SER_RD ;SER_WR ROUTINE TRANSFERS THE DATA AN EXAMPLE OF A READ FROM CONFIGURATION REGISTER: NOV CNTRL_BUF,#TIMER ;LOAD CNTRL_BUF WITH READ CONTROL ;DATA_BUF ADDREST FROM CONFIGURATION REGISTER: NOV CNTRL_BUF,#TIMER ;LOAD CNTRL_BUF WITH READ CONTROL ;DAT</pre>			89H				
INTERIN EQU 8AH ,SDAS INTERRUFT STATUS REG. READ CONTROL BYTE. TIMER EQU 86H ,SDAS TIMER REG. READ CONTROL BYTE. SPIRO EQU 8CH ,SDAS TIMER REG. READ CONTROL BYTE. SPIRO EQU 8CH ,SDAS TIMER REG. READ CONTROL BYTE. LIMITSTAT EQU 8CH ,SDAS LIMIT STATUS REG. READ CONTROL BYTE. LIMITSTAT EQU 8CH ,SDAS LIMIT STATUS REG. READ CONTROL BYTE. LIMITSTAT EQU 8CH ,SDAS LIMIT STATUS REG. READ CONTROL BYTE. LIMITSTAT EQU 8CH ,STMBOLIC STARTING ADDRESS OF THE DATA BLOCK ,IN SYSTEM MEMORY, USED TO STORE THE ,CONVERSION RESULTS READ FROM FIFO IN BURST ;READ ROUTINE. ATA_BUF EQU 0XXH ,SYMBOLIC ADDRESS FOR A 16 BIT DATA BUPFER NTRL_BUF EQU 0XXH ,SYMBOLIC ADDRESS FOR AN 8 BIT BUFFER USED ,IN ROUTINE. SELINUM EQU 0XXH ,SYMBOLIC DEFINITION FOR THE NUMBER OF ;RESULTS TO BE READ FROM FIFO IN BURST ;RESULTS TO BE READ FROM FIFO IN BURST ;RESULTS TO BE READ FROM FIFO IN BURST ;RESULTS TO BE READ FROM FIFO IN BURST :RESULTS TO BE READ FROM FIFO IN BURST TRED : :SERIAL DAS READS AND WAITES ARE PERFORMED BY SUBROUTINES SER_WE & SER_ED. : : : : : : : : : : : : :							
TIMER EQU 86H ;SDAS TIMER REG. READ CONTROL BYTE. TIMER EQU 06H ;SDAS TIMER REG. WRITE CONTROL BYTE. SPIFO EQU 0CCH ;SDAS FIFO , SINGLE READ CONTROL BYTE. HITSTAT EQU 8CH ;SDAS LIMIT STATUS REG. READ CONTROL BYTE. ATA_BLK EQU 0XXH ;SYMBOLIC STARTING ADDRESS OF THE DATA BLOCK ;IN SYSTEM MENORY, USED TO STORE THE CONVERSION RESULTS READ FROM FIFO IN BURST ;READ ROUTINE. ATA_BUF EQU 0XXH ;SYMBOLIC ADDRESS FOR A 16 BIT DATA BUPFER NTRL_BUF EQU 0XXH ;SYMBOLIC ADDRESS FOR A 16 BIT DATA BUPFER NTRL_BUF EQU 0XXH ;SYMBOLIC ADDRESS FOR A 16 BIT DATA BUPFER NTRL_BUF EQU 0XXH ;SYMBOLIC DEFINITION FOR THE NUMBER OF ;RESULTS TO BE READ FROM FIFO IN BURST READ SERIAL DAS READS AND WRITES ARE PERFORMED BY SUBROUTINES SER_WR & SER_RD, THESE ROUTINES USE THE "CNTRL_BUF" REGISTER AS CONTROL INFUT AND THE "DATA_BUF" REGISTER AND FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. AN EXAMPLE OF A WRITE TO CONFIGURATION REGISTER: MOV CNTRL_BUF,#02H ;LOAD CONTRL_BUF WITH WRITE CONTROL SER ADD FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. MOV DATA_BUF,#02H ;LOAD LIGH ORDER BYTE OF DATA TO ;DATA_BUF" REGISTER ADD FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. MOV DATA_BUF,#02H ;LOAD LIGH ORDER BYTE OF DATA TO ;DATA_BUF NOV DATA_BUF,#02H ;LOAD LIGH ORDER BYTE OF DATA TO ;DATA_BUF LCALL SER_WR ;SER_WR ROUTINE TRANSFERS THE DATA AN EXAMPLE OF A READ FROM CONFIGURATION REGISTER: NOV CNTRL_BUF,#RTIMER ;LOAD CONTRL_BUF WITH READ CONTROL ;PITB							
TIMER EQU 0BH ; SDAS TIMER REG. WRITE CONTROL BYTE. SPIFO EQU 0CH ; SDAS FIFO , SUNGLE READ CONTROL BYTE. EPIFO EQU 0CH ; SDAS FIFO , BURST READ CONTROL BYTE. IMTSTAT EQU 0DH ; SDAS LIMIT STATUS REG. READ CONTROL BYTE. ATA_BLK EQU 0XH ; SYMBOLIC STARTING ADDRESS OF THE DATA BLOCK ; IN SYSTEM MEMORY, USED TO STORE THE ; CONVERSION RESULTS READ FROM FIFO IN BURST ; READ ROUTINE. ATA_BUF EQU 0XH ; SYMBOLIC ADDRESS FOR A 16 BIT DATA BUFFER NIRL_BUF EQU 0XH ; SYMBOLIC ADDRESS FOR A 16 BIT DATA BUFFER SILT_NUM EQU 0XH ; SYMBOLIC DEFINITION FOR THE NUMBER OF ; RESULTS TO BE READ FROM FIFO IN BURST READ SERIAL DAS READS AND WRITES ARE PERFORMED BY SUBROUTINES SER_WR & SER_RD, THESE ROUTINES SOR CONTROL BYTE AN EXAMPLE OF A WRITE TO CONFIGURATION REGISTER: MOV CITEL_BUF, #WCONFIG ; LOAD CITEL_BUF WITH WRITE CONTROL ; DITE MOV DATA_BUF+1,#00H ; JOAD LOW ROBER BYTE OF DATA TO ; DATA_BUF NOV DATA_BUF+1,#00H ; JOAD LOW ROBER BYTE OF DATA TO ; DATA_BUF MOV CITEL_BUF,#WCONFIG ; JOAD CONTEL_BUF WITH WRITE CONTROL ; DATA_BUF MOV DATA_BUF+1,#00H ; JOAD LOW ROBER BYTE OF DATA TO ; DATA_BUF MOV CITEL_BUF,#WCONFIG ; JOAD CONTEL_BUF WITH WRITE CONTROL ; DATA_BUF MOV DATA_BUF+1,#00H ; JOAD CONTEL_BUF WITH READ CONTROL ; DATA_BUF MOV DATA_BUF,#WCONFIG ; JOAD CONTEL_BUF WITH READ CONTROL ; DATA_BUF MOV CITEL_BUF,#RTIMER ; JEAR ROUTINE TRANSFERS THE DATA MOV CITEL_BUF,#RTIMER ; JEAR ROUTINE TRANSFERS THE DATA MOV CITEL_BUF,#RTIMER ; JEAR FOR CONFIGURATION REGISTER: MOV CITEL_BUF,#RTIMER ; JEAR FOR CONFIGURATION REGISTER: MOV CITEL_BUF,#RTIMER ; JEAR FOR THE READ CONTROL ; DATA_BUF MOV CITEL_BUF,#RTIMER ; JEAR CONTINE TRANSFERS THE DATA							
SFIFO EQU 8CH ;SDAS FIFO , SINGLE READ CONTROL BYTE. BFIFO EQU 0CCH ;SDAS FIFO , BURET READ CONTROL BYTE. IMISTAT EQU 0XH ;SYMBOLIC STARTING ADDRESS OF THE DATA BLOCK ;IN SYSTEM MEMORY, USED TO STORE THE ;CONVERSION RESULTS READ FROM FIFO IN BURST ;READ ROUTINE. ATA_BUF EQU 0XH ;SYMBOLIC ADDRESS FOR A 16 BIT DATA BUFFER NTRL_BUF EQU 0XXH ;SYMBOLIC ADDRESS FOR A 16 BIT DATA BUFFER NTRL_BUF EQU 0XXH ;SYMBOLIC DEFINITION FOR THE NUMBER OF ;RESULTS TO BE READ FROM FIFO IN BURST EXEMPTION SERIAL DAS READS AND WRITES ARE PERFORMED BY SUBROUTINES SER_WR & SER_RD, THESE ROUTINES USE THE "CNTRL_BUF" REGISTER AS CONTROL INPUT AND THE "DATA_BUF" REGISTER, AND FOR READS DATA BUFFER, FOR WRITES DATA 15 LOADED ON THE "DATA_BUF" REGISTER, AND FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. AN EXAMPLE OF A WRITE TO CONFIGURATION REGISTER: MOV CNTRL_BUF, #002H ;LOAD LOW ORDER BYTE OF DATA TO ;DATA_BUF MOV DATA_BUF+,#02H ;LOAD LOW ORDER BYTE OF DATA TO ;DATA_BUF MOV CNTRL_BUF,#RCONFIG ;LOAD CNTRL_BUF WITH WRITE CONTROL ;DATA_BUF MOV DATA_BUF+,#02H ;LOAD LOW ORDER BYTE OF DATA TO ;DATA_BUF MOV CNTRL_BUF,#RCONFIG ;LOAD CNTRL_BUF WITH READS THE DATA SET MOV CNTRL_BUF,#RCONFIG ;LOAD CNTRL_BUF WITH WRITE CONTROL ;DATA_BUF MOV DATA_BUF,#02H ;LOAD LOW ORDER BYTE OF DATA TO ;DATA_BUF MOV DATA_BUF,#02H ;LOAD LOW ORDER BYTE OF DATA TO ;DATA_BUF MOV CNTRL_BUF,#RCONFIG ;LOAD CNTRL_BUF WITH READ CONTROL ;BYTE MOV CNTRL_BUF,#RCONFIG ;LOAD CNTRL_BUF WITH READ CONTROL ;BYTE MOV CNTRL_BUF,#RCONFIG ;LOAD CNTRL_BUF WITH READ CONTROL ;BYTE MOV CNTRL_BUF,#RCONFIG ;LOAD CNTRL_BUF WITH READ CONTROL ;BYTE				SDAS TIMER RE	WRITE CONTROL BYTE.		
BEIFO EQU 0CCH ;SDAS FIFO , BURST READ CONTROL BYTE. IMTSTAT EQU 0DH ;SDAS LIMIT STATUS REG. READ CONTROL BYTE. ATA_BLK EQU 0XXH ;SYMBOLIC STARTING ADDRESS OF THE DATA BLOCK ,IN SYSTEM MEMORY, USED TO STORE THE ;CONVERSION RESULTS READ FROM FIFO IN BURST ;READ ROUTINE. ATA_BUF EQU 0XXH ;SYMBOLIC ADDRESS FOR A 16 BIT DATA BUFFER NTRL_BUF EQU 0XXH ;SYMBOLIC DADRESS FOR A 16 BIT DATA BUFFER NTRL_BUF EQU 0XXH ;SYMBOLIC DADRESS FOR A 16 BIT DATA BUFFER NTRL_BUF EQU 0XXH ;SYMBOLIC DEFINITION FOR THE NUMBER OF ;RESULTS TO BE READ FROM FIFO IN BURST READ SERIAL DAS READS AND WRITES ARE PERFORMED BY SUBROUTINES SER_WR & SER_RD, THESE ROUTINES USE THE "CNTRL_BUF" REGISTER AS CONTROL INPUT AND THE "DATA_BUF" REGISTER, AND FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. AN EXAMPLE OF A WRITE TO CONFIGURATION REGISTER: MOV CNTRL_BUF, #WCONFIG ;LOAD LOW ORDER BYTE OF DATA TO ,DATA_BUF" MOV DATA_BUF+1,#00H ;JOAD LOW ORDER BYTE OF DATA TO ,DATA_BUF MOV DATA_BUF+1,#00H ;JOAD LOW ORDER BYTE OF DATA TO ,DATA_BUF MOV DATA_BUF+1,#00H ;JOAD LOW ORDER BYTE OF DATA TO ,DATA_BUF MOV CNTRL_BUF,#WC CONFIGURATION REGISTER: MOV CNTRL_BUF,#RTIMER ;SER_WR ROUTINE TRANSFERS THE DATA AN EXAMPLE OF A READ FROM CONFIGURATION REGISTER: MOV CNTRL_BUF,#RTIMER ;LOAD CNTRL_BUF WITH WRITE CONTROL ,BYTE MOV CNTRL_BUF,#RTIMER ;LOAD CNTRL_BUF WITH READ CONTROL ,BYTE LCALL SER_RD ;SER_ND CONFIGURATION REGISTER: MOV CNTRL_BUF,#RTIMER ;LOAD CNTRL_BUF WITH READ CONTROL ,BYTE LCALL SER_RD ;SER_ND ROUTINE READS THE DATA							
LMTSTAT EQU 9DH ;SDAS LIMIT STATUS REG. READ CONTROL BYTE. ATA_BLK EQU 0XXH ;SYMBOLIC STARTING ADDRESS OF THE DATA BLOCK ;IN SYSTEM MEMORY, USED TO STORE THE ;CONVERSION RESULTS READ FROM FIFO IN BURST ;READ ROUTINE. ATA_BUF EQU 0XXH ;SYMBOLIC ADDRESS FOR A 16 BIT DATA BUFFER NTRL_BUF EQU 0XXH ;SYMBOLIC ADDRESS FOR AN 8 BIT BUFFER USED ;IN ROUTINES FOR CONTROL BYTE. SLT_NUM EQU 0XXH ;SYMBOLIC DEFINITION FOR THE NUMBER OF ;RESULTS TO BE READ FROM FIFO IN BURST READ ************************************							
ATA_BLK EQU 0XXH ;SYMBOLIC STARTING ADDRESS OF THE DATA BLOCK ;IN SYSTEM MEMORY, USED TO STORE THE ;CONVERSION RESULTS READ FROM FIFO IN BURST ;READ ROUTINE. ATA_BUF EQU 0XXH ;SYMBOLIC ADDRESS FOR A 16 BIT DATA BUFFER NIRTL_BUF EQU 0XXH ;SYMBOLIC ADDRESS FOR A 16 BIT DATA BUFFER SLT_NUM EQU 0XXH ;SYMBOLIC DEPINITION FOR THE NUMBER OF ;IN ROUTINES FOR CONTROL BYTE SETIAL DAS READS AND WRITES ARE PERFORMED BY SUBROUTINES SER_WR & SER_RD, THESE ROUTINES USE THE "CNTRL_BUF" REGISTER AS CONTROL INPUT AND THE "DATA_BUF" REGISTER, AND FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. **** AN EXAMPLE OF A WRITE TO CONFIGURATION REGISTER: MOV CNTRL_BUF, #WCONFIG ;LOAD LOW ORDER BYTE OF DATA TO ;DATA_BUF" REGISTER, AND FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. MOV CNTRL_BUF, #02H ;LOAD LOW ORDER BYTE OF DATA TO ;DATA_BUF MOV DATA_BUF+1,#00H ;LOAD LOW ORDER BYTE OF DATA TO ;DATA_BUF							
<pre>, IN SYSTEM MEMORY, USED TO STORE THE</pre>	LIMISIAI	EQU:	obh	JODAS LIMIT SI	AIUS REG. READ CONIROL BIIE.		
<pre>;CONVERSION RESULTS READ FROM FIFO IN BURST ;READ ROUTINE. ATA_BUF EQU 0XH ;SYMBOLIC ADDRESS FOR A 16 BIT DATA BUFFER INTRL_BUF EQU 0XXH ;SYMBOLIC ADDRESS FOR AN 8 BIT BUFFER USED ;IN ROUTINES FOR CONTROL BYTE. ISLT_NUM EQU 0XXH ;SYMBOLIC DEFINITION FOR THE NUMBER OF ;RESULTS TO BE READ FROM FIFO IN BURST READ ***********************************</pre>	ATA_BLK	EQU	ОХХН	SYMBOLIC STAR	TING ADDRESS OF THE DATA BLOCK		
<pre>;READ ROUTINE. ;ARTA_BUF EQU 0XXH ;SYMBOLIC ADDRESS FOR AN 8 BIT BUFFER USED ;IN ROUTINES FOR CONTROL BYTE. SUT_NUM EQU 0XXH ;SYMBOLIC DEFINITION FOR THE NUMBER OF ;RESULTS TO BE READ FROM FIFO IN BURST READ ***********************************</pre>				; IN SYSTEM MEM	DRY, USED TO STORE THE		
ATA_BUF EQU 0XXH ; SYMBOLIC ADDRESS FOR A 16 BIT DATA BUFFER INTEL_BUF EQU 0XXH ; SYMBOLIC ADDRESS FOR A 16 BIT DATA BUFFER INTEL_BUF EQU 0XXH ; SYMBOLIC ADDRESS FOR AN 8 BIT BUFFER USED ; IN ROUTINES FOR CONTROL BYTE. ISLT_NUM EQU 0XXH ; SYMBOLIC DEFINITION FOR THE NUMBER OF ; RESULTS TO BE READ FROM FIFO IN BURST READ SERIAL DAS READS AND WRITES ARE PERFORMED BY SUBROUTINES SER_WR & SER_RD, THESE ROUTINES USE THE "CNTEL_BUF" REGISTER AS CONTROL INPUT AND THE "DATA_BUF" REGISTER AS DATA BUFFER, FOR WRITES DATA IS LOADED ON THE "DATA_BUF" REGISTER, AND FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. AN EXAMPLE OF A WRITE TO CONFIGURATION REGISTER: MOV CNTEL_BUF, #02H ; LOAD CNTEL_BUF WITH WRITE CONTROL ; BYTE MOV DATA_BUF, #02H ; LOAD LOW ORDER BYTE OF DATA TO ; DATA_BUF NOV DATA_BUF, #02H ; JOAD HIGH ORDER BYTE OF DATA TO ; DATA_BUF LCALL SER_WR ; SER_WR ROUTINE REGISTER: MOV CNTEL_BUF, #THMER ; LOAD CNTEL_BUF WITH READ CONTROL ; BYTE LCALL SER_RD ; PAREM FROM CONFIGURATION REGISTER: MOV CNTEL_BUF, #THMER ; LOAD CNTEL_BUF WITH READ CONTROL ; BYTE LCALL SER_RD ; SER_RD ROUTINE READS THE DATA				;CONVERSION RE	SULTS READ FROM FIFO IN BURST		
<pre>NTRT_BUF EQU 0XXH ; SYMEOLIC ADDRESS FOR AN 8 BIT BUFFER USED ;IN ROUTINES FOR CONTROL BYTE. ISLT_NUM EQU 0XXH ; SYMEOLIC DEFINITION FOR THE NUMBER OF ;RESULTS TO BE READ FROM FIFO IN BURST READ</pre>				;READ ROUTINE.			
<pre>NTRT_BUF EQU 0XXH ; SYMEOLIC ADDRESS FOR AN 8 BIT BUFFER USED ;IN ROUTINES FOR CONTROL BYTE. ISLT_NUM EQU 0XXH ; SYMEOLIC DEFINITION FOR THE NUMBER OF ;RESULTS TO BE READ FROM FIFO IN BURST READ</pre>	ATA BUF	EQU	OXXH	SYMBOLIC ADDR	ESS FOR A 16 BIT DATA BUFFER		
<pre>;IN ROUTINES FOR CONTROL BYTE. ;IN ROUTINES FOR CONTROL BYTE. ;SINDOLLC DEFINITION FOR THE NUMBER OF ;RESULTS TO BE READ FROM FIFO IN BURST READ ***********************************</pre>							
<pre>SLT_NUM EQU 0XXH ;SYMBOLIC DEFINITION FOR THE NUMBER OF ;RESULTS TO BE READ FROM FIFO IN BURST READ ***********************************</pre>				14			
<pre>;RESULTS TO BE READ FROM FIFO IN BURST READ ;RESULTS TO BE READ FROM FIFO IN BURST READ ;results to be read from fifth in burst read ;results and writes are performed by subroutines ser_wr & ser_rd, these routines use the "CNTRL BUF" register as control input and the "DATA_BUF" REGISTER as DATA BUFFER, FOR WRITES DATA IS LOADED ON THE "DATA_BUF" REGISTER, AND FOR READS DATA REFURSI IN THE "DATA_BUF" REGISTER</pre>	ST.T NITM	EOU	0774				
SERIAL DAS READS AND WRITES ARE PERFORMED BY SUBROUTINES SER_WR & SER_RD, THESE ROUTINES USE THE "CNTRL_BUF" REGISTER AS CONTROL INPUT AND THE "DATA_BUF" REGISTER AS DATA BUFFER, FOR WRITES DATA IS LOADED ON THE "DATA_BUF" REGISTER, AND FOR READS DATA RETURNS IN THE "DATA_BUF" REGISTER. AN EXAMPLE OF A WRITE TO CONFIGURATION REGISTER: MOV CNTRL_BUF, #WCONFIG ; LOAD CNTRL_BUF WITH WRITE CONTROL ;BYTE MOV DATA_BUF, #02H ; LOAD LOW ORDER BYTE OF DATA TO ;DATA_BUF MOV DATA_BUF+1, #00H ; LOAD LOW ORDER BYTE OF DATA TO ;DATA_BUF LCALL SER_WR ;SER_WR ROUTINE TRANSFERS THE DATA AN EXAMPLE OF A READ FROM CONFIGURATION REGISTER: MOV CNTRL_BUF, #RTIMER ;LOAD CNTRL_BUF WITH READ CONTROL ;BYTE LCALL SER_RD ;SER_RD ROUTINE READS THE DATA		220					
MOV CNTRL_BUF, #WCONFIG ; LOAD CNTRL_BUF WITH WRITE CONTROL ,BYTE ; DATA_BUF, #02H ; LOAD LOW ORDER BYTE OF DATA TO MOV DATA_BUF+1, #00H ; LOAD HIGH ORDER BYTE OF DATA TO MOV DATA_BUF+1, #00H ; LOAD HIGH ORDER BYTE OF DATA TO LCALL SER_WR ; SER_WR ROUTINE TRANSFERS THE DATA ; AN EXAMPLE OF A READ FROM CONFIGURATION REGISTER: MOV CNTRL_BUF, #RTIMER ; LOAD CNTRL_BUF WITH READ CONTROL ; LCALL SER_RD ; SER_RD ROUTINE READS THE DATA	SERIAL THESE F "DATA_E "DATA_E	DAS RE COUTINE SUF" RE SUF" RE	ADS AND S USE TH GISTER A GISTER,	WRITES ARE PERF E "CNTRL_BUF" R S DATA BUFFER, AND FOR READS D.	DRMED BY SUBROUTINES SER_WR & S BGISTER AS CONTROL INPUT AND THU FOR WRITES DATA IS LOADED ON THU ATA RETURNS IN THE "DATA_BUF" RU	ER_RD, E E EGISTER.	
,BYTE MOV DATA_BUF,#02H ;LOAD LOW ORDER BYTE OF DATA TO ,DATA_BUF MOV DATA_BUF+1,#00H ;LOAD HIGH ORDER BYTE OF DATA TO ,DATA_BUF LCALL SER_WR ;SER_WR ROUTINE TRANSFERS THE DATA ; AN EXAMPLE OF A READ FROM CONFIGURATION REGISTER: MOV CNTRL_BUF,#RTIMER ;LOAD CNTRL_BUF WITH READ CONTROL ;EXTE LCALL SER_RD ;SER_RD ROUTINE READS THE DATA	AN E	XAMPLE	OFAWR	ITE TO CONFIGUR	ATION REGISTER:		
,DATA_BUF MOV DATA_BUF+1,#00H ;LOAD HIGH ORDER BYTE OF DATA TO ,DATA_BUF LCALL SER_WR ;SER_WR ROUTINE TRANSFERS THE DATA ; AN EXAMPLE OF A READ FROM CONFIGURATION REGISTER: MOV CNTRL_BUF,#RTIMER ;LOAD CNTRL_BUF WITH READ CONTROL ;EYTE LCALL SER_RD ;SER_RD ROUTINE READS THE DATA	Μ	10V	CNTRL_B	UF,#WCONFIG		NTROL	
MOV DATA_BUF+1,#00H ;LOAD HIGH ORDER BYTE OF DATA TO ;DATA_BUF ;DATA_BUF LCALL SER_WR ;SER_WR ROUTINE TRANSFERS THE DATA ; AN EXAMPLE OF A READ FROM CONFIGURATION REGISTER:	M	10 V	DATA_BUI	F,#02H		0	
LCALL SER_WR ;SER_WR ROUTINE TRANSFERS THE DATA ; AN EXAMPLE OF A READ FROM CONFIGURATION REGISTER: MOV CNTRL_BUF,#RTIMER ;LOAD CNTRL_BUF WITH READ CONTROL ;EVTE LCALL SER_RD ;SER_RD ROUTINE READS THE DATA	Ν	IOV	DATA_BUI	7+1,#00H	;LOAD HIGH ORDER BYTE OF DATA	то	
MOV CNTRL_BUF, #RTIMER ;LOAD CNTRL_BUF WITH READ CONTROL ;BYTE LCALL SER_RD ;SER_RD ROUTINE READS THE DATA	I	CALL	SER_WR			DATA	
;BYTE LCALL SER_RD ;SER_RD ROUTINE READS THE DATA	; AN E	XAMPLE	OF A REA	AD FROM CONFIGUR	ATION REGISTER:		
LCALL SER_RD ;SER_RD ROUTINE READS THE DATA	Ν	40V	CNTRL_BU	JF,#RTIMER		ROL	
	-		CRD DD				
	1	JCALL	SER_RD		SER_ED ROOTINE READS THE DATA		TL/H/11879-90

			8051 Assembly Code Example (Continued)	
******	******	******	*****	
			OR A SERIAL WRITE TO THE DAS. BEFORE CALLING THE	
			OULD BE LOADED IN THE "CNTRL_BUF"	
; AND T	HE DATA	TO BE WRITTEN TO THE	SDAS SHOULD BE LOADED IN THE "DATA_BUF".	
;*****	******	*****	*********	
SER_WR:				
_	CLR	SDAS_SLCT	;SELECT THE SDAS, CHIP SELECT=0	
	CLR	S_DONE	CLEAR SEND CYCLE DONE FLAG	
	MOV	SBUF, CNTRL_BUF	;START SENDING THE WRITE CONTROL BYTE ;WAIT HERE UNTIL SEND CYCLE COMPLETED	
SENDW :	JNB	S_DONE, SENDW	WAIT HERE UNTIL SEND CICLE COMPLETED	
	CLR	S DONE	CLEAR SEND CYCLE DONE FLAG	
	MOV	SBUF, DATA_BUF	;START SENDING LOW ORDER BYTE OF DATA	
SEND1:	JNB	S_DONE, SEND1	;WAIT HERE UNTIL SEND CYCLE COMPLETED	
	CLR	S DONE	CLEAR SEND CYCLE DONE FLAG	
	MOV	SBUF, DATA BUF+1	START SENDING HIGH ORDER BYTE OF DATA	
SEND2:	JNB	S_DONE, SEND2	;WAIT HERE UNTIL SEND CYCLE COMPLETED	
	SETB	SDAS_SLCT	;DESELECT THE SDAS, CHIP SELECT=1	
******	RET ******	*****	**********	
			A SERIAL READ FROM THE DAS. BEFORE CALLING THE	
			DULD BE LOADED ON THE "CNTRL_BUF"	
; AND T	HE DATA	IS LOADED IN THE "DAY	A_BUF" UPON RETURN FROM SUBROUTINE.	
	******	******	******************	
SER_RD:	CLR	SDAS SLCT	;SELECT THE SDAS, CHIP SELECT=0	
	CLR	S DONE	CLEAR SEND CYCLE DONE FLAG	
	MOV	SBUF, CNTRL_BUF	; START SENDING THE READ CONTROL BYTE	
SENDR :	JNB	S_DONE, SENDR	WAIT HERE UNTIL SEND CYCLE COMPLETED	
	SETB	R_EN	;ENABLE DATA RECEIVE CYCLES	
	CLR	R DONE	START A DATA BYTE RECEIVE CYCLE	
RCV1:	JNB	R_DONE, RCV1	WAIT HERE UNTIL RECEIVE COMPLETED	
	MOV	DATA_BUF, SBUF	;STORE LOW ORDER BYTE IN DATA_BUF	
	CLR	R DONE	START A DATA BYTE RECEIVE CYCLE	
RCV2 :	JNB	R DONE, RCV2	WAIT HERE UNTIL RECEIVE COMPLETED	
	MOV	DATA_BUF+1,SBUF	;STORE HIGH ORDER BYTE IN DATA_BUF	
	SETB	SDAS SLCT	; DESELECT THE SDAS, CHIP SELECT=1	
	CLR	R_EN	DISABLE DATA RECEIVE CYCLES	
	RET		,	
				TL/H/11879-91

			8051 Assembly Code Example (Continued)	
			IFO", FOR READING THE CONVERSION RESULTS	
			TA IS READ FROM FIFO AND STORED IN THE "DATA_BLK" ADDRESS. NUMBER OF CONVERSION	
			. THIS ROUTINE USES THE RO AND RI REGISTERS.	
			HE PRESENT REGISTER BANK.	
			WHERE THE CONVERSION RESULTS ARE STORED.	
			TRACK OF THE NUMBER OF RESULTS TO BE READ	
FROM				
		*****	***************	
D_FIFO	MOV	R0, DATA BLK	SETTING DATA BLOCK POINTER	
	MOV	A, #RSLT_NUM	;NUMBER OF RESULTS TO BE READ IN ACC	
	RL	A	CALCULATING # OF DATA BYTES TO BE	
			;READ FROM FIFO, EACH CONVERSION	
			;RESULTS IS 2 BYTES	
	MOV	R1,A	NUMBER OF DATA BYTES TO RI COUNTER	
	DEC	R1	;TOTAL DATA BYTES MINUS 1 IN COUNTER	
	CLR	SDAS_SLCT	;SELECT THE SDAS, CHIP SELECT=0	
	CLR	S DONE	CLEAR SEND CYCLE DONE FLAG	
	MOV	SBUF, #RBFIFO	START SENDING THE FIFO BURST READ	
			; CONTROL BYTE	
ENDB :	JNB	S_DONE, SENDB	;WAIT HERE UNTIL SEND CYCLE COMPLETED	
	SETB	R_EN	;ENABLE DATA RECEIVE CYCLES	
D_LP:	CLR	R_DONE	;START A DATA BYTE RECEIVE CYCLE	
CVB:	JNB	R_DONE, RCVB	;WAIT HERE UNTIL RECEIVE COMPLETED	
	MOV	@R0,SBUF	STORE DATA BYTES IN DATA_BLK	
	INC	RO	; POINTING TO NEXT DATA LOCATION	
	DJNZ	R1,RD_LP	READ NEXT BYTE IF NOT THE LAST ONE	
	SETB	SDAS_SLCT	; DESELECT THE SDAS, BEFOR READING ; THE LAST BYTE, BURST READ TERMINATION	
	CLR	R_DONE	START A DATA BYTE RECEIVE CYCLE	
CVL:	JNB	R_DONE, RCVL	;WAIT HERE UNTIL RECEIVE COMPLETED	
CVL;	JNB MOV	R_DONE, RCVL @R0, SBUF	;WAIT HERE UNTIL RECEIVE COMPLETED ;STORE THE LAST DATA BYTE	
CVL:	MOV	-		
	MOV CLR RET	@R0,SBUF R_EN	;STORE THE LAST DATA BYTE ;DISABLE DATA RECEIVE CYCLES	
*****	MOV CLR RET	@R0,SBUF R_EN	;STORE THE LAST DATA BYTE	
THIS	MOV CLR RET ROUTINE	@Ro,SBUF R_EN INITIALIZES THE SDA	;STORE THE LAST DATA BYTE ;DISABLE DATA RECEIVE CYCLES	
****** THIS COMMU	MOV CLR RET ROUTINE NICATIC	@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT	;STORE THE LAST DATA BYTE ;DISABLE DATA RECEIVE CYCLES 	
THIS COMMU SERIA IS HI	MOV CLR RET ROUTINE NICATIC L CLOCK GH. THI	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE</pre>	;STORE THE LAST DATA BYTE ;DISABLE DATA RECEIVE CYCLES 	
THIS COMMU SERIA IS HI DEVEL	MOV CLR RET ROUTINE INICATIC L CLOCK GH. THI LOPMENT	©RO, SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R	;STORE THE LAST DATA BYTE ;DISABLE DATA RECEIVE CYCLES S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILE ITS CHIP SELECT D AT THE START OF THE PROGRAM DURING CODE EAD OR WRITE CYCLE MUST BE INTERRUPTED	
THIS COMMU SERIA IS HI DEVEL BECAU	MOV CLR RET ROUTINE INICATIC L CLOCK GH. THI JOPMENT USE OF T	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN</pre>	,STORE THE LAST DATA BYTE ,DISABLE DATA RECEIVE CYCLES S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILE ITS CHIP SELECT D AT THE START OF THE PROGRAM DURING CODE HEAD OR WRITE CYCLE MUST BE INTERRUPTED T.	
THIS COMMU SERIA IS HI DEVEL BECAU	MOV CLR RET ROUTINE DNICATIC L CLOCK GH. THI JOPMENT JSE OF T	©R0, SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN	;STORE THE LAST DATA BYTE ;DISABLE DATA RECEIVE CYCLES S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILE ITS CHIP SELECT D AT THE START OF THE PROGRAM DURING CODE EAD OR WRITE CYCLE MUST BE INTERRUPTED	
THIS COMMU SERIA IS HI DEVEL BECAU	MOV CLR RET ROUTINE INICATIC LL CLOCK GH. THI JOPMENT USE OF T SR_PORT_	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN EE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST:</pre>	;STORE THE LAST DATA BYTE ;DISABLE DATA RECEIVE CYCLES 	
THIS COMMU SERIA IS HI DEVEL BECAU	MOV CLR RET ROUTINE DNICATIC L CLOCK GH. THI JOPMENT JSE OF T	©R0, SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN	,STORE THE LAST DATA BYTE ,DISABLE DATA RECEIVE CYCLES S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILE ITS CHIP SELECT D AT THE START OF THE PROGRAM DURING CODE HEAD OR WRITE CYCLE MUST BE INTERRUPTED T.	
THIS COMMU SERIA IS HI DEVEL BECAU	MOV CLR RET ROUTINE ROUTINE CL CLOCK GH. THI OPMENT ISE OF T SETB SETB	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST: SDAS_SLCT R_EN</pre>	<pre>;STORE THE LAST DATA BYTE ;DISABLE DATA RECEIVE CYCLES </pre>	
THIS COMMU SERIA IS HI DEVEL BECAU DEVEL BECAU	MOV CLR RET ROUTINE NICATIC LL CLOCK GH. THI OPMENT SE OF T SETB SETB SETB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST: SDAS_SLCT R_EN R_DONE</pre>	<pre>,STORE THE LAST DATA EYTE ,DISABLE DATA RECEIVE CYCLES .S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILLE ITS CHIP SELECT DD AT THE START OF THE PROGRAM DURING CODE LEAD OR WRITE CYCLE MUST BE INTERRUPTED T</pre>	
THIS COMMU SERIA IS HI DEVEL BECAU DEVEL BECAU	MOV CLR RET ROUTINE INICATIO L CLOCK GH. THI OPMENT SE OF T SETB SETB SETB CLR JNB	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN ST: SDAS_SLCT R_EN R_DONE R_DONE R_DONE,TRY1</pre>	<pre>;STORE THE LAST DATA EYTE ;DISABLE DATA RECEIVE CYCLES .S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILE ITS CHIP SELECT #D AT THE START OF THE PROGRAM DURING CODE LEAD OR WRITE CYCLE MUST BE INTERRUPTED T. </pre>	
THIS COMMU SERIA IS HI DEVEL BECAU DAS_SE	MOV CLR RET ROUTINE INICATIC L CLOCK GH. THI OPMENT ISE OF T SETB SETB CLR JNB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST: SDAS_SLCT R_EN R_DONE R_DONE,TRY1 R_DONE</pre>	<pre>;STORE THE LAST DATA BYTE ;DISABLE DATA RECEIVE CYCLES </pre>	
THIS COMMU SERIA IS HI DEVEL BECAU DAS_SE	MOV CLR RET ROUTINE INICATIO L CLOCK GH. THI JOPMENT ISE OF T SETB SETB SETB CLR JNB	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN FRT: SDAS_SLCT R_EN R_DONE R_DONE R_DONE,TRY1 R_DONE R_DONE,TRY2</pre>	<pre>,STORE THE LAST DATA EYTE ,DISABLE DATA RECEIVE CYCLES S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILLE ITS CHIP SELECT ED AT THE START OF THE PROGRAM DURING CODE ELAD OR WRITE CYCLE MUST BE INTERRUPTED T. </pre>	
THIS COMMU SERIA IS HI DEVEL BECAU ****** DAS_SE RY1: RY2:	MOV CLR RET ROUTINE INICATIC L CLOCK GGH. THI OPMENT ISE OF T SETB SETB CLR JNB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA INITIALIZES THE SDA INITIALIZES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN KST: SDAS_SLCT R_EN R_DONE R_DONE,TRY1 R_DONE R_DONE,TRY1 R_DONE,TRY2 R_DONE</pre>	<pre>;STORE THE LAST DATA BYTE ;DISABLE DATA RECEIVE CYCLES </pre>	
THIS COMMU SERIA IS HI DEVEL BECAU ****** DAS_SE RY1: RY2:	MOV CLR RET ROUTINE NICATIO L CLOCK GH. THI JOPMENT SETB SETB SETB CLR JNB CLR JNB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN FRT: SDAS_SLCT R_EN R_DONE R_DONE R_DONE,TRY1 R_DONE R_DONE,TRY2</pre>	<pre>;STORE THE LAST DATA EYTE ;DISABLE DATA RECEIVE CYCLES S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILE ITS CHIP SELECT ID AT THE START OF THE PROGRAM DURING CODE LEAD OR WRITE CYCLE MUST BE INTERRUPTED T. ;DESELECT THE SDAS, CHIP SELECT=1 ;ENABLE DATA RECEIVE CYCLES ;START A CYCLE, 8 PULSES APPLIED ;WAIT HERE UNTIL CYCLE COMPLETED ;START A CYCLE, 8 PULSES APPLIED ;WAIT HERE UNTIL CYCLE COMPLETED ;START A CYCLE, 8 PULSES APPLIED ;START A CYCLE, 8 PULSES APPLIED</pre>	
THIS COMMU SERIA IS HI DEVEL BECAU ****** DAS_SE RY1: RY2:	MOV CLR RET ROUTINE ROUTINE NICATIC L CLCCK GH. THI JOPMENT SETB SETB CLR JNB CLR JNB CLR JNB CLR JNB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA INITIALIZES THE SDA INITIALIZES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN KST: SDAS_SLCT R_EN R_DONE R_DONE,TRY1 R_DONE R_DONE,TRY1 R_DONE,TRY2 R_DONE</pre>	<pre>;STORE THE LAST DATA EYTE ;DISABLE DATA RECEIVE CYCLES S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILE ITS CHIP SELECT ID AT THE START OF THE PROGRAM DURING CODE LEAD OR WRITE CYCLE MUST BE INTERRUPTED T. ;DESELECT THE SDAS, CHIP SELECT=1 ;ENABLE DATA RECEIVE CYCLES ;START A CYCLE, 8 PULSES APPLIED ;WAIT HERE UNTIL CYCLE COMPLETED ;START A CYCLE, 8 PULSES APPLIED ;WAIT HERE UNTIL CYCLE COMPLETED ;START A CYCLE, 8 PULSES APPLIED ;START A CYCLE, 8 PULSES APPLIED</pre>	
THIS COMMU SERIA IS HI DEVEL BECAU ****** DAS_SE RY1: RY2:	MOV CLR RET NICATIC L CLOCK GH. THI JOPMENT SETB SETB CLR JNB CLR JNB CLR JNB CLR JNB	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST: SDAS_SLCT R_EN R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE,TRY1 R_DONE R_DONE R_DONE,TRY2 R_DONE R_DONE,TRY3</pre>	<pre>;STORE THE LAST DATA EYTE ;DISABLE DATA RECEIVE CYCLES SSERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILLE ITS CHIP SELECT ED AT THE START OF THE PROGRAM DURING CODE EAD OR WRITE CYCLE MUST BE INTERRUPTED T. </pre>	
THIS COMMU SERIA IS HI DEVEL BECAU ****** DAS_SE RY1: RY2:	MOV CLR RET ROUTINE ROUTINE NICATIC L CLCCK GH. THI JOPMENT SETB SETB CLR JNB CLR JNB CLR JNB CLR JNB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST: SDAS_SLCT R_EN R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE,TRY1 R_DONE R_DONE R_DONE,TRY2 R_DONE R_DONE,TRY3</pre>	<pre>;STORE THE LAST DATA EYTE ;DISABLE DATA RECEIVE CYCLES SSERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILLE ITS CHIP SELECT ED AT THE START OF THE PROGRAM DURING CODE EAD OR WRITE CYCLE MUST BE INTERRUPTED T. </pre>	TL/H/11879–96
THIS COMMU SERIA IS HI DEVEL BECAU ****** DAS_SE RY1: RY2:	MOV CLR RET ROUTINE ROUTINE NICATIC L CLCCK GH. THI JOPMENT SETB SETB CLR JNB CLR JNB CLR JNB CLR JNB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST: SDAS_SLCT R_EN R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE,TRY1 R_DONE R_DONE R_DONE,TRY2 R_DONE R_DONE,TRY3</pre>	<pre>;STORE THE LAST DATA EYTE ;DISABLE DATA RECEIVE CYCLES SSERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILLE ITS CHIP SELECT ED AT THE START OF THE PROGRAM DURING CODE EAD OR WRITE CYCLE MUST BE INTERRUPTED T. </pre>	TL/H/11879–96
THIS COMMU SERIA IS HI DEVEL BECAU ****** DAS_SE RY1: RY2:	MOV CLR RET ROUTINE ROUTINE NICATIC L CLCCK GH. THI JOPMENT SETB SETB CLR JNB CLR JNB CLR JNB CLR JNB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST: SDAS_SLCT R_EN R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE,TRY1 R_DONE R_DONE R_DONE,TRY2 R_DONE R_DONE,TRY3</pre>	<pre>;STORE THE LAST DATA EYTE ;DISABLE DATA RECEIVE CYCLES SSERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILLE ITS CHIP SELECT ED AT THE START OF THE PROGRAM DURING CODE EAD OR WRITE CYCLE MUST BE INTERRUPTED T. </pre>	TL/H/11879–96
THIS COMMU SERIA IS HI DEVEL BECAU ****** DAS_SE RY1: RY2:	MOV CLR RET ROUTINE ROUTINE NICATIC L CLCCK GH. THI JOPMENT SETB SETB CLR JNB CLR JNB CLR JNB CLR JNB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST: SDAS_SLCT R_EN R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE,TRY1 R_DONE R_DONE R_DONE,TRY2 R_DONE R_DONE,TRY3</pre>	<pre>;STORE THE LAST DATA EYTE ;DISABLE DATA RECEIVE CYCLES SSERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILLE ITS CHIP SELECT ED AT THE START OF THE PROGRAM DURING CODE EAD OR WRITE CYCLE MUST BE INTERRUPTED T. </pre>	TL/H/11879–96
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THIS COMMU SERIA IS HI DEVEL BECAU ****** DAS_SE RY1: RY2:	MOV CLR RET ROUTINE ROUTINE NICATIC L CLCCK GH. THI JOPMENT SETB SETB CLR JNB CLR JNB CLR JNB CLR JNB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST: SDAS_SLCT R_EN R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE,TRY1 R_DONE R_DONE R_DONE,TRY2 R_DONE R_DONE,TRY3</pre>	<pre>;STORE THE LAST DATA EYTE ;DISABLE DATA RECEIVE CYCLES :S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILLE ITS CHIP SELECT DD AT THE START OF THE PROGRAM DURING CODE ELAD OR WRITE CYCLE MUST BE INTERRUPTED T. </pre>	TL/H/11879–96
THIS COMMU SERIA IS HI DEVEL BECAU ****** DAS_SE RY1: RY2:	MOV CLR RET ROUTINE ROUTINE NICATIC L CLCCK GH. THI JOPMENT SETB SETB CLR JNB CLR JNB CLR JNB CLR JNB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST: SDAS_SLCT R_EN R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE,TRY1 R_DONE R_DONE R_DONE,TRY2 R_DONE R_DONE,TRY3</pre>	<pre>;STORE THE LAST DATA EYTE ;DISABLE DATA RECEIVE CYCLES :S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILLE ITS CHIP SELECT DD AT THE START OF THE PROGRAM DURING CODE ELAD OR WRITE CYCLE MUST BE INTERRUPTED T. </pre>	TL/H/11879–96
THIS COMMU SERIA IS HI DEVEL BECAU SDAS_SE CRY1: CRY1:	MOV CLR RET ROUTINE ROUTINE NICATIC L CLCCK GH. THI JOPMENT SETB SETB CLR JNB CLR JNB CLR JNB CLR JNB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST: SDAS_SLCT R_EN R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE,TRY1 R_DONE R_DONE R_DONE,TRY2 R_DONE R_DONE,TRY3</pre>	<pre>;STORE THE LAST DATA EYTE ;DISABLE DATA RECEIVE CYCLES :S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILLE ITS CHIP SELECT DD AT THE START OF THE PROGRAM DURING CODE ELAD OR WRITE CYCLE MUST BE INTERRUPTED T. </pre>	TL/H/11879–96
THIS COMMU SERIA IS HI DEVEL BECAU	MOV CLR RET ROUTINE ROUTINE NICATIC L CLCCK GH. THI JOPMENT SETB SETB CLR JNB CLR JNB CLR JNB CLR JNB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST: SDAS_SLCT R_EN R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE,TRY1 R_DONE R_DONE R_DONE,TRY2 R_DONE R_DONE,TRY3</pre>	<pre>;STORE THE LAST DATA EYTE ;DISABLE DATA RECEIVE CYCLES :S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILLE ITS CHIP SELECT DD AT THE START OF THE PROGRAM DURING CODE ELAD OR WRITE CYCLE MUST BE INTERRUPTED T. </pre>	TL/H/11879–96
THIS COMMU SERIA IS HI DEVEL BECAU SDAS_SE CRY1: CRY1:	MOV CLR RET ROUTINE ROUTINE NICATIC L CLCCK GH. THI JOPMENT SETB SETB CLR JNB CLR JNB CLR JNB CLR JNB CLR	<pre>@R0,SBUF R_EN INITIALIZES THE SDA N CYCLE HAS BEEN INT PULSES TO THE DAS W S ROUTINE CAN BE USE OR ANYWHERE THAT A R HE SYSTEM REQUIREMEN RST: SDAS_SLCT R_EN R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE R_DONE,TRY1 R_DONE R_DONE R_DONE,TRY2 R_DONE R_DONE,TRY3</pre>	<pre>;STORE THE LAST DATA EYTE ;DISABLE DATA RECEIVE CYCLES :S SERIAL INTERFACE IN CASE THAT A ERRUPTED. THIS ROUTINE APPLYS 24 HILLE ITS CHIP SELECT DD AT THE START OF THE PROGRAM DURING CODE ELAD OR WRITE CYCLE MUST BE INTERRUPTED T. </pre>	TL/H/11879–96

7.3 TMS320 INTERFACE MODE

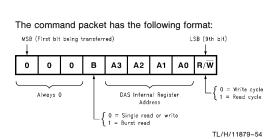
The TMS320 interface mode is designed to work directly with the serial interface port of the TMS320C3x and TMS320C5x families of digital signal processors. This interface uses five lines: two data lines (DX DR) two frame synchronization signal lines (FSX, FSR), and a serial clock line (SCLK). Note that the TMS320C3x/5x serial interface has two separate serial clock lines for transmit and receive called CLKX and CLKR, but the LM12434 and LM12{L}438 only uses one clock input for both receive and transmit. Typically, CLKX is specified as an output and drives SCLK as well as CLKR (defined as an input). The serial clock for this interface mode is a free running clock, with the data stream synchronized by SCLK. The start of each data transfer (the beginning of a data packet) is synchronized by FSX (Transmit Frame Sync) or FSR (Receive Frame Sync). This interface can communicate with one device; no device select signal is used. The following discussion assumes that the reader has a basic knowledge of the architecture and operation of the TMS320C3x/5x serial interface port.

The TMS320 interface mode is selected when the MODESEL1 and MODESEL2 pins have the logic state of "11". *Figure 16* shows a typical connection diagram for the LM12434 and LM12{L}438 in the TMS320 serial interface mode. The FSR, FSX, DX, DR, and SCLK lines are assigned to interface pins P1 through P5.

Data transfer in this mode is programmable by the processor for 8-, 16-, 24-, or 32-bit data packets for the TMS320C3x and 8-, or 16-bit data packets for TMS320C5x. The LM12434 and LM12(L)438 uses 16-bit and 32-bit data packets. For the TMS320C5x the 32-bit packet is composed of two successive 16-bit packets with no gaps between them. The data bits in each packet are transferred MSB first, and are shifted in on the rising edge of SCLK and are stable and captured at the falling edge of the SCLK. As with the "Standard" and "8051" interface modes, the LM12434 and LM12{L}438 has three different communication cycles: write cycle, read cycle and burst read cycle. At the start of each data transfer cycle, a stream of 9 data bits (the "command packet") is written to the LM12434 and LM12{L}438 and informs it about the communication cycle. The placement of these 9 bits in the data packet is different in the read and write cycles and is discussed for each case separately. The command packet carries the following information:

what type of data transfer (communication cycle) is started

which device register is to be accessed

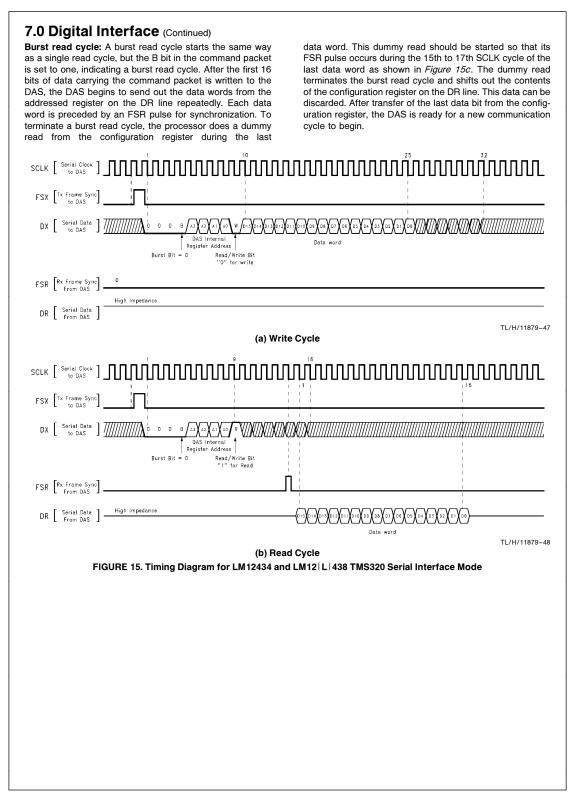


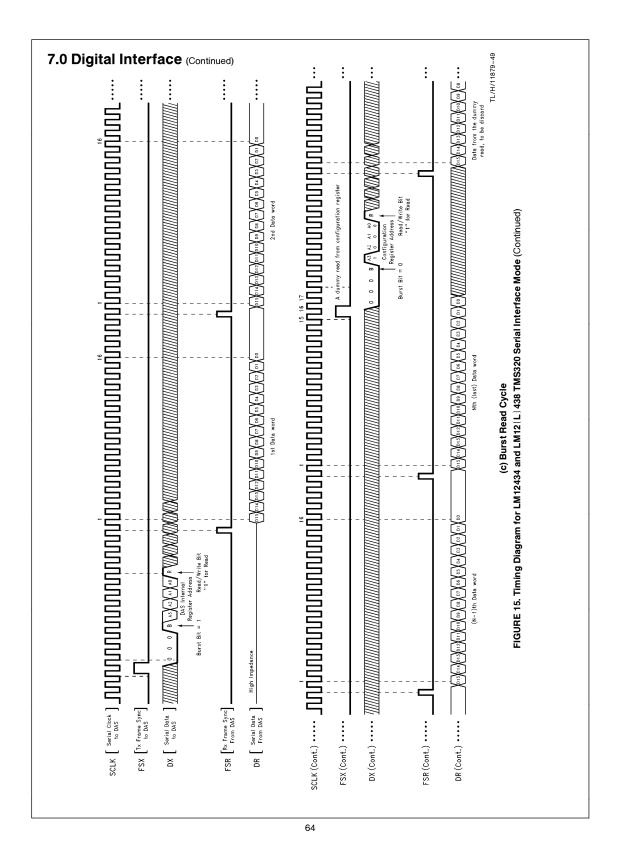
The first bit of the command packet is always the MSB of the data packet to to be transferred.

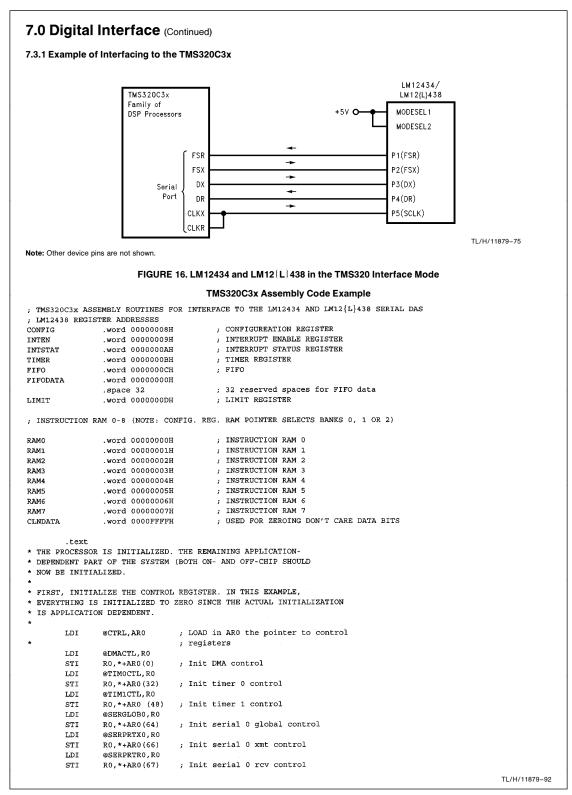
Figure 15 shows the timing diagrams for the three communication cycles. *Figure 15a* shows a write cycle. *Figure 15b* shows a read cycle, and *Figure 15c* shows a burst read cycle. Note that these timing diagrams depict general relationships between the SCLK edges, the data bits and the frame synchronization signals (FSX, FSR). These diagrams are not meant to show guaranteed timing performance. (See specification tables for parametric switching characteristics.)

Write cycle: A write cycle begins with an FSX pulse from the processor. The first data bit is received by the DAS on the DX line during the next SCLK falling edge after the falling edge of FSX. A 32-bit data packet is written to the DAS. The TMS320C3x does this with a 32-bit transfer, using its serial port 32-bit register. With the TMS320C5x family two successive 16-bit transfers are initiated without any gap in between. The first 9 bits (MSBs) of the data are the command packet with the R/W bit and B bit equal to zero. Following the command packet, a 16-bit data stream starts on the falling edge of the 10th SCLK cycle and continues through the 25th cycle. The last 7 bits in the 32-bit data packet are "don't care" and are ignored by the DAS. The data is written to the register addressed in the command packet (A3, A2, A1, A0). There is no activity on the FSR and DR lines during a write cycle. The write cycle is completed after the last data bit is transferred.

Read cycle: A read cycle also begins with an FSX pulse from the processor. The read cycle uses 16-bit data transfer. Following the FSX pulse, 16 bits of data are written to the DAS on the DX line. The first 9 bits (MSBs) of data are the command packet with the R/\overline{W} bit equal to one and the B bit equal to zero. The last 7 bits (LSBs) are "don't care" and are ignored by the DAS. About 3 to 4 CLK (the DAS main clock input, not the SCLK) cycles after the R/\overline{W} bit is received, the DAS generates an FSR pulse to initiate the data transfer. Following the FSR pulse, the DAS will send 16 bits of data to the processor on the DR line on the next SCLK cycle following the FSR pulse. The data is read from the register addressed in the command packet. The read cycle is completed after the last data bit is transferred.







			TMS320C3x Assembly Code Example (Continued)	
			Interesting out Example (continued)	
	LDI	@SERTIM0,R0		
	STI	R0,*+AR0(68)	; Init serial 0 timer control	
	LDI	@SERGLOB1,R0		
	STI	R0,*+AR0(80)	; Init serial 1 global control	
	LDI	@SERPRTX1,R0		
	STI	R0,*+AR0(82)	; Init serial 1 xmt control	
	LDI	@SERPRTR1,R0		
	STI	R0,*+AR0(83)	; Init serial 1 rcv control	
	LDI	@SERTIM1,R0		
	STI	R0,*+AR0(84)	; Init serial 1 timer control	
	LDI	@STIMCNT1,R0		
	STI	R0,*+AR0(85)	; Init serial 1 timer counter	
	LDI	@STIMPRD1,R0		
	STI	R0,*+AR0(86)	; Init serial 1 timer period	
	LDI	@PARINT, RO		
	STI	R0,*+AR0(100)	; Init parallel interface control (c30 only)	
	LDI	@IOINT, RO		
	STI	R0,*+AR0(96)	; Init I/O interface control	
		10, 1110(50)	,	
	LDI	@STCK, SP	; Initialize the stack pointer	
	OR	2000H,ST	; Global interrupt enable	
	OR	200011,01	, Grobur incorrupt chabic	
	BR	BEGIN	; Branch to the beginning of application.	
EGIN	NOP	55510	, so one segamany on application.	
-911	LDI	0,IOF	; PROGRAM XF1 PORT AS AN INPUT PORT	
	LDI	@CTRL, AR0	; LOAD in ARO the pointer to control	
	LDI		, how in five the pointer to control	
	LDI	@CONFIG,R0 0082H,R1	; SYNC. PIN OUTPUT	
	CALL	SWRITE	; SOFT RESET LM12438	
	CALL	SWRITE	, SOFI RESEI LMIZ450	
	LDI	@INTEN,RO		
			; 32 CONVERSIONS	
	LDI	0714H,R1		
	LDI	0C714H,R1	; 24 CONVERSIONS	
	CALL	SWRITE	; INIT. INTERRUPT ENABLE REG.	
	LDI	@TIMER,RO		
	LDI	OAAAAH,R1	TOND COME VALUE IN BIND	
	CALL	SWRITE	; LOAD SOME VALUE IN TIMER	
		073W0 D0		
	LDI	@RAMO,RO	; INSTRUCTIONS FOR 8 CONVERSION	
	LDI	0000H,R1	; ON EACH CHANNEL (0-7) ALL SINGLE ENDED	
	CALL	SWRITE	; SET RAMO	
	LDI	@RAM1,R0		
	LDI	0004H,R1		
	CALL	SWRITE	; SET RAM1	
	LDI	@RAM2,R0		
	LDI	0008H,R1		
	CALL	SWRITE	; SET RAM2	
	LDI	@RAM3,R0		
	LDI	000CH, R1		
	CALL	SWRITE	; SET RAM3	
	LDI	@RAM4,R0		
	LDI	0010H,R1		
	CALL	SWRITE	; SET RAM4	
			,	
	LDI	@RAM5,R0		
	LDI	0014H,R1	CET DAME	
	CALL	SWRITE	; SET RAM5	
	LDI	@RAM6,R0		
	LDI	0018H,R1	OF DAVE	
	CALL	SWRITE	; SET RAM6	
	LDI	@RAM7,R0		
	LDI	001CH,R1		
	CALL	SWRITE	; SET RAM7	
	LDI	@CONFIG,R0	; START FULL CALIBRATION	
	LDI	0088H,R1	; SYNC. PIN OUTPUT	
	CALL	SWRITE		
				TL/H/11879-9

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	•		TMS320C3x Assembly Code Example (Continued)	
HKINTI	TSTB	80H, IOF	; TEST XF1 INPUT CONNECTED TO LM12438'S INTERRUPT	
	BNZ	CHKINTI	; FOR COMPLETION OF FULL CALIBRATION	
	LDI	@INTSTAT,R0		
	CALL	SREAD	; READ INTERRUPT STATUS REG.	
DOAGAIN		@CONFIG,R0	; IF FULL CALIBRATION IS DONE SET THE START BIT	
	LDI CALL	0081H,R1 SWRITE	; OF LM12438 CONFIG. REG. (SYNC. PIN OUTPUT) ; START LM12438 SEQUENCER	
CHKINT2	TSTB BNZ	80H, IOF CHKINT2	; TEST XFI INPUT CONNECTED TO IM12438'S INTERRUPT ; (COMPLETION OF 24 FIFO CONVERSIONS)	
	LDI	@CONFIG,R0		
	LDI	0080H,R1	; STOP THE CONVERSION (IS NOT NECESSARY)	
	CALL LDI	SWRITE @INTSTAT,R0		
	CALL	SREAD	; READ INTERRUPT STATUS REG.	
	LDI	32,R4		
LOOP	LDI	R4,R1		
	LDI CALL	@FIFO,R0 BREAD	; READ FIFO	
	SUBB	1,R4		
	BNZ	FLOOP		
	LDI LDI	@CONFIG,R0 0002H,R1	; RESET LM12438 (SYNC. PIN OUTPUT)	
	CALL	SWRITE	; RESEI EMIZASS (SINC. FIN COIPOI)	
	BR	DOAGAIN		
	IDLE			
; LM124	38 BURS	T READ ROUTINE TH	ROUGH SERIAL PORT1	
BREAD	PUSH	ST	; SAVE STATUS REG.	
	PUSH	AR0	; SAVE ARO	
	PUSH	AR1	; SAVE AR1	
	PUSH PUSH	AR2 R0	; SAVE AR2 ; SAVE RO	
	PUSH	R1	; SAVE R1	
	PUSH	R2	; SAVE R2	
	PUSH PUSH	R3 R4	; SAVE R3 ; SAVE R4	
	LDI LDI		; LOAD in ARO the pointer to control ; USE AR2 AS POINTER TO FIFO DATA	
	LDI	@SERGLOB1R, R2	; PREPARE FOR 16 BIT TRANSMIT	
	CMPI	0,R1	; IF COUNTER IS 0 (USER'S ERROR)	
	BZ	BDONE2	; TERMINATE NOW BLSE CONTINUE	
	CMPI	1,R1	; IF A SINGLE READ REQUIRED THEN	
	BZ BR	SINGLE MLTIPLE	; CALL THE SINGLE READ SUBROUTINE ; ELSE GO ON	
SINGLE	LDŤ	@FIFO,R0	; FOR SINGLE READ FIFO ADDRESS IS	
	CALL	SREAD	; CALLING SINGLE READ ROUTINE	
	STI BR	R1,*AR2++(1) BDONE2	; STORE READ DATA INTO FIFODATA ; TERMINATE	
ALTIPLE	TUT	13,R4	; SET UP R4 AS THE DELAY COUNTER	
10111105	LDI	@SERGLOB1R, R2	; PREPARE FOR 16 BIT TRANSMIT	
	STI	R2,*+AR0(80)	; Init serial 1 global control	
	RPTS	7	; POSITION THE ADDRESS	
	ROL	RO	; TO START AT BIT #10	
	OR LDI	1080H,R0 R0,R3	; SET THE READ BIT ; RO IS FREED FOR LAST READ	
	LDI	@CONFIG,R0	; PREPARE FOR A LAST CONFIG REG. READ	
	RPTS ROL	7 R0	; WHICH WILL STOP LM12438 FROM GENERATING ; FURTHER BURST READS	
	OR	80H,R0	; SET THE READ BIT	TI (11/4/000 0 0)
				TL/H/11879-94

			TMS320C3x Assembly Code Example (Continued)	
	0.007	P2 + 3P2 (22)		
	STI	R3,*+AR0(88)	; Init serial 1 data xmt register	
	RPTS	2H	; PROVIDE DELAY FOR UPDATE OF	
	NOP		; XSREMPTY BIT IN GLOB CONT REG.	
	LDI	1000B,R3		
	TSTB	*+AR0(80),R3	; CHECK SER. 1 CONTROL XSREMPTY	
	BNZ	CHKR2	; IF XSREMPTY=1 THEN KEEP CHECKING	
COUNT	NOP			
	SUBB	1,R1	; DECREMENT COUNTER (R1) AND CHECK FOR ZERO	
	LDI	1,R3	; PREPARE R3 FOR CHECKING RRDY BIT	
RCONT3		*+AR0(80),R3 RCONT3	TE DEDY-0 THEN CHECK ACAIN	
	BZ	KCON15	; IF RRDY=0 THEN CHECK AGAIN	
DONE2	LDI	*+AR0(92),R3	; LOAD DRR (RECEIVED DATA), RRDY IS CLEARED	
	AND	OFFFFH,R3	; CLEAN UP THE UPPER BITS	
	STI	R3,*AR2++(1)	; PLACE READ DATA IN FIFODATA	
	CMPI	1,R1	; IF COUNTER=1 THEN TERMINATE	
	BNZ	COUNT	; ELSE CONTINUE	
	DDCC		WATE BOD THE LOTH CLOCK DICE	
BSTDONE	RPTS NOP	R4	; WAIT FOR THE 16TH CLOCK RISE ; BEFORE SENDING THE TERMINATING	
	MOF		; READ FROM CONFIG. REG	
	STI	R0,*+AR0(88)	; XMT FOR LAST READ FROM CONFIG REG	
CONT4			; READ SER. 1 CONTROL REGISTER TO	
	TSTB		; CHECK FOR RRDY BIT	
	BZ	RCONT4	; IF RRDY IS 1, EXIT THE BURST ROUTINE	
CONT5		*+AR0(92),R3		
	AND STI		; CLEAN UP THE UPPER BITS ; PLACE IT IN FIFODATA	
	911	, ANGTT(1)	, LAND, II IN EILOPAIN	
RCONT6		*+AR0(80),R3	; READ SER. 1 CONTROL REGISTER TO	
	TSTB	0001B,R3	CHECK FOR RRDY BIT	
	ΒZ	RCONT6		
DONE2	LDI	*+AR0(92),R3	; READ THE DRR (CLEAR RRDY BIT)	
	POP	R4	; RESTORE R4	
	POP	R3	; RESTORE R3	
	POP	R2	; RESTORE R2	
	POP	R1	; RESTORE R1	
	POP	RO	; RESTORE RO	
	POP	AR2	; RESTORE AR2	
	POP	AR1	; RESTORE AR1	
	POP	AR0	; RESTORE ARO	
	POP	ST	; RESTORE ST	
	RETS			
				TL/H/11879-9

SREAD		Interface (C	TMS320C3x Assembly Code Example (Continued)	
SREAD	O CINCI	E DEAD DOUTINE	THEOLOGICAL ACCOUNTY COULD EXAMPLE (COMMINSO)	
	PUSH	ST	; SAVE STATUS REG.	
	PUSH	ARO	; SAVE ARO	
	PUSH	RO	; SAVE R0 THE READ ADDRESS	
	PUSH	R2	; SAVE R2	
	LDI	@CTRL,AR0	; LOAD in ARO the pointer to control	
	LDI		; PREPARE FOR 16 BIT TRANSMIT	
			; AND 16 BIT RECIEVE	
	STI	R2,*+AR0(80)	; Init serial 1 global control	
	RPTS	7	; POSITION THE ADDRESS	
	ROL	RO	; TO START AT BIT #10	
	OR	80H,R0	; SET THE READ BIT	
	STI		; Init serial 1 data xmt register	
	RPTS	2H	; PROVIDE DELAY FOR UPDATE OF	
	NOP	*·300/00) D0	; XSREMPTY BIT IN GLOB CONT REG.	
	LDI TSTB	*+AR0(80),R0	; READ SER. 1 CONTROL XSREMPTY	
	TSTB BNZ	1000B,R0 CHKR1	; CHECK ; IF IT IS CLEAR (TRANSMIT COMPLETE) CONTINUE	
	BNZ	CHKRI	, IF II IS CHEAR (IRANSMII COMPLETE, CONTINUE	
CONT1	LDI	*+AR0(80),R0	; READ SER. 1 CONTROL	
	TSTB	0001B,R0	; CHEK RRDY BIT	
	BZ	RCONT1	; IF RRDY IS 1 (RECEIVE COMPLETE) CONTINUE	
DONE1		*+AR0(92),R1	; LOAD DRR (RECEIVED DATA) INTO R1	
	AND	OFFFFH,R1	; CLEAN UP UPPER BITS	
	POP	R2	; RESTORE R2	
	POP	RO	; RESTORE R0 THE READ ADDRESS	
	POP	ARO	; RESTORE ARO	
	POP	ST	; RESTORE ST	
	RETS WRITE	ROUTINE THROUGH	CEDIAL DOPTI	
WRITE		ST	; SAVE STATUS REG.	
	PUSH	ARO	; SAVE ARO	
	PUSH	R2	; SAVE R2	
	LDI	@CTRL, AR0	; LOAD in ARO the pointer to control	
	LDI	@SERGLOB1W, R2		
	STI	R2,*+AR0(80)	; Init serial 1 global control	
	AND	@CLNDATA,R1	; CLEAN UP UNUSED ADD. BITS	
	RPTS	23	; POSITION THE ADDRESS TO START AT BIT #27	
	ROL	RO	;	
	RPTS	6	; POSITION DATA TO START AT BIT #22	
	ROL	R1	;	
	OR	R1,R0	;	
	STI	R0,*+AR0(88)	; Init serial 1 data xmt register	
	RPTS	2H	; PROVIDE DELAY FOR UPDATE OF	
	NOP	+ . 3 DO (00) DO	; XSREMPTY BIT IN GLOB CONT REG.	
	LDI	*+AR0(80),R0	; READ SER. 1 CONTROL XSREMPTY	
	TSTB BNZ	1000B,R0 CHK1	; CHECK ; IF IT IS CLEAR (TRANSMIT COMPLETE) CONTINUE	
	BNZ	CHKI	, IF II IS CHERK (INNIMIT COMPLETE) CONTINUE	
		R2	; RESTORE R2	
	POP			
DONE1	POP POP	AR0	; RESTORE AR0	
IDONE1		ARO ST	; RESTORE ARO ; RESTORE ST	
VDONE1	POP			TL/H/11879–97

7.4 I²C BUS INTERFACE

The I²C bus is a serial synchronous bus structure. It is a multi-master bus, which means that more than one device capable of controlling the bus can be connected to it. The bus uses 2 wires, serial data (SDA) and serial clock (SCL), to carry information between the devices connected to the bus. Both data and clock lines are bidirectional and are connected to the positive power supply via a pull-up resistor. Each device is identified by a unique address, whether it is a microprocessor/controller or a peripheral such as memory, keyboard, data-converter or display. Each device can operate as either transmitter or receiver, depending on the function of the device. In addition to transmitters and receivers, devices can also be considered as masters and slaves when performing data transfer. A master is the device that initiates a data transfer on the bus and generates the clock signals to permit that transfer. At that time, any device addressed is considered slave. It should be apparent that the I²C bus is not merely an interconnecting wire, it embodies comprehensive formats and procedures for addressing, transfer cycles start and stop, clock generation/synchronization and bus arbitration. The following discussion assumes that the reader is familiar with the specification and architecture of the I²C bus.

The LM12434 and LM12{L}438's I²C bus interface is selected when the MODESEL1 and MODESEL2 pins have the logic state of "10". Figure 18 shows a typical connection diagram for the LM12434 and LM12{L}438 to the I²C bus. As was mentioned, communication on the I²C bus is performed on 2 lines. SCL (serial clock) and SDA (serial data): pins P5 and P4 are assigned to these lines. The DAS operates as a slave on the I²C bus. As a result, the SCL line is an input (no clock is generated by the LM12434 and LM12{L}438) and the SDA line is a bi-directional serial data path. According to I²C bus specifications, the DAS has a 7-bit slave address. The four most significant bits of the slave address are hard wired inside the LM12434 and LM12{L}438 and are "0101". The three least significant bits of the address are assigned to pins P3-P1. Therefore, the LM12434 and LM12{L}438 I²C slave address is:



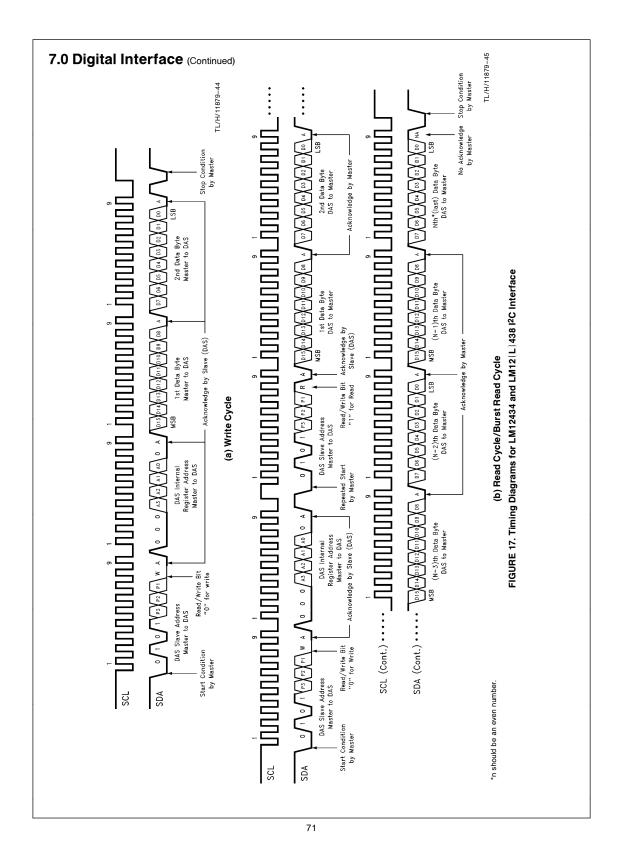
Tying the P3-P1 pins to different logic levels allows up to eight LM12434 and LM12{L}438's to be addressed on a single I²C bus.

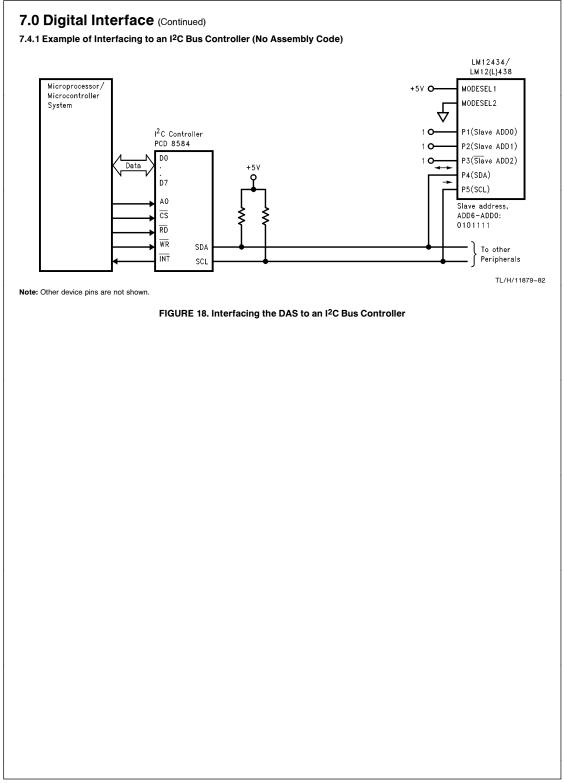
Figure 17 shows the timing diagram for the read and write cycles for the LM12434 and LM12{L}438's I²C interface.

This timing diagram depicts the general relationship between the serial clock edges and the data bits. It is not meant to show guaranteed timing performance. (See specification tables for parametric switching characteristics.) The DAS's I²C interface timing parameters fully meet or exceed the I²C bus specification. Data transfer on the I²C bus is byte oriented and the 16-bit data to be written to or read from each register is transferred in two bytes.

Write cycle: A write cycle is illustrated in Figure 17a. Communication is initiated with a start condition generated by a master (I²C bus specification), followed by a byte of the DAS's slave address with the read/write bit (8th bit) being "0", indicating a write cycle will follow. At the 9th SCL clock pulse of the first data packet, the DAS pulls the SDA line low ("0") to acknowledge that it has been addressed. The next byte is the address of the DAS register to be accessed. The format of this byte is three "0's" (MSBs) followed by four bits of register address (MSB first as shown) and a "0" as the last bit (LSB). After the DAS acknowledges the address byte, the 16-bit data proceeds in two bytes, beginning with the high order byte (MSB first). The direction of the data in a write cycle is from master to DAS with acknowledgement given by the DAS at the end of each byte. The cycle is completed by a stop condition generated by the master.

Read/burst read cycle: The read and burst read cycles for the I²C interface are combined in a single format. A read cycle is shown in Figure 17b. A read cycle starts the same as a write with a slave address byte for write followed by a register address byte. After the register address byte is written to the DAS, the bus should be released without any stop condition. The master then applies a repeat start condition followed by the DAS's slave address, but with the read/ write bit being "1", indicating a read request from the master. The DAS (slave) acknowledges its address and beginning with the next byte, the direction of the data will be from DAS to master. The DAS starts to transmit the contents of its register (addressed previously at second byte of the cycle) synchronized with the clocks applied by the master. An even number of data bytes should be read from the DAS (two bytes per register). At the end of each byte received from the DAS the bus master generates an acknowledge. The DAS continues to repeat transmitting its register contents as long as the master is transmitting clocks and acknowledges at the end of each byte. The DAS recognizes the end of the transfer whenever the master does not acknowledge at the end of an even numbered byte. At this point, the master should generate a stop condition as required by the I²C bus specification. Notice that the master may read only one word (single read) or as many words (two bytes each) as it needs using the read procedure.





8.0 Analog Considerations

8.1 REFERENCE VOLTAGE

The difference between the voltages applied to the V_{REF} + and V_{REF} - is the analog input voltage span (the difference between the voltages applied across two multiplexer inputs or the voltage applied to one of the multiplexer inputs and analog ground, over which 4095 positive and 4096 negative codes exist). The voltage sources driving V_{REF} + or V_{REF} - must have very low output impedance and noise. The circuit in *Figure 19* is an example of a very stable reference appropriate for use with the LM12434 and LM12{L}438.

The ADC can be used in either ratiometric or absolute reference applications. In ratiometric systems, the analog input voltage is proportional to the voltage used for the ADC's reference voltage. When this voltage is the system power supply, the V_{REF+} pin is connected to V_A⁺ and V_{REF-} is connected to GND. This technique relaxes the system reference stability requirements because the analog input voltage and the ADC reference voltage move together. This maintains the same output code for given input conditions.

For absolute accuracy, where the analog input voltage varies between very specific voltage limits, a time and temperature stable voltage source can be connected to the reference inputs. Typically, the reference voltage's magnitude will require an initial adjustment to null reference voltage induced full-scale errors.

8.2 INPUT RANGE

The LM12434 and LM12{L}438's fully differential ADC and reference voltage inputs generate a two's-complement output that is found by using the equation below.

output code =
$$\frac{V_{IN+} - V_{IN-}}{V_{REF+} - V_{REF-}}$$
 (4096) - $\frac{1}{2}$ (12-bit)

output code =
$$\frac{V_{IN+} - V_{IN-}}{V_{REF+} - V_{REF-}}$$
 (256) - $\frac{1}{2}$ (8-bit)

Round up to the next integer value between -4096 to 4095 for 12-bit resolution and between -256 to 255 for 8-bit resolution if the result of the above equation is not a whole number. As an example, $V_{REF+}=2.5V, \ V_{REF-}=1V, \ V_{IN+}=1.5V$ and $V_{IN-}=GND$. The 12-bit + sign output code is positive full-scale, or 0,1111,1111,1111. If $V_{REF+}=5V, \ V_{REF-}=1V, \ V_{IN+}=3V$, and $V_{IN-}=GND$, the 12-bit + sign output code is 0,1100,0000,0000.

8.3 INPUT CURRENT

A charging current flows into or out of (depending on the input voltage polarity) the analog input pins, |N0-|N7 at the start of the analog input acquisition time (t_{ACQ}). This current's peak value will depend on the actual input voltage applied.

8.4 INPUT SOURCE RESISTANCE

For low impedance voltage sources (<60 Ω for 8 MHz operation), the input charging current will decay, before the end of the S/H's acquisition time, to a value that will not introduce any conversion errors. For higher source impedances, the S/H's acquisition time can be increased. As an example, operating with a 8 MHz clock frequency and maximum acquisition time, the LM12434 and LM12438's analog inputs can handle source impedances as high as 4.17 k Ω . Refer to Section 6.2.1, Instruction RAM "00", Bits 12–15 for further information.

8.5 INPUT BYPASS CAPACITANCE

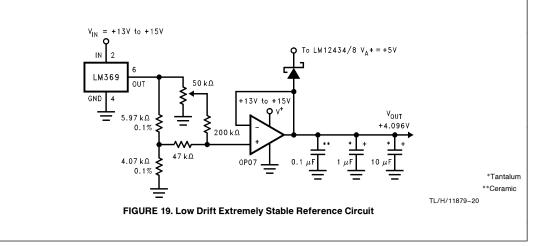
External capacitors (0.01 μF –0.1 μF) can be connected between the analog input pins, IN0–IN7, and analog ground to filter any noise caused by inductive pickup associated with long input leads. These capacitors will not degrade the conversion accuracy.

8.6 INPUT NOISE

The leads to each of the analog multiplexer input pins should be kept as short as possible. This will minimize input noise and clock frequency coupling that can cause conversion errors. Input filtering can be used to reduce the effects of the noise sources.

8.7 POWER SUPPLY CONSIDERATIONS

Decoupling and bypassing the power supply on a high resolution ADC is an important design task. Noise spikes on the V_A+ (analog supply) or V_D+ (digital supply) can cause conversion errors. The analog comparator used in the ADC will respond to power supply noise and will make erroneous conversion decisions. The DAS is especially sensitive to power supply spikes that occur during the auto-zero or linearity calibration cycles.



8.0 Analog Considerations (Continued)

The LM12434/8 is designed to operate from a single +5V power supply. The LM12{L}438 is designed to operate from a single +3.3V supply. The separate supply and ground pins for the analog and digital portions of the circuit allow separate external bypassing. To minimize power supply noise and ripple adequate bypass capacitors should be placed directly between power supply pins and their associated grounds. Both supply pins are generally connected to the same supply source. In systems with separate analog and digital supplies, the DAS should be powered from the analog supply. At least a 10 µF tantalum electrolytic capacitor in parallel with a 0.1 μ F monolithic ceramic capacitor is recommended for bypassing each power supply. The key consideration for these capacitors is to have the low series resistance and inductance. The capacitors should be placed as close as physically possible to the supply and ground pins with the smaller capacitor closer to the device. The capacitors also should have the shortest possible leads in order to minimize series lead inductance. Surface mount chip capacitors are optimal in this respect and should be used when possible.

When the power supply regulator is not local on the board, adequate bypassing (a high value electrolytic capacitor) should be placed at the power entry point. The value of the capacitor depends on the total supply current of the circuits on the PC board. All supply currents should be supplied by the capacitor instead of being drawn from the external supply lines, while the external supply charges the capacitor at a steady rate.

The DAS has two V_D+ and DGND pins on two sides of its package. It is recommended to use a 0.1 μ F plus a 10 μ F capacitor between pins 15 and 16 (V_D+) and 14 (DGND) and a 0.1 μ F capacitor between pins 28 (V_D+) and 1 (DGND) for the PLCC package. The respective pins for the SO package are 21 and 22 (V_D+) and 20 (DGND), 6 (V_D+) and 7 (DGND). The layout diagrams in Section 8.8 show the recommended placement for the supply bypass capacitors.

8.8 PC BOARD LAYOUT AND GROUNDING CONSIDERATIONS

To get the best possible performance from the LM12434 and LM12{L}438, the printed circuit boards should have separate analog and digital ground planes. The reason for using two ground planes is to prevent digital and analog ground currents from sharing the same path until they reach a very low impedance power supply point. This will prevent noisy digital switching currents from being injected into the analog ground.

Figure 20 illustrates a favorable layout for ground planes, power supply and reference input bypass capacitors. *Figure 20a* shows a layout using a 28-pin PLCC socket and through-hole assembly. *Figure 20b* shows a surface mount layout for the same 28-pin PLCC package. A similar approach should be used for the SO package.

The analog ground plane should encompass the area under the analog pins and any other analog components such as the reference circuit, input amplifiers, signal conditioning circuits, and analog signal traces.

The digital ground plane should encompass the area under the digital circuits and the digital input/output pins of the DAS. Having a continuous digital ground plane under the data and clock traces is very important. This reduces the overshoot/undershoot and high frequency ringing on these lines that can be capacitively coupled to analog circuitry sections through stray capacitances.

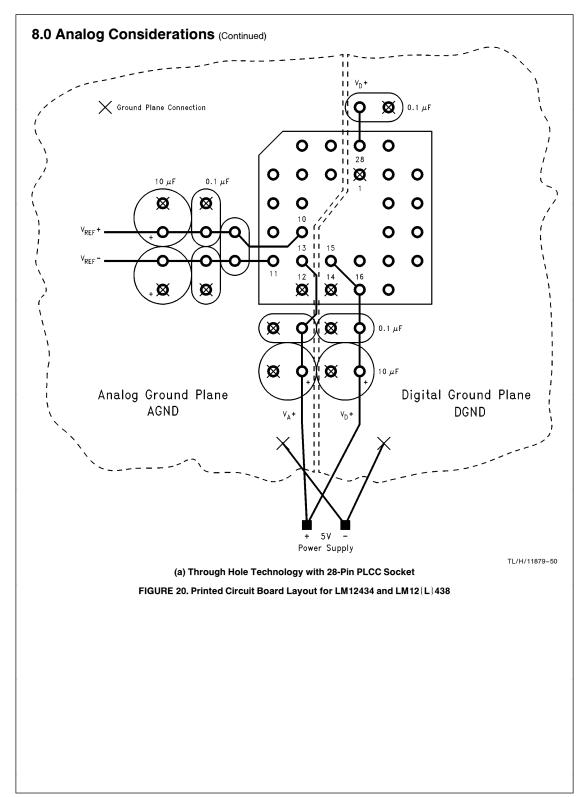
The AGND and DGND in the LM12434 and LM12{L}438 are not internally connected together. They should be connected together on the PC board right at the chip. This will provide the shortest return path for the signals being exchanged between the internal analog and digital sections of the DAS.

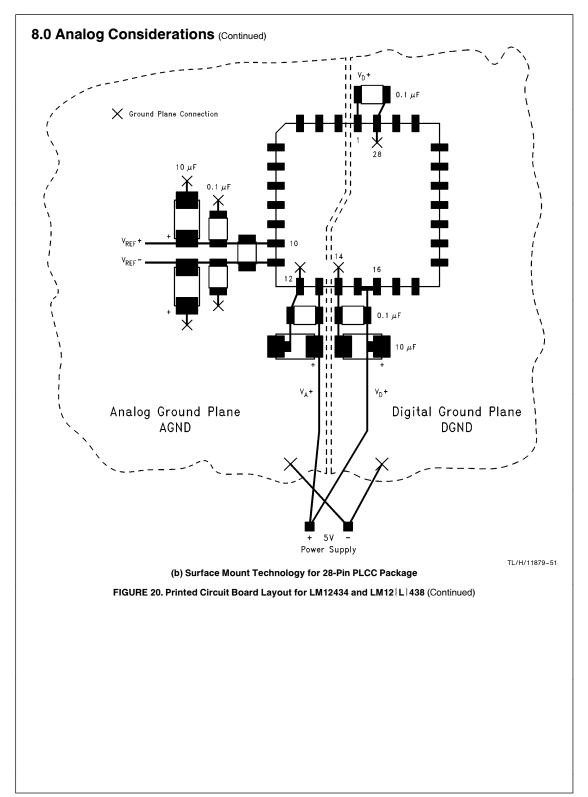
It is also a good design practice to have power plane layers in the PC board. This will improve the supply bypassing (an effective distributed capacitance between power and ground plane layers) and voltage drops on the supply lines. However, power planes are not essential as ground planes are for the performance of the DAS. If power planes are used, they should be separated into two planes and the area and connections should follow the same guidelines as mentioned for the ground planes. Each power plane should be laid out over its associated ground planes, avoiding any overlap between power and ground planes of different types. When the power planes are not used, it is recommended to use separate supply traces for the $V_{\mbox{\scriptsize A}}+$ and V_D+ pins from a low impedance supply point (the regulator output or the power entry point to the PC board). This will help ensure that the noisy digital supply does not corrupt the analog supply.

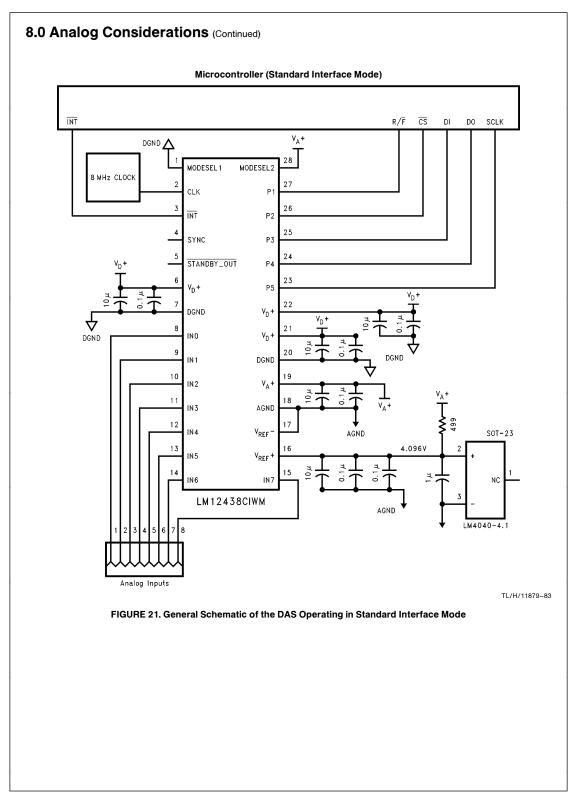
When measuring AC input signals with the DAS, any cross-talk between analog input/output lines and the reference lines (IN0–IN7, MUXOUT \pm , S/H IN \pm , V_{REF} \pm) should be minimized. Cross talk is minimized by reducing any stray capacitance between the lines. This can be done by increasing the clearance between traces, keeping the traces as short as possible, shielding traces from each other by placing them on different sides of the AGND plane, or running AGND traces between them.

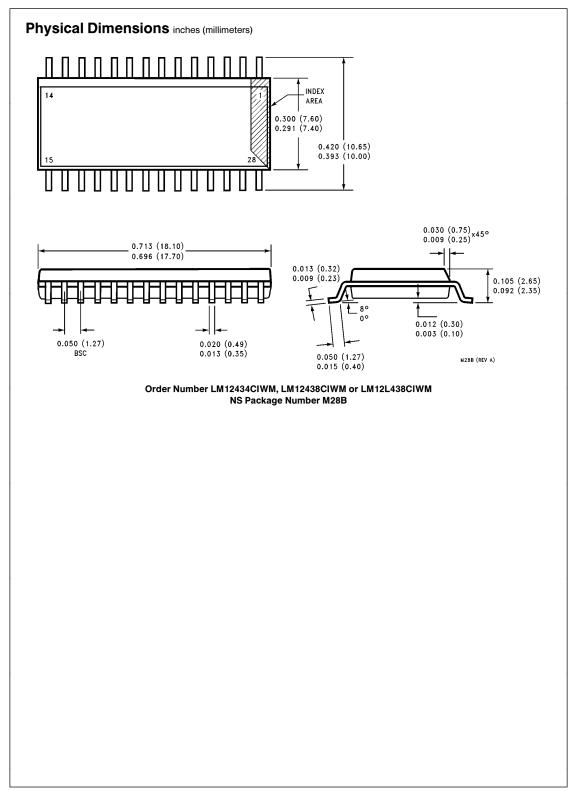
Figure 20 also shows the reference input bypass capacitors. Here the reference inputs are considered to be differential. The performance of the DAS improves by having a 0.1 μF capacitor between the V_{REF}+ and V_{REF}-, and by bypassing in a manner similar to that described in Section 8.7 for the supply pins. When a single ended reference is used, V_{REF}- is connected to AGND and only two capacitors are used between V_{REF}+ and V_{REF}- (0.1 μF + 10 μF). It is recommended to directly connect the AGND side of these capacitors to the V_{REF}- instead of connecting V_{REF} - and the ground sides of the capacitors separately to the ground planes. This provides a significantly lower-impedance connection when using surface mount technology.

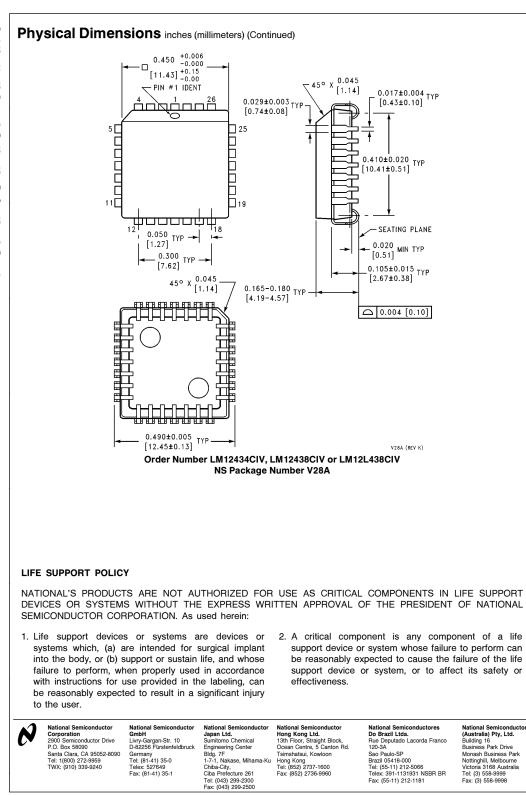
Figure 21 is intended to give a general idea of how the DAS should be wired and interfaced to a μ C that operates in the Standard Interface mode. All necessary analog and digital power supply and voltage reference bypass capacitors are shown. A voltage reference of 4.096V generated by the LM4040-4.1 is connected to the V_{REF+} of the DAS and the V_{REF-} is connected to analog ground. The serial interface pins P1 through P5 of the DAS are connected to the μ C's serial control lines and the interrupt pin of the DAS is wired directly to the interrupt of the μ C. In this diagram the DAS runs on a separate clock than the μ C, however, in some applications the DAS analog clock (CLK) may be a derivative of the μ C's.











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